3D*labs*®

GLINT® *500TX*™

Hardware Reference Manual

Issue 4

Change History

Document	Issue	Date	Change
106.1.56	1	29 April 96	First Release
	2	14 May 96	Updates to Chapters 3, 4, 5, 8, 9, 10, 11, 12 and Appendix A added.
	3	4 June 96	
	4	5 Mar 97	Typing corrections to sections 3.2.1, 4.2.16, 7.3, 9.2, 9.3, 9.3.1, 9.8, 11.5.1, A.1. Style change. Index added.

Contents

Tables

Figures

1.   GLINT 500TX Functional Overview

1.1   Introduction

The GLINT 500TX high performance graphics processor combines workstation class 3D graphics acceleration and state of the art 2D performance in a single chip. All 3D rendering operations are accelerated by the GLINT 500TX, including Gouraud shading, texture mapping, depth buffering, antialiasing and alpha blending.

Implemented around a scaleable memory architecture, the GLINT 500TX reduces the cost and complexity of delivering high performance 3D graphics within a windowing environment - making it ideal for a wide range of graphics products from PC boards to high end workstation accelerators.
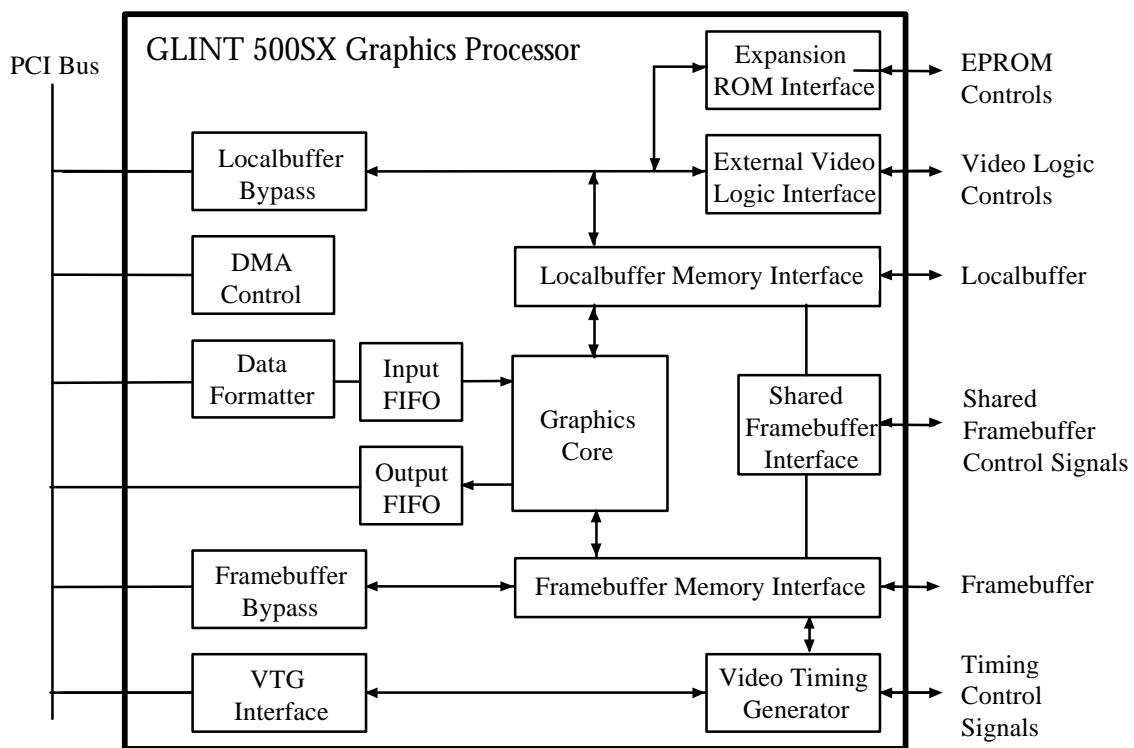
Figure 1-1 GLINT 500TX Functional Units

1.2   Notation

The following notational conventions are used in this book.

A signal name ending in N indicates an active low signal, e.g. PCIFrameN.

n-m indicates a bit field from bit n to bit m, e.g. 7-0 specifies bits 7 through 0 inclusive.

Use of the letter h indicates a hexadecimal number, e.g. 6Fh is a hexadecimal number.

Use of the letter b indicates a binary number, e.g. 1010b is a binary number.

Use of the letter X indicates that a value is undefined, e.g. XXXh is a undefined hexadecimal number.

1.3   GLINT 500TX Graphics Core

The Graphics Core (GC) in the GLINT 500TX accelerates the key operations for 3D and 2D applications. For further information on the functionality of the GC refer to the GLINT 500TX Programmers Reference Manual.

1.4   PCI Interface

The PCI interface conforms to the PCI Local Bus standard Revision 2.1. The GLINT 500TX is a PCI Local Bus Target and a PCI Local Bus Read Master.

The host interface includes the configuration registers, the GLINT 500TX control registers, and two bypass paths: one to the Localbuffer memory and one to the Framebuffer memory.

The PCI interface has an input FIFO for passing data to the Graphics Core, and an output FIFO for buffering up data to be read from the Graphics Core. The input FIFO is 32 words deep. The output FIFO is 8 words deep.

A DMA controller is provided in the PCI interface to allow the GLINT 500TX to read data directly into the Graphics Core input FIFO.

1.5   Big-endian Processor Support

The GLINT 500TX provides support for big-endian processors. A big-endian processor will generate byte swapped big-endian data on the PCI local bus, commonly known as gib-endian.

All the regions on the GLINT 500TX can accept gib-endian data. The configuration space is set by a control pin at reset time and the GLINT 500TX control registers are always visible little and gib-endian.

The Localbuffer and Framebuffer each have two PCI apertures whose endian is programmable.

1.6   Localbuffer Memory Interface

The Localbuffer memory is used to store off screen pixel associated information. This includes Depth (Z), Stencil, and texture data.

The Localbuffer consists of one or two banks of DRAM giving from 2 to 48 Mbytes of storage. A Localbuffer width of 0 to 48 bits is supported. The number of bits populated in any hardware implementation will depend on software requirements. The memory control signals are programmable to allow for optimum operation at different GLINT 500TX clock speeds with memory systems using -50 to -80 speed DRAM parts. Page sizes from 256 to 2048 are supported. EDO DRAM is also supported.

The Localbuffer interface provides a link to the PCI Local Bus to allow host accesses to bypass the Graphics Core.

Table 1-1. Localbuffer DRAM Types

DRAM Generic types
256K x 16/18
512k x8/9
1M x 4
1M x 16/18
2M x 8/9
4M x 4

DRAMs used must support fast page-mode or Extended-DataOut and CAS-BEFORE-RAS refresh.

1.7 Framebuffer Memory Interface

The GLINT 500TX can address a Framebuffer of between 2MByte and 32MBytes of VRAM. A Framebuffer data width of 64 bits is supported. The VRAMs supported include 256kx4, 256kx8 and 256kx16. The VRAMs must support split transfer cycles.

The memory control signals are programmable to allow for optimum operation at different GLINT 500TX clock speeds with a range of memory speeds allowing -60 to -80 VRAMs to be used. The GLINT 500TX can make use of VRAM write masks and block fill mode, if available, to improve performance.

LUT-DACs with 64 and 128 bit pixel buses are supported. For more information on LUT-DAC support refer to External Video Control (Section 5).

GLINT 500TX interfaces directly to most Framebuffers, however Framebuffers with greater than 16 memory parts require external buffering of the address and control lines.

The Framebuffer interface also provides a link to the PCI Local Bus to allow host accesses to bypass the Graphics Core.

The GLINT 500TX supports 32, 16, and 8 bit packed framestores.

1.8 Shared Framebuffer/Shared Localbuffer Interface

The GLINT 500TX provides a mechanism to share the Framebuffer and/or the Localbuffer with another device. The GLINT 500TX can be programmed to either perform the sharing arbitration (primary controller) or act as a slave (secondary controller).

1.9 Video Timing Generation

The GLINT 500TX has an internal timing generator and VRAM transfer controller for simple Framebuffer configurations. For more complex configurations an external timing generator and transfer controller is required.

The maximum video clock (VClk) for the GLINT 500TX is 80MHz. The video clock is derived from the video output pixel clock. The pixel clock is divided by the number of serial port interleaved banks. So if the pixel clock is 135MHz and there are 4 serial port interleaved banks, the video clock to the GLINT 500TX will be clocked at 33.75MHz.

Maximum GLINT 500TX video clock rates (assuming 50MHz VRAMs) are shown in table 1-2.

Table 1-2. Maximum Pixel Clock Support

Pixel Width	Serial Interleave	Maximum Pixel Frequency
32 bit	4	200MHz
16 bit	8	400MHz
8 bit	16	800MHz

1.10 External Video Logic Interface

The GLINT 500TX can control external video logic such as the video output LUT-DAC. The address and data lines for the control come from the Localbuffer interface. Control signals are provided to allow standard LUT-DACs to be connected directly to the GLINT 500TX. Some LUT-DACs will require a small amount of glue logic.

1.11 Reset Configuration Control

A number of parameters for the GLINT 500TX are set at reset time, such as Localbuffer and Framebuffer memory size and speed. The reset state is configured with resistors connected to the Localbuffer data pins. The state of the data pins is sampled on the rising edge of the reset line. See Reset Control (Section 12) for more details.

1.12 Expansion EPROM support

The GLINT 500TX supports an expansion EPROM. This EPROM may store code needed for device-specific initialization and expansion of the boot time code.

1.13 GLINT 500TX Address Map

The GLINT 500TX has six PCI base address regions:

Table 1-3. PCI Address Regions

Region	Description
Configuration	PCI configuration region
0	GC control region
1	Aperture 0 access to Localbuffer memory
2	Aperture 0 access to Framebuffer memory
3	Aperture 1 access to Localbuffer memory
4	Aperture 1 access to Framebuffer memory
ROM	Expansion ROM

2. PCI Configuration Region

The PCI Configuration Region provides at set of 'hooks' which satisfies the needs of current and anticipated system configuration mechanisms. The configuration registers are accessed and modified by the use of Configuration Read and Write commands.

Sixty four bytes of the Configuration registers are predefined within the PCI Specification and are supported by the GLINT 500TX. The remaining 192 Bytes are device specific and are unused by the GLINT 500TX.

Table 2-1. Configuration Region.

31	24	16	8	0	
Device ID		Vendor ID			00h
Status		Command			04h
Class Code			Revision ID		08h
BIST	Header Type	Latency Timer	Cache Line Size		0Ch
Base Address Registers					10h
					14h
					18h
					1Ch
					20h
					24h
Reserved					28h
Reserved					2Ch
Expansion ROM Base Address					30h
Reserved					34h
Reserved					38h
Max_Lat	Min_Gnt	Interrupt Pin	Interrupt line		3Ch
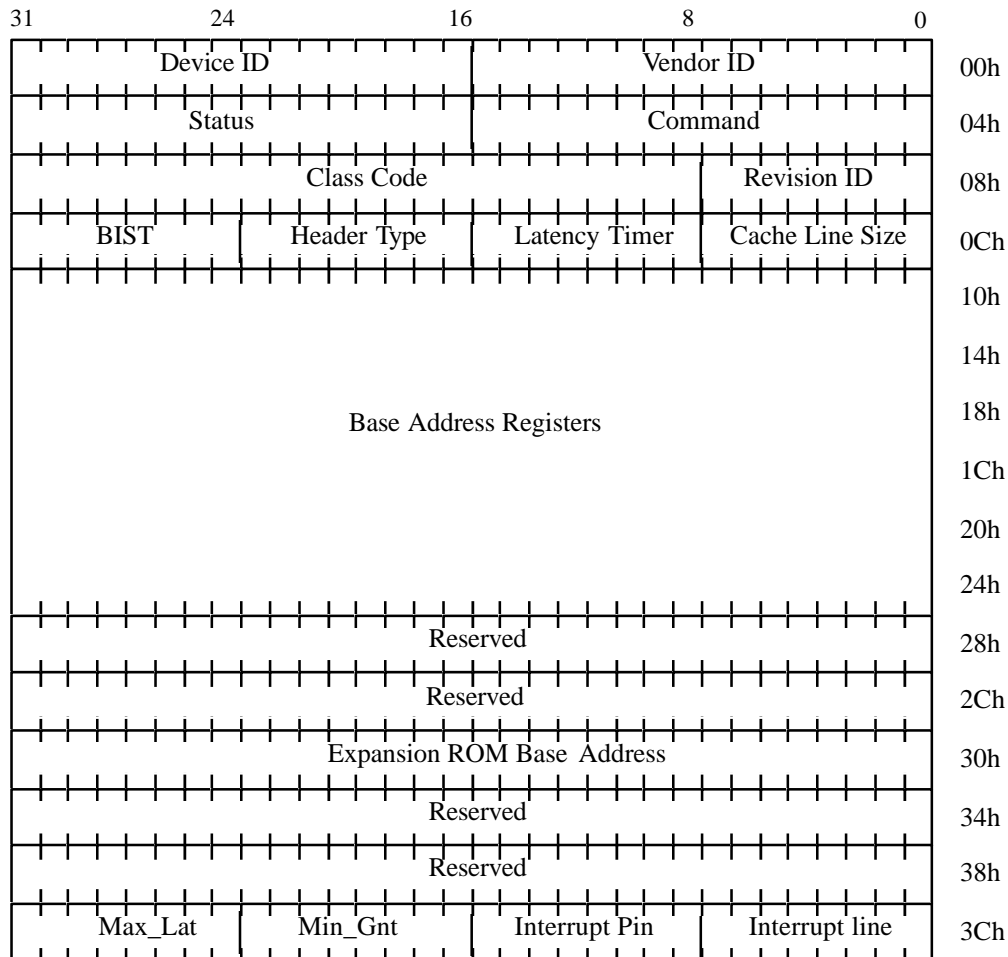
2.1 Device Identification

2.1.1 Vendor ID

Vendor identification number.

CFGVendorId

Region: Config   Offset: 00h

Read Only   Reset Value: 3D3D

31	24	16	8	0

Vendor ID
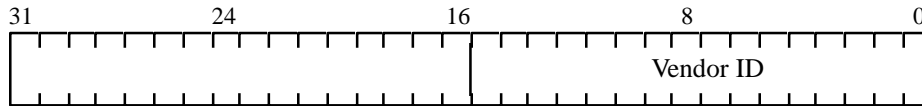
Bits 15-0   3D3Dh

3Dlabs company code

2.1.2 Device ID

Device identification number.

CFGDeviceId

Region: Config   Offset: 02h

Read Only   Reset Value: 0002h

31	24	16	8	0
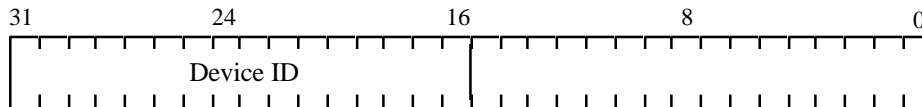
Device ID

Bits 31-16   0002h

GLINT 500TX Device number

2.1.3 Revision ID

Revision identification number.

CFGRevisionId

Region: Config   Offset: 08h

Read Only   Reset Value: Revision Number

31	24	16	8	0

Revison ID
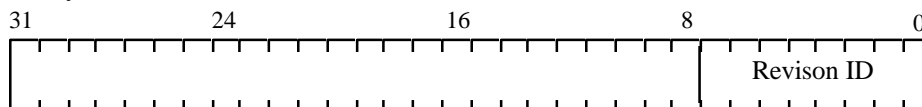
The revision ID register returns the following code:

Bits 7 - 0   Revision

01h = Revision R01

2.1.4   Class Code Register

CFGClassCode

Region: Config   Offset: 09h

Read Only   Reset Value: 038000h

```
31              24          16             8              0
┌─────────────┬───────────┬──────────────┬───────────────┐
│  Base Class  │  Sub Class │ Device Class │               │
└─────────────┴───────────┴──────────────┴───────────────┘
```
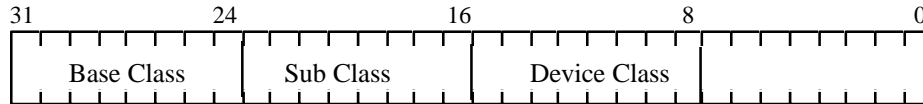
Bits 31-24   03h

       Base class. PCI Definition: Display controller

Bits 23-16   80h

       Sub class. PCI Definition: Other Display controller (not VGA or XGA)

Bits 15-8   00h

       Device class

NB. Some operating systems may expect a device of Class 03h 80h to contain a VGA device and fail to boot correctly if no VGA device is present. The GLINT 500TX has no in-built VGA and hence this problem may occur. To avoid this problem setting the 'Base Class Zero' field of the FBMemControl register using a configuration resistor causes the Class Code register to return 00h 00h (Backward Compatibility Class). - see section 3.3.1

2.1.5   Header Type

CFGHeaderType

Region: Config   Offset: 0Eh

Read Only   Reset Value: 00h

```
31              24          16             8              0
┌───────────────┬───────────┬──────────────────────────────┐
│               │ Header Type │                              │
└───────────────┴───────────┴──────────────────────────────┘
```
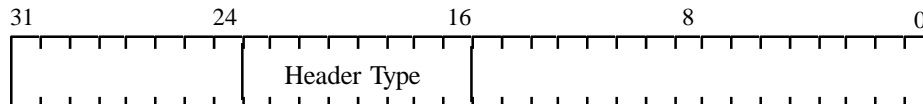
Bits 23-16   00h

       Header Type. PCI Definition: Single function device

2.2   Device Control

2.2.1   Command Register

The command register provides control over a device's ability to generate and respond to PCI cycles. Writing zero to this register disconnects the device from the PCI for all except configuration accesses. All necessary bits within the command register are supported for the functionality contained in the GLINT 500TX.

CFGCommand

Region: Config   Offset: 04h

Read/Write   Reset Value: 0000h

31	24	16	8	0
		Command		
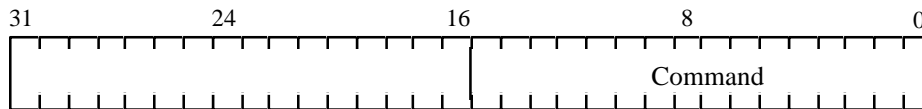
Bit 0   I/O access enable (Read Only)

               0 = The GLINT 500TX has no I/O space regions

Bit 1   Memory access enable

               0 = Disable memory space accesses. (RESET)

               1 = Enable memory space accesses

Bit 2   Master enable

               0 = Disable master accesses. (RESET)

               1 = Enable master accesses

Bit 3   Special Cycle access enable (Read Only)

               0 = The GLINT 500TX never responds to special cycle accesses.

Bit 4   Memory Write and Invalidate enable (Read Only)

               0 = The GLINT 500TX master never issues Memory Write and Invalidate accesses.

Bit 5   VGA palette snoop enable (Read Only)

               0 = The GLINT 500TX is not a VGA device.

Bit 6   Parity error report enable (Read Only)

               0 = The GLINT 500TX does not report parity errors.

Bit 7   Address/Data stepping enable (Read Only)

               0 = The GLINT 500TX does not do stepping.

Bit 8   SERR driver enable(Read Only)

               0 = The GLINT 500TX does not report parity errors.

Bit 9   Master Fast back-to-back enable (Read Only)

               0 = The GLINT 500TX master does not implement fast back-to-back accesses.

Bits 15-10   Reserved

               000000b

2.3   Device Status

2.3.1   Status Register

The Status Register is used to record status information for PCI related events. The definition for each bit is given below.

Reads to this register behave normally. Writes function differently in that bits can be reset but not set. A bit is reset whenever the register is written and the data in the corresponding bit location is a 1.

CFGStatus

Region: Config   Offset: 06h

Read Only   Reset Value: 00h

```
 31                    24                  16                  8                   0
┌──────────────────────────────────────┬──────────────────────────────────────┐
│               Status                  │                                      │
└──────────────────────────────────────┴──────────────────────────────────────┘
```
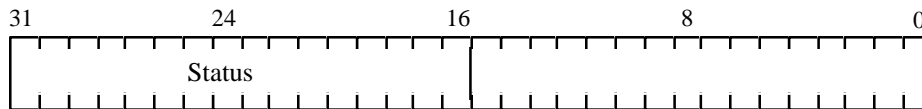
Bits 22-16   Reserved (Read Only)
                0000000b.

Bit 23   Fast back-to-back Transactions (Read Only)
                1 = Indicates support for fast back-to-back PCI transactions .

Bit 24   Master Parity check flag (Read Only)
                0 = Parity checking not implemented on the GLINT 500TX.

Bits 26-25   10b (Read Only)
                Indicates that the GLINT 500TX asserts DevselN at medium speed.

Bit 27   Target Abort flag (Read Only)
                0 = The GLINT 500TX never issues a target abort.

Bit 28   Master Target Abort flag
                Set by master when transaction terminates with target abort.

Bit 29   Master Abort flag
                Set by master when it terminates transaction with master abort.

Bit 30   SERR flag (Read Only)
                0 = Parity checking not implemented on the GLINT 500TX.

Bit 31   PERR flag (Read Only)
                0 = Parity checking not implemented on the GLINT 500TX.

2.4   Miscellaneous Functions

2.4.1   BIST

Optional register used for control and status of BIST.

CFGBist

Region: Config   Offset: 0Fh

Read Only   Reset Value: 00h

```
 31              24              16              8               0
┌───────────────┬───────────────────────────────────────────────┐
│     BIST      │                                               │
└───────────────┴───────────────────────────────────────────────┘
```
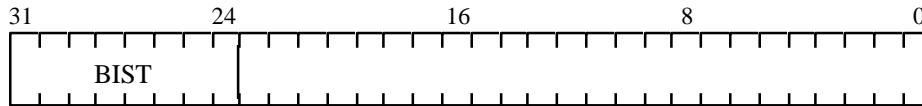
Bits 31-24   BIST

               00h.   BIST unsupported by the GLINT 500TX over the PCI interface.

2.4.2   Latency Timer

This register specifies, in PCI bus clocks, the value of the Latency Timer for this PCI bus master.

CFGLatTimer

Region: Config   Offset: 0Dh

Read/Write   Reset Value: 00h

```
 31              24              16              8               0
┌───────────────────────────────┬───────────────┬───────────────┐
│                               │ Latency Timer │               │
└───────────────────────────────┴───────────────┴───────────────┘
```
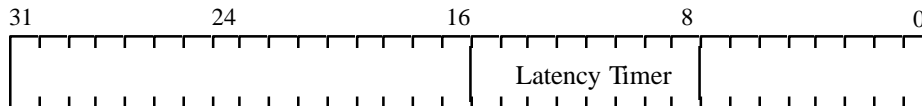
Bits 15-8   Latency Timer Count

               Sets the maximum number of PCI clock cycles for master burst accesses.

2.4.3   Cache Line Size

This register specifies the cache line size in units of 32 bit words. It is only implemented for masters which use the 'Memory write and invalidate' command. The GLINT 500TX does not use this command.

CFGCacheLine

Region: Config   Offset: 0Ch

Read Only   Reset Value: 00h

```
 31              24              16              8               0
┌───────────────────────────────────────────────┬───────────────┐
│                                               │  Cache Line   │
└───────────────────────────────────────────────┴───────────────┘
```

Bits 7-0   Cache Line Size

               00h. Cache line size unsupported.

2.4.4   Maximum Latency

This register specifies how often the PCI device needs to gain access to the PCI bus.

CFGMaxLat

Region: Config   Offset: 3Fh

Read Only   Reset Value: Determined by Localbuffer data pins

```
 31              24              16              8               0
```

| Max Lat |
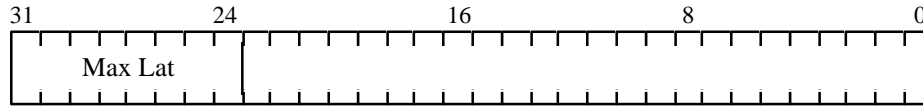
Bits 31-24   Maximum Latency   LB Reset Bits 21-20

Set by the reset value of Localbuffer data pins.
Possible values are: 00h, 40h, 80h, and C0h.

2.4.5   Minimum Grant

This register specifies the duration of a burst period required by the PCI device.

CFGMinGrant

Region: Config   Offset: 3Eh

Read Only   Reset Value: Determined by Localbuffer data pins

```
 31              24              16              8               0
```

| Min Gnt |
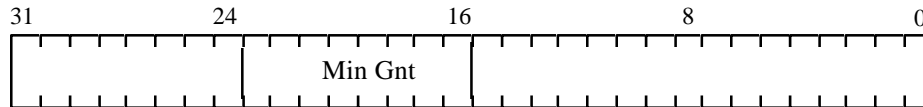
Bits 23-16   Minimum Grant   LB Reset Bits 23-22

Set by the reset value of Localbuffer data pins.
Possible values are: 00h, 40h, 80h, and C0h.

2.4.6   Interrupt Pin

The Interrupt Pin register tells the BIOS which interrupt line is used by the GLINT 500TX.

CFGIntPin

Region: Config   Offset: 3Dh

Read Only   Reset Value: 01h

```
 31              24              16              8               0
```
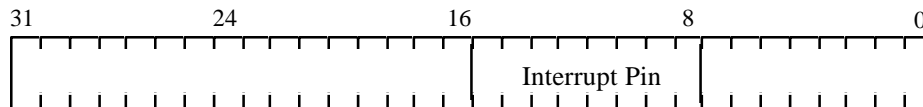
| Interrupt Pin |

Bits 15-8   Interrupt Pin

01h   The GLINT 500TX uses Interrupt pin A

2.4.7   Interrupt Line

The Interrupt Line register is an 8 bit register used to communicate interrupt line routing information.

CFGIntLine

Region: Config   Offset: 3Ch

Read/Write   Reset Value: 00h

31	24	16	8	0
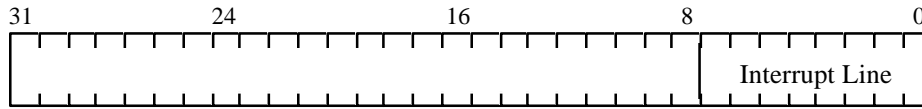
Interrupt Line

Bits 7-0   Interrupt Line

2.5   Base

The base address registers allow the boot software to relocate PCI devices in the address spaces. At system power-up device independent software must be able to determine what devices are present, build a consistent address map, and determine if a device has an expansion ROM.

2.5.1   Base Address 0 Register

The Base Address 0 Register contains the GLINT 500TX control space offset. The control registers are in memory space. They are not prefetchable and can be located anywhere in 32 bit address space.

CFGBaseAddr0

Region: Config   Offset: 10h

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0

Base Address 0
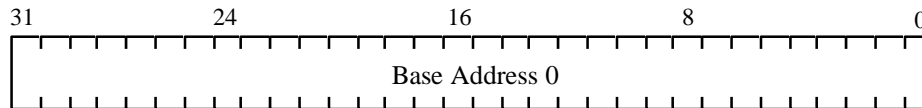
Bits 31-17   Base offset
              Loaded at boot time to set offset of the control register space.

Bits 16-4   Size indication   Read Only
              000h   Indicates that the control registers must be mapped into 128KBytes.

Bits 3-0   Address Type   Read Only
              0h   Memory Space, not prefetchable, in 32 bit address space

2.5.2   Base Address 1 Register

The Base Address 1 Register contains the GLINT 500TX aperture 0 Localbuffer offset. The Localbuffer is in memory space. It is not prefetchable and can be located anywhere in 32 bit address space.

CFGBaseAddr1

Region: Config   Offset: 14h

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0
Base Address 1				

Bits 31-xx   Base offset

Loaded at boot time to set offset of the Localbuffer space.

Bits xx-4   Size indication   Read Only   LB Reset Bits 26-24

0000h   Set at reset time by the Localbuffer data pins.
The following sizes are possible: 0M, 1M, 2M, 4M, 8M, 16M, 32M, and 64M Bytes.

Bits 3-0   Address Type   Read Only

0h   Memory Space, not prefetchable, in 32 bit address space

2.5.3   Base Address 2 Register

The Base Address 1 register contains the GLINT 500TX aperture 0 Framebuffer offset. The Framebuffer is in memory space. It is not prefetchable and can be located anywhere in 32 bit address space.

CFGBaseAddr2

Region: Config   Offset: 18h

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0
Base Address 2				

Bits 31-xx   Base offset

Loaded at boot time to set offset of the Framebuffer space.

Bits xx-4   Size indication   Read Only   FB Reset Bits 31-29

0000h   Set at reset time by the Framebuffer data pins.
The following sizes are possible: 0M, 1M, 2M, 4M, 8M, 16M, and 32M Bytes.

Bits 3-0   Address Type   Read Only

0h   Memory Space, not prefetchable, in 32 bit address space.

2.5.4   Base Address 3 Register

The Base Address 3 Register contains the GLINT 500TX aperture 1 Localbuffer offset. Aperture 1 is always the same size as aperture 0.

CFGBaseAddr3

Region: Config   Offset: 1Ch

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0
Base Address 3				

Bits 31-xx   Base offset

Loaded at boot time to set offset of the Localbuffer space.

Bits xx-4   Size indication   Read Only   LB Reset Bits 26-24

0000h   Set at reset time by the Localbuffer data pins.
Addresses The following sizes are possible: 0M, 1M, 2M, 4M, 8M, 16M, 32M, and 64M Bytes.

Bits 3-0   Address Type   Read Only

0h   Memory Space, not prefetchable, in 32 bit address space.

2.5.5   Base Address 4 Register

The Base Address 4 register contains the GLINT 500TX aperture 1 Framebuffer offset. Aperture 1 is always the same size as aperture 0.

CFGBaseAddr4

Region: Config   Offset: 20h

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0
Base Address 4				

Bits 31-xx   Base offset

Loaded at boot time to set offset of the Framebuffer space.

Bits xx-4   Size indication   Read Only   FB Reset Bits 31-29

0000h   Set at reset time by the Framebuffer data pins.
The following sizes are possible: 0M, 1M, 2M, 4M, 8M, 16M, and 32M Bytes.

Bits 3-0   Address Type   Read Only

0h   Memory Space, not prefetchable, in 32 bit address space.

2.5.6   Expansion ROM Base Address

The Expansion ROM Base register is the offset address for the expansion ROM. The ROM is in memory space.

CFGRomAddr

Region: Config   Offset: 30h

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0
		Expansion ROM Base Address		
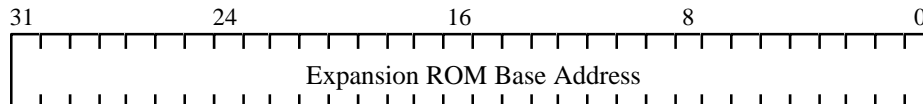
Bits 31-16   Base offset

Loaded at boot time to set offset of the Expansion ROM.

Bits 15-11   Size indication   Read Only

00h   Indicates that the Expansion ROM must be mapped into 64KBytes.

Bits 10-1   Reserved   Read Only

000h   PCI reserved register bits.

Bit 0   Access enable

0 = Expansion ROM accesses disabled
1 = Expansion ROM accesses enabled

2.6 Expansion ROM Interface

A 64K x 8 bit interface is provided for an expansion ROM. This interface is read only from the PCI .The address and data lines share pins with the Localbuffer data bus as defined in table 2-2.

Table 2-2. Expansion ROM Connections

Signal	Pins used	Description
RomAddr(15-0)	LBMemData(39-24)	Expansion ROM Address lines.
RomData(7-0)	LBMemData(47-40)	Expansion ROM Data bus.
RomEnN	RomEnN	Expansion ROM read strobe (negative active)
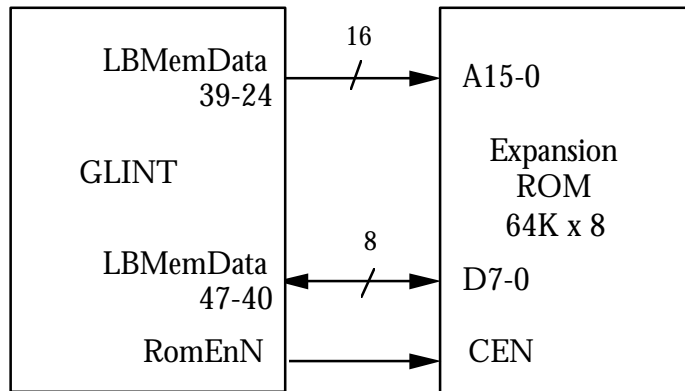
Figure 2-1 Expansion ROM interface

3. Region 0 - Control Registers

3.1 Region 0 Address Map

The GLINT 500TX region 0 is a 128KByte region containing the control registers and ports to and from the Graphics Core.

The control space is mapped in twice in the 128KByte region. In the second 64K the registers are mapped to be byte swapped for big endian hosts.

Offset	Function	Byte Swap Offset
0000.0000h - 0000.0FFFh	Control Status Registers	0001.0000h - 0001.0FFFh
0000.1000h - 0000.17FFh	Localbuffer Registers	0001.1000h - 0001.17FFh
0000.1800h - 0000.1FFFh	Framebuffer Registers	0001.1800h - 0001.1FFFh
0000.2000h - 0000.2FFFh	GC FIFO Interface	0001.2000h - 0001.2FFFh
0000.3000h - 0000.3FFFh	Internal Video Registers	0001.3000h - 0001.3FFFh
0000.3000h - 0000.7FFFh	External Video Registers	0001.3000h - 0001.7FFFh
0000.8000h - 0000.FFFFh	GC Register Access (Through FIFO)	0001.8000h - 0001.FFFFh

Figure 3-1. Region 0 Address Map

3.1.1   Reset Status Register

Writing to the reset status register forces a software reset of the GLINT 500TX Graphics Core. The software reset does not reset the PCI interface. It is provided for software diagnostics in case an incorrect register set up locks up the internal GC.

The software reset takes a number of cycles and the GC must not be used during the reset. A flag in the register is provided which shows that the software reset is still in progress.

For more information on the operation of the GLINT 500TX at reset please refer to Reset Control (Section 12).

ResetStatus

Region: 0   Offset: 0000.0000h

Read/Write   Reset Value: 0000.0000h

| 31 | 24 | 16 | 8 | 0 |
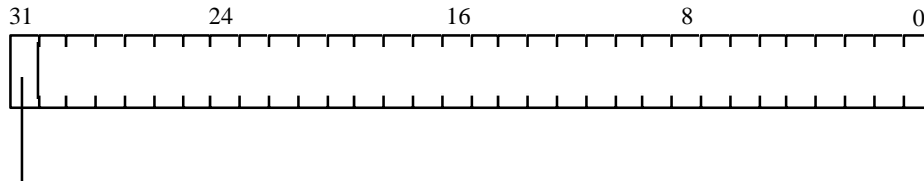
Software Reset Flag

Bits 30-0   Reserved

Bit 31   Software Reset Flag

        0 = The GLINT 500TX is ready for use
        1 = The GLINT 500TX is being reset and must not be used

3.1.2   Interrupt Enable Register

The Interrupt Enable Register allows for a number of GLINT 500TX flags to generate a
PCI interrupt. Five interrupt sources are defined below. At reset all interrupts sources are
disabled.

IntEnable

Region: 0   Offset: 0000.0008h

Read/Write   Reset Value: 0000.0000h

Vertical Retrace Interrupt Enable
Error Interrupt Enable
External Interrupt Enable
Sync Interrupt Enable
DMA Interrupt Enable
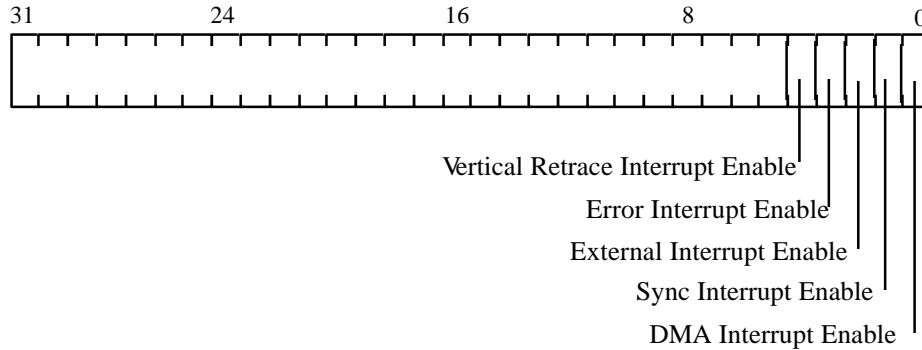
Bit 0   DMA interrupt enable

0 = Disable interrupt (RESET)
1 = Enable interrupt

Bit 1   Sync interrupt enable

0 = Disable interrupt (RESET)
1 = Enable interrupt

Bit 2   External interrupt enable

0 = Disable interrupt (RESET)
1 = Enable interrupt

Bit 3   Error interrupt enable

0 = Disable interrupt (RESET)
1 = Enable interrupt

Bit 4   Vertical retrace interrupt enable

0 = Disable interrupt (RESET)
1 = Enable interrupt

3.1.3   Interrupt Flags Register

The Interrupt Flags Register shows which interrupts are outstanding on the GLINT 500TX.

Flag bits are reset by writing to this register with the corresponding bit set to a 1. Flags at positions where the bits are set to 0 will be unaffected by the write.

IntFlags

Region: 0   Offset: 0000.0010h

Read/Write   Reset Value: 0000.0000h

Vertical Retrace Flag
Error Flag
External Flag
Sync Flag
DMA Flag
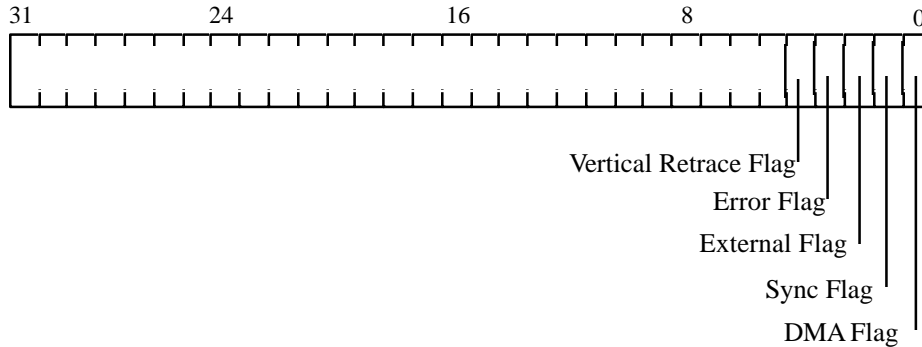
Bit 0   DMA Flag

                      0 = No interrupt (RESET)
                      1 = Interrupt outstanding

Bit 1   Sync Flag

                      0 = No interrupt (RESET)
                      1 = Interrupt outstanding

Bit 2   External Flag

                      0 = No interrupt (RESET)
                      1 = Interrupt outstanding

Bit 3   Error Flag

                      0 = No interrupt (RESET)
                      1 = Interrupt outstanding

Bit 4   Vertical Retrace Flag

                      0 = No interrupt (RESET)
                      1 = Interrupt outstanding

3.1.4   Input FIFO Space Register

The input FIFO space register indicates the number of words that can currently be written to the input FIFO. This register can be read at any time and used to allow the controlling software to efficiently send data to the GLINT 500TX. If the DMA controller for the FIFO is in use, the value read is a snapshot of the current FIFO status.

InFIFOSpace

Region: 0   Offset: 0000.0018h

Read Only   Reset Value: 0000.0010h

31	24	16	8	0

Input FIFO Available
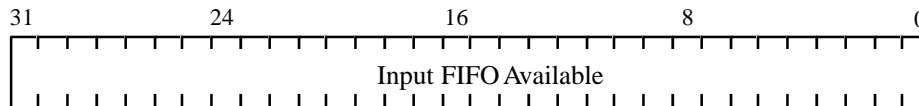
Bits 31-0   Input FIFO Space

Valid range: 0 to 16.
The number of empty words in the input FIFO. This number of words can be written before checking again for FIFO space availability. Although the input FIFO is 32 words deep, the maximum Input FIFO space returned is 16 for compatibility with GLINT 300SX.

3.1.5   Output FIFO Words Register

The output FIFO words register indicates the number of words currently in the output FIFO. This register can be read at any time and used to allow the controlling software to efficiently read output data from the GLINT 500TX.

OutFIFOWords

Region: .0   Offset: 0000.0020h

Read Only   Reset Value: 0000.0000h

31	24	16	8	0
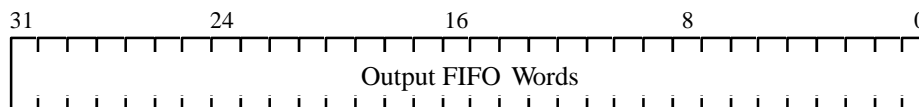
Output FIFO Words

Bits 31-0   Output FIFO Words

Valid range: 0 to 8.
The number of valid words in the output FIFO. This number of words can be read before checking for more words.

3.1.6   DMA Start Address

The DMA address should be loaded with the first PCI address for the buffer to be transferred to the GC when using the DMA controller.

Writing to the DMA start address register loads the address into the DMA address counter. Once a DMA has been set off the next DMA start address may be loaded. A read of this register returns the last start value loaded even if the DMA is underway.

DMAAddress

Region: 0   Offset: 0000.0028h

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0
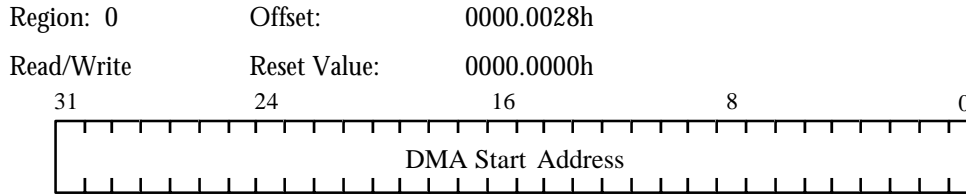
DMA Start Address

Bits 31-0   DMA Start Address

PCI start address for PCI master read transfer to the Graphics Core.

3.1.7   DMA Count

The DMA count register should be loaded with the number of words to be transferred in the DMA operation. The action of loading a word count greater than zero sets off the DMA operation. The value read back from this register indicates the current number of words left to be transferred.

This register should only be written to if the count is zero. It can be read at any time.

DMACount

Region: 0   Offset: 0000.0030h

Read/Write   Reset Value: 0000.0000h

31	24	16	8	0
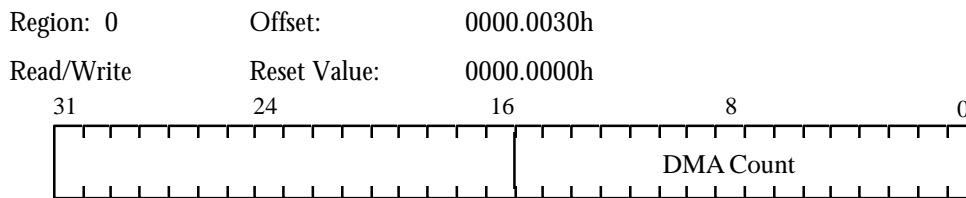
DMA Count

Bits 15-0   DMA Count

Valid Range: 0 to 65535
Number of words to be transferred in DMA operation.
Undefined action if this register is written to when it is not zero.

3.1.8   Error Flags Register

The Error Flags Register shows which errors are outstanding on the GLINT 500TX.

Flag bits are reset by writing to this register with the corresponding bit set to a 1. Flags at positions where the bits are set to 0 will be unaffected by the write.

ErrorFlags

Region: 0   Offset: 0000.0038h

Read/Write   Reset Value: 0000.0000h

Command error

Output FIFO error
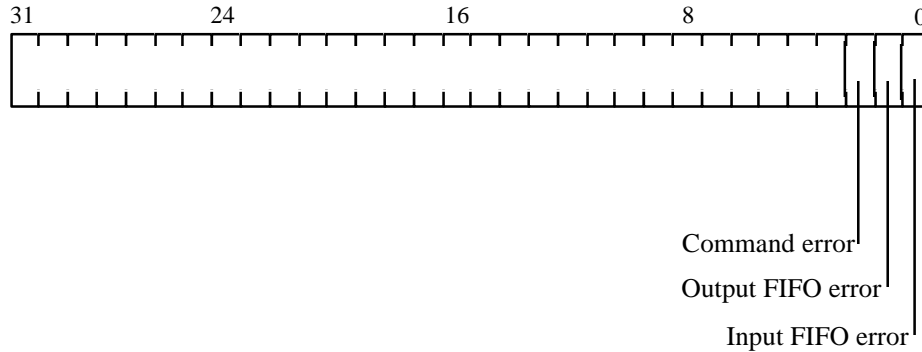
Input FIFO error

Bit 0   Input FIFO Error Flag

Flag set on write to full input FIFO
            0 = No error (RESET)
            1 = Error outstanding

Bit 1   Output FIFO Error Flag

Flag set on read from empty output FIFO
            0 = No error (RESET)
            1 = Error outstanding

Bit 2   Command Error Flag

Flag set on incorrect mixing of accesses to the input FIFO space and the GC register space
            0 = No error (RESET)
            1 = Error outstanding

3.1.9 Video Clock Control Register

The video clock control Register drives two physical pins on the GLINT 500TX. These pins are used to program the video clock PLL chip.

VClkCtl

Region: 0   Offset: 0000.0040h

Read/Write   Reset Value: 0000.0000h
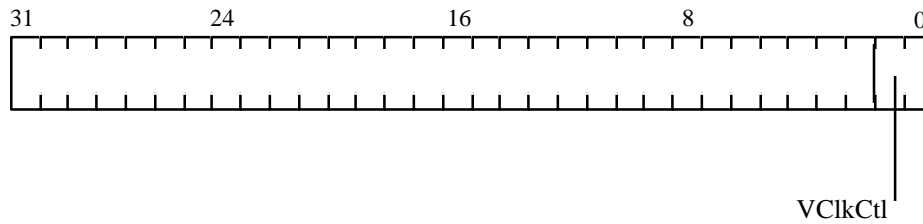
VClkCtl

Bit 0   VClkCtl (0)

Bit 1   VClkCtl (1)

3.1.10   Test Register

The test register is not to be used by any user software. Writes to this register have an undefined effect.

The GLINT 500TX powers up in functional mode.

TestRegister

Region: 0   Offset: 0000.0048h

Read/Write   Reset Value: 0000.0000h

```
31              24              16              8               0
┌─────────────────────────────────────────────────────────────┐
│                                                               │
│                                                               │
└─────────────────────────────────────────────────────────────┘
```
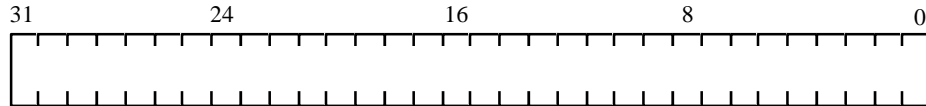
Bit 0   Rasterizer

Bit 1   Scissor Stipple

Bit 2   Color DDA

Bit 3   Fog

Bit 4   Alpha test

Bit 5   LB read

Bit 6   GID Stencil Depth

Bit 7   LB write

Bit 8   FB read

Bit 9   Alpha blend

Bit 10   Dither

Bit 11   Logicops

Bit 12   FB Write

Bit 13   Host out

Bit 14   Texture Address

Bit 15   Texture Read

Bit 16   Texture Color

Bit 17   Router

3.1.11   Aperture 0 Control Register

The aperture 0 control Register sets up the data transfer modes for the Localbuffer visible in region 1 and the Framebuffer in region 2.

The Localbuffer can be set to be byte swapped for big endian hosts.

The Framebuffer can be set to be byte swapped and half word swapped for big endian hosts.

The Framebuffer can be used in a mode whereby two 16-bit buffers (A and B) are interleaved together on a per-pixel basis. Each 32bit word contains a 16 bit pixel from buffer A and the equivalent pixel from buffer B. Control bits are provided to allow reading and writing of Buffers A and B as contiguous 16-bit packed buffers, despite their being pixel-interleaved within memory. Each 32-bit read or write access over the PCI bus thus transfers two 16-bit pixels to either Buffer A or Buffer B as selected by the fields below.

Aperture0

Region: 0   Offset: 0000.0050h

Read/Write   Reset Value: 0000.0000h

Bits 1-0	Framebuffer Byte Control
	0 = Standard
	1 = Byte Swapped
	2 = Half Word Swapped
	3 = Reserved
Bit 2	Localbuffer Byte control
	0 = Standard
	1 = Byte Swapped
Bit 3	Packed 16-bit (1:5:5:5) Framebuffer Control
	Turns on 16-bit packed accesses.
	0 = disable packed 16-bit framebuffer
	1 = enable packed 16-bit framebuffer
Bit 4	Packed 16-bit Read Buffer Select
	0 = select Buffer A for read accesses
	1 = select Buffer B for read accesses

Bit 5   Packed 16-bit Write Buffer Select

       0 = select Buffer A for write accesses

       1 = select Buffer B for write accesses

Bit 6   Packed 16-bit Double Write Control

      Allows a write access to be performed to both Buffer A and Buffer B simultaneously.

       0 = disable double writes

       1 = enable double writes

3.1.12   Aperture 1 Control Register

The aperture 1 control Register sets up the data transfer modes for the Localbuffer visible in region 3 and the Framebuffer in region 4.

The Localbuffer can be set to be byte swapped for big endian hosts.

The Framebuffer can be set to be byte swapped and half word swapped for big endian hosts.

The Framebuffer can be used in a mode whereby two 16-bit buffers (A and B) are interleaved together on a per-pixel basis. Each 32bit word contains a 16 bit pixel from buffer A and the equivalent pixel from buffer B. Control bits are provided to allow reading and writing of Buffers A and B as contiguous 16-bit packed buffers, despite their being pixel-interleaved within memory. Each 32-bit read or write access over the PCI bus thus transfers two 16-bit pixels to either Buffer A or Buffer B as selected by the fields below.

Aperture1

Region: 0   Offset: 0000.0058h

Read/Write   Reset Value: 0000.0000h

Bits 1-0	Framebuffer Byte Control
	0 = Standard
	1 = Byte Swapped
	2 = Half Word Swapped
	3 = Reserved

Bit 2	Localbuffer Byte control
	0 = Standard
	1 = Byte Swapped

Bit 3	Packed 16-bit (1:5:5:5) Framebuffer Control
	Turns on 16-bit packed accesses.
	0 = disable packed 16-bit framebuffer
	1 = enable packed 16-bit framebuffer

Bit 4	Packed 16-bit Read Buffer Select
	0 = select Buffer A for read accesses
	1 = select Buffer B for read accesses

Bit 5   Packed 16-bit Write Buffer Select

0 = select Buffer A for write accesses

1 = select Buffer B for write accesses

Bit 6   Packed 16-bit Double Write Control

Allows a write access to be performed to both Buffer A and Buffer B simultaneously.

0 = disable double writes

1 = enable double writes

3.1.13   DMA Control Register

The DMA control Register sets up the data transfer modes for the DMA controller. Data transfer can be set to byte swapped for big endian hosts.

DMAControl

Region: 0   Offset: 0000.0060h

Read/Write   Reset Value: 0000.0000h

| 31 | 24 | 16 | 8 | 0 |

DMA Data Swap
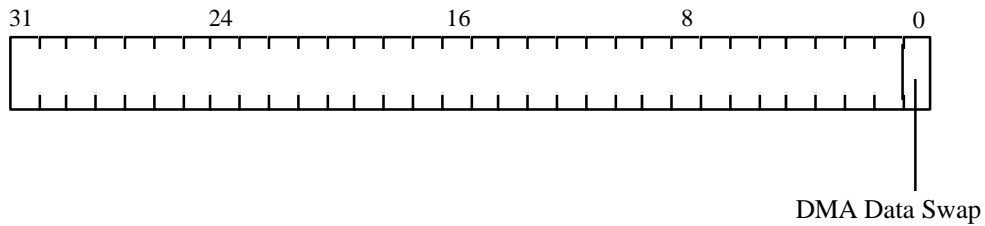
Bit 0   DMA Byte Swap Control

0 = Standard

1 = Byte Swapped

3.1.14   FIFO Disconnect Register

The FIFO Disconnect Register enables input FIFO and output FIFO disconnect on the GLINT 500TX.

Input FIFO and Output FIFO Disconnect are disabled at reset.

FIFODis

Region: 0   Offset: 0000.0068h

Read/Write   Reset Value: 0000.0000h

Output FIFO Disconnect

Input FIFO Disconnect
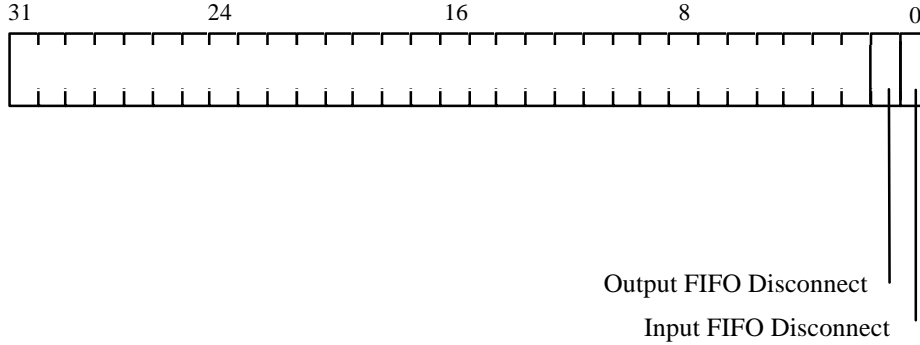
Bit 0   Input FIFO Disconnect enable
                     0 = Disabled (RESET)
                     1 = Enabled

Bit 1   Output FIFO Disconnect enable
                     0 = Disabled (RESET)
                     1 = Enabled

N.B. If a GLINT Delta is used with the GLINT 500TX, then the Input FIFO Disconnect must always be enabled on the GLINT 500TX

3.2   Localbuffer Registers

3.2.1   Localbuffer Memory Control

The Localbuffer memory control register sets the characteristics of the Localbuffer DRAM. The register is initialized at reset time by setting values on Localbuffer data pins (see Reset Control, Section 12). Care must be taken when modifying this register to ensure that the DRAM will function within its worst case timings.

LBMemoryCtl

Region: 0   Offset: 0000.1000h

Read/Write   Reset Value: Determined by Localbuffer data pins
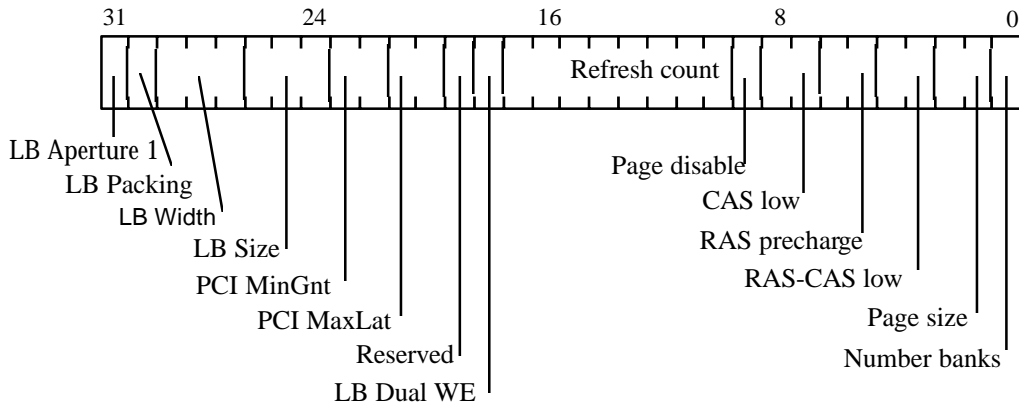
| Bit 0 | Number of banks | LB Reset Bit 0 |

Defines the number of banks of CAS interleaved memory in the localbuffer.

> 0 = 1 bank
> 1 = 2 banks

| Bits 2-1 | Page size | LB Reset Bits 2-1 |

Defines the page size of the DRAM of the memory in the localbuffer. If there are 2 banks of memory, the effective page size is twice this value.

> 0 = 256 pixels
> 1 = 512 pixels
> 2 = 1024 pixels
> 3 = 2048 pixels

| Bits 4-3 | RAS-CAS low | LB Reset Bits 4-3 |

Defines the number of MClks that RAS is asserted before CAS is asserted during a memory access.

> 0 = 2 clocks
> 1 = 3 clocks
> 2 = 4 clocks
> 3 = 5 clocks

Bits 6-5   RAS Precharge   LB Reset Bits 6-5

Defines the RAS Precharge time in terms of MClk periods.

         0 = 2 clocks
         1 = 3 clocks
         2 = 4 clocks
         3 = 5 clocks

Bits 8-7   CAS low   LB Reset Bits 8-7

Defines the CAS low time during a localbuffer access in terms of MClk periods.

         0 = 1 clock
         1 = 2 clocks
         2 = 3 clocks
         3 = 4 clocks

Bit 9   Page mode disable   LB Reset Bit 9

Asserting this bit will cause all localbuffer accesses to perform a full DRAM memory cycle. i.e. Fast Page mode is never used.

         0 = Page mode enabled
         1 = Page mode disabled

Bits 17-10   Refresh count

This field can be used to optimize the DRAM refresh period to the system MClk and the DRAM used for the localbuffer. The refresh period is the value of this field x 16 x MClk period . The Reset value is 20h.

Bit 18   Localbuffer dual Write enables   Read Only   LB Reset Bit 18

x16 DRAM parts come with either 2CAS line and 1 WE line or 1CAS line and 2 WE. The preferred memory parts for GLINT dual CAS lines, however asserting this bit field allows Dual WE parts to be used. In this case, the LBMemCasN lines should be connected to the DRAM WE lines, and the LBMemWeN lines should be connected to the DRAM CAS lines. When x4 or x8 parts are used, this bit should not be set.

         0 = Dual CAS
         1 = Dual Write Enables

Bit 19   Reserved Read Only   LB Reset Bit 19

Bits 21-20   PCI Maximum Latency   Read Only   LB Reset Bits 21-20

Form the top 2 bits of the configuration space Maximum Latency register

Bits 23-22   PCI Minimum Grant   Read Only   LB Reset Bits 23-22

Form the top 2 bits of the configuration space Minimum Grant register

Bits 26-24   Localbuffer visible region size   Read Only   LB Reset Bits 26-24

         0 = 1 MByte
         1 = 2 MBytes
         2 = 4 MBytes
         3 = 8 MBytes
         4 = 16 MBytes
         5 = 32 MBytes
         6 = 64 MBytes
         7 = 0 MBytes

Bits 29-27	Localbuffer width	Read Only	LB Reset Bits 29-27
	0 = 16 Bit		
	1 = 18 Bit		
	2 = 24 Bit		
	3 = 32 Bit		
	4 = 36 Bit		
	5 = 40 Bit		
	6 = 48 Bit		
	7 = Other width		
Bit 30	Localbuffer Bypass Packing	Read Only	LB Reset Bit 30
	0 = 64 bit Localbuffer bypass step		
	1 = 32 bit Localbuffer bypass step		
Bit 31	Second Localbuffer aperture	Read Only	LB Reset Bit 31
	0 = Disabled		
	1 = Enabled		

3.2.1   Localbuffer Memory EDO

The Localbuffer memory EDO register enables and controls the use of EDO DRAM for the Localbuffer and controls the number of page detectors used to control the Localbuffer.

LBMemoryEDO

Region: 0   Offset: 0000.1008h

Read/Write   Reset Value: 0000.0000h

Two Page Enable

Bank Size
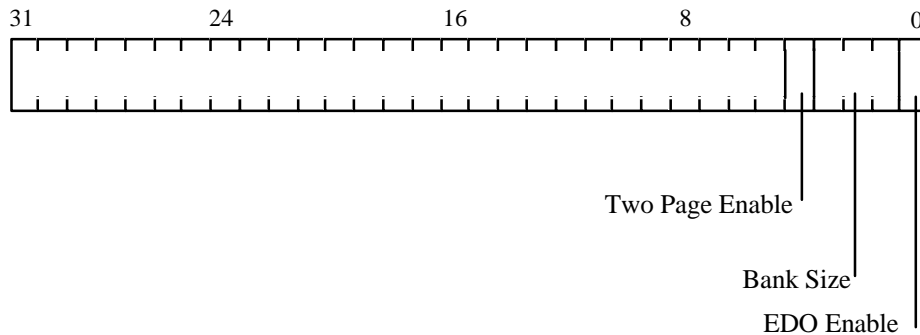
EDO Enable

Bit 0	EDO enable

Enables EDO functionality in the localbuffer.

         0 = EDO disabled   (RESET)
         1 = EDO enabled

Bits 3-1	Bank Size

         0 = Second memory bank disabled   (RESET)
         1 = Second bank starts at 256K pixels
         2 = Second bank starts at 512K pixels
         3 = Second bank starts at 1M pixels
         4 = Second bank starts at 2M pixels
         5 = Second bank starts at 4M pixels
         6 = Second bank starts at 8M pixels
         7 = Reserved

Bit 4	Two Page enable

Enables a separate page detectors for each bank of memory .

         0 = Single Page detector   (RESET)
         1 = Two Page Detectors Enabled

N.B. Bits 31 to 20 of this register return bits 31 to 20 of the LBMemoryCtl register when read.

3.3   Framebuffer Registers

3.3.1   Framebuffer Memory Control

The Framebuffer memory control register sets the characteristics of the Framebuffer VRAM. The register is initialized at reset time by setting values on Localbuffer data pins (see Reset Control, Section 12). Care must be taken when modifying this register to ensure that the VRAM will function within its worst case timings.

FBMemoryCtl

Region: 0   Offset: 0000.1800h

Read/Write   Reset Value: Determined by Framebuffer data pins

| Bits 1-0 | RAS-CAS low | FB Reset Bits 1-0 |

Defines the period from RAS asserted to CAS asserted during a framebuffer access in terms of MClks.

> 0 = 2 clocks
> 1 = 3 clocks
> 2 = 4 clocks
> 3 = 5 clocks

| Bits 3-2 | RAS Precharge | FB Reset Bits 3-2 |

Defines the RAS Precharge period in MClks.

> 0 = 2 clocks
> 1 = 3 clocks
> 2 = 4 clocks
> 3 = 5 clocks

| Bits 5-4 | CAS low | FB Reset Bits 5-4 |

Determines the CAS active time during a framebuffer memory access.

> 0 = 1 clock
> 1 = 2 clocks
> 2 = 3 clocks
> 3 = 4 clocks

| Bit 13-6 | Refresh count |

This field can be used to optimize the VRAM refresh period to the system MClk and the VRAM used for the framebuffer. The refresh period is the value of this field x 16 x MClk period.

> Reset value 20h

Bit 14   Page mode disable   FB Reset Bit 6

Asserting this bit will cause all framebuffer accesses to perform a full VRAM memory cycle.
i.e. Fast Page mode is never used.

> 0 = Page mode enabled
> 1 = Page mode disabled

Bits 19-15   00000h Read only

Bits 21-20   Reserved

Bit 22   EDO DRAM   FB Reset Bit 22

This field is for informational purposes only and can be used to correctly configure the
Localbuffer through software.

0 = Fast Page Mode DRAM fitted for Localbuffer

1 = EDO DRAM fitted for Localbuffer

Bits 25-23   Reserved   FB Reset Bits 25-23

Bit 26   Base Class Zero   Read only   FB Reset Bit 26

> 0 = GLINT 500TX returns a PCI Base class and sub-class of 03h 80h
> 1 = GLINT 500 TX returns a PCI Base Class and sub-Class of 00h 00h

> See Section 2.1.4

Bit 27   Reserved Read only   FB Reset Bit 27

Bit 28   Framebuffer Aperture 1 Enable   Read only   FB Reset Bit 28

Bits 31-29   Framebuffer Visible Region Size   Read only   FB Reset Bits 31-29

> 0 = 1 MByte
> 1 = 2 MBytes
> 2 = 4 MBytes
> 3 = 8 MBytes
> 4 = 16 MBytes
> 5 = 32 MBytes
> 6 = Reserved
> 7 = 0 MBytes

3.3.2   Framebuffer Mode Select

The Framebuffer mode select register sets the mode of the Framebuffer VRAM. The register is initialized at reset time by setting values on Localbuffer data pins (see Reset Control, Section 12).

FBModeSel

Region: 0   Offset: 0000.1808h

Read/Write   Reset Value: Determined by Framebuffer data bits

```
 31              24              16               8               0
┌──────────────────────────────────────────────────────────────────┐
│                      00000h                                        │
└──────────────────────────────────────────────────────────────────┘
```

FB Dual WE
FB Block
FB Interleave
Ext VTG sel
Transfer Disable
SFB Mode
Fast Mode Disable
Reserved
Reserved
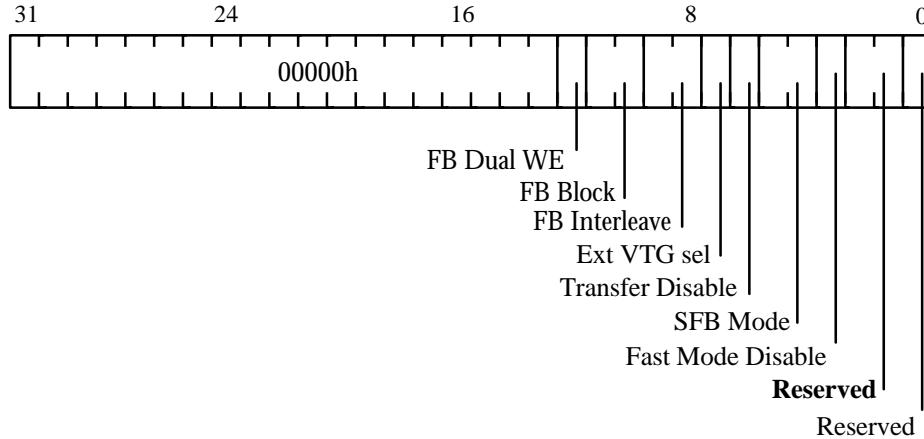
Bit 0	Framebuffer Width	Read Only

This field always returns the value 1 indicating that the Framebuffer width is 64 bits for backward compatibility with the GLINT 300SX.

Bits 2-1   Reserved

This field always returns the value 3.

Bit 3   Fast Mode Disable   FB Reset Bit 10

Setting this field turns off some of the memory access optimizations.

        0 = Fast mode enabled
        1 = Fast mode disabled

Bit 5-4   Shared Framebuffer Mode   Read only   FB Reset Bits 12-11

If TX Enhanced mode is not set, this 2 bit field determines the Shared Framebuffer mode.

        0 = Disabled
        1 = Arbiter (Primary controller)
        2 = Requester (Secondary controller)
        3 = Reserved

This is compatible with GLINT 300SX.

In TX enhanced mode is set , then this field is used in conjunction with the TX Enhanced Shared Memory and SFBModeSwap fields of the TX Shared Memory Control register to determine Shared memory control. See section 7.3 for more details

Bit 6   Transfer disable   FB Reset Bit 13

        0 = Video memory transfer cycles enabled
        1 = Video memory transfer cycles disabled

Bit 7   External VTG Select   FB Reset Bit 14

> 0 = Select internal Video Timing Generator
> 1 = Select external Video Timing Generator

Bits 9-8   Framebuffer interleave   FB Reset Bits 16-15

This field determines how many interleaved banks of memory are available. e.g. Framebuffer Width = 1 and Framebuffer Interleave = 1 means 2 x64bit banks of memory interleaved by CAS.

> 0 = 1 way
> 1 = 2 way
> 2 = 4 way
> 3 = Reserved

Bits 11-10   Framebuffer block fill size   FB Reset Bits 18-17

The field is used by the memory controller to perform VRAM block fill and selects the block fill size of an individual VRAM. It can be used by the software in conjunction with the values in the Framebuffer Width field and the Framebuffer Interleave field to determine the actual block fill size available to GLINT.

> .   0 = Block fill unsupported
> 1 = 4 pixel per VRAM block fill
> 2 = 8 pixel per VRAM block fill
> 3 = Reserved

Bit 12   Framebuffer Dual Write Enables   FB Reset Bit 19

x16 VRAM parts come with either 2 CAS line and 1 WE line or 1CAS line and 2 WE. The preferred memory parts for GLINT have dual CAS lines, however asserting this bit field allows Dual WE parts to be used. In this case, the FBMemCasN lines should be connected to the VRAM WE lines, and the FBMemWeN lines should be connected to the VRAM CAS lines. When x4 or x8 parts are used, this bit should not be set.

> 0 = Dual CAS VRAMs
> 1 = Dual WE VRAMs

Bits 31-13   00000h

3.3.3 Framebuffer Graphics Core Write Mask

The Framebuffer GC write mask register is a read only register to allow the current Graphics Core write mask to be read. This register is for diagnostic purposes only.

FBGCWrMask

Region: 0   Offset: 0000.1810h

Read   Reset Value: FFFF.FFFFh

31						24								16							8								0
												Write Mask																		
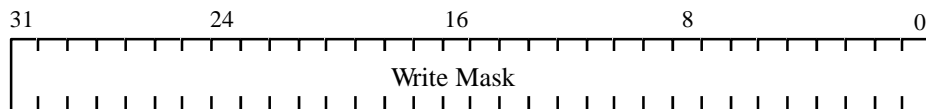
Bits 31-0   Graphics Core Write Mask

3.3.4 Framebuffer Graphics Core Color Lower

The Framebuffer GC color lower register is a read only register to allow the current Graphics Core color low 32 bits to be read. This register is for diagnostic purposes only.

FBGCColorLower

Region: 0   Offset: 0000.1818h

Read   Reset Value: XXXX.XXXXh

31						24								16							8								0
												Color Lower																		
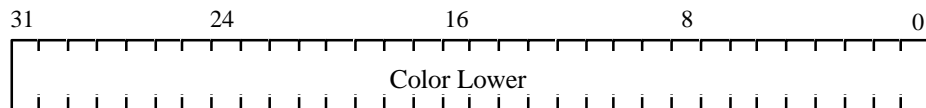
Bits 31-0   Graphics Core Color Mask

3.3.5   Framebuffer TX Shared Memory Control

The Framebuffer TX shared memory control register sets the characteristics of shared framebuffer interface for the GLINT 500TX..

FBTXMemCtl

Region: 0   Offset: 0000.1820h

Read/Write   Reset Value: Determined by TX Control Pin
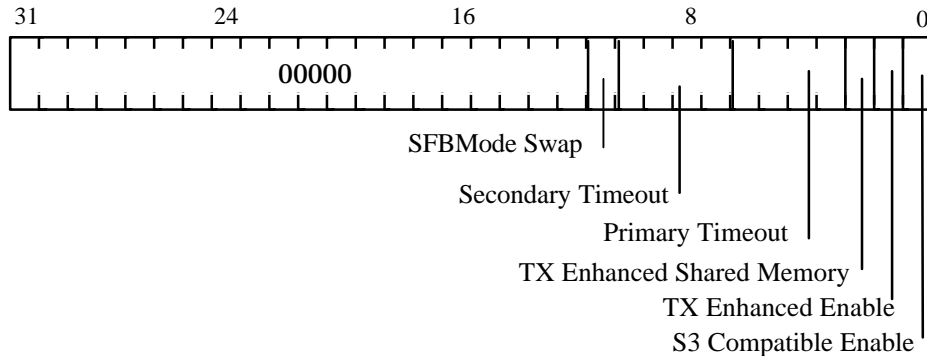
Bit 0	S3 Compatible Enable

Sets the Framebuffer memory controller to be compatible with the S3 964/968

Bit 1	TX Enhanced Enable	Read Only	TX Control Pin

Indicates that certain GLINT 500TX enhanced features are available

Bit 2	TX Enhanced Shared Memory	Read Only	FB Reset Bit 20

This bit can only be set if the TXEnhanced pin is pulled high.

In TX enhanced mode this value is used together with the Shared Framebuffer Mode bits in the FBModeSel register and the SFBModeSwap field to determine the Shared Memory configuration. See Section 7.3.

Bits 6-3	Primary Timeout

This 4 bit field provides a timeout count for the Shared Memory arbiter. When GLINT 500TX is a primary controller it will ignore requests from the secondary controller until the timeout counter has reached zero. The timeout period is MClk x 16 .

Reset value 0h

Bits 10-7	Secondary Timeout

This 4 bit field provides a timeout counter for the Shared Memory arbiter. When GLINT 500TX is a primary controller, the timeout counter is used to gate requests from the GLINT 500TX for the memory bus when the secondary controller has the bus. The timeout period is MClk x 16.

Reset value 0h

Bit 11	SFBModeSwap	Read Only	FB Reset Bit 21

In TX enhanced mode this value is used together with the Shared Framebuffer Mode bits in the FBModeSel register and the TXEnhanced SharedMemory field to determine the Shared Memory configuration. See Section 7.3.

3.3.6   Framebuffer Bypass Write Mask

The Framebuffer write mask register defines the hardware write used for bypass accesses.

FBWrMaskk

Region: 0   Offset: 0000.1830h

Read   Reset Value: FFFF.FFFFh

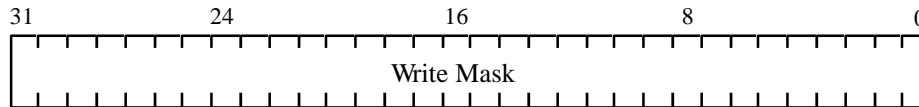| 31	24	16	8	0
		Write Mask		

Bits 31-0   Graphics Core Write Mask

3.3.7   Framebuffer Graphics Core Color Upper

The Framebuffer GC color upper register is a read only register to allow the current Graphics Core color high 32 bits to be read. This register is for diagnostic purposes only.

FBGCColorUpper

Region: 0   Offset: 0000.1838h

Read   Reset Value: XXXX.XXXXh

31	24	16	8	0
		Color Upper		
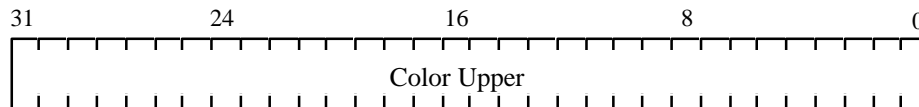
Bits 31-0   Graphics Core Color Upper

3.4   Graphics Core Registers

All the Graphics Core registers in the GLINT 500TX are addressed in this part of region 0.
The address for each register and associated data fields is defined in the GLINT
Programmers Reference Manual.

31	24	16	8	0	OFFSET
Core Register 1					0000.8000h
Core Register 2					0000.8008h
Core Register N					0000.8FF8h
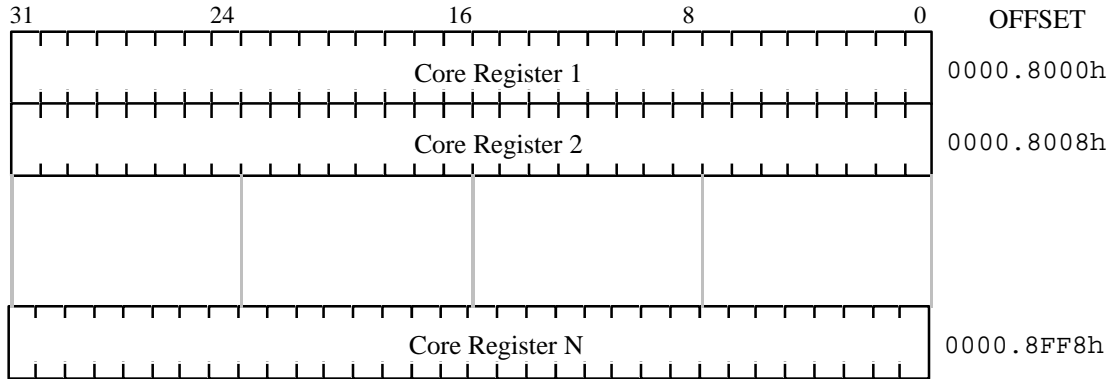
Note. Not all the available register locations are used within the Graphics Core.
        The registers are on 64 bit boundaries.

3.5   Graphics Core FIFO Interface

The Graphics Core FIFO interface provides a port through which both GC register addresses and data can be sent to the input FIFO. A range of 4 KBytes of host space is provided although all data may be sent through one address in the range. ALL accesses go directly to the FIFO, the range is provided to allow for data transfer schemes which force the use of incrementing addresses. Before writing to the input FIFO the user must check that there is sufficient space by reading the InFIFOSpace register.

If the FIFO interface is used, then data is typically sent to the GLINT 500TX in pairs, an address word which addresses the register to be updated, followed by the data to be sent to the register. Note that the GC registers can not be read through this interface. Command buffers generated to be sent to the input FIFO interface may be read directly by the GLINT 500TX by using the DMA controller.

A data formatting scheme is provided to allow for multiple data words to be sent with one address word where adjacent or grouped registers are being written, or where one register is to be written many times.

For more information on the direct FIFO interface data buffer formats please refer to the GLINT Programmers Reference Manual.
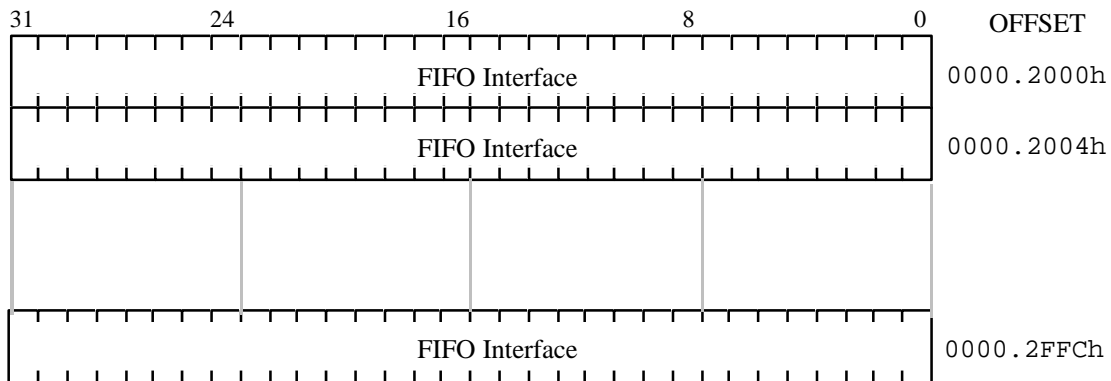
Note. The FIFO interface can be accessed at 32 bit boundaries. This is to allow a direct copy from a DMA format buffer.

4. Internal Video Timing Generator

The GLINT 500TX provides a timing generator to enable a complete framebuffer to be implemented with just the addition of VRAM, video clock generator and a suitable RAMDAC. The timing generator produces appropriate Horizontal and Vertical Syncs and Blanks from an external video clock. It controls the instigation of VRAM transfer cycles in the Framebuffer Interface and provides the VRAM transfer addresses. It also controls the VRAM serial clocks and serial output enables.

It is anticipated that GLINT 500TX will be used with more complex framebuffers than the internal timing generator can drive. For this reason, the timing generator can be disabled and the Framebuffer Interface can be controlled by external circuitry to generate VRAM transfer cycles.

The timing generator is controlled through a series of registers accessible from the PCI bus. There is no access to the timing generator from the GLINT 500TX core.

The timing generator operates entirely from a video clock (VClk). Suitable internal resynchronization occurs between the timing generator and both the PCI interface (PCIClk) and the Framebuffer Interface (MClk).

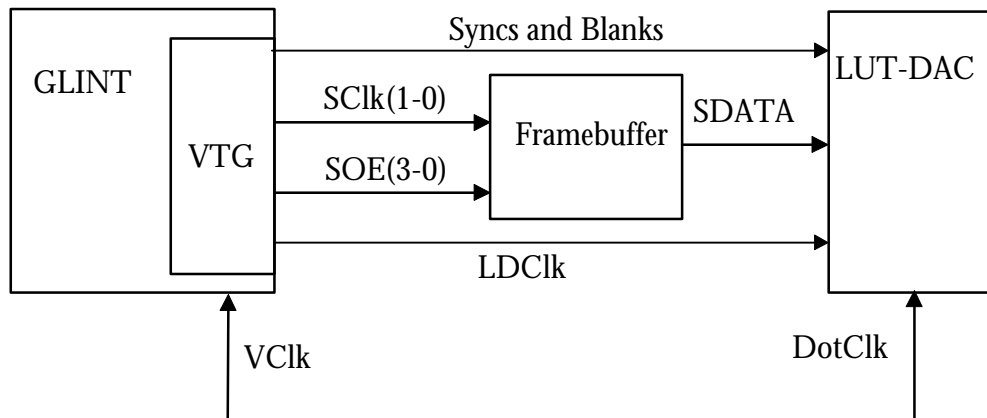Figure 4-1. Video Timing Generator

4.1   Overview of Internal VTG features

- Generates VSync, HSync, CompositeBlank, CompositeSync, all with programmable polarity.

- 12 bit horizontal and vertical counters.

- Video clock of up to 80 MHz.

- Linearly mapped framebuffer.

- VRAMs with split transfer required.

- VRAMs with and without QSF.

- Programmable size of VRAM split register - 128 or 256.

- Programmable transfer address at start of frame for double buffering support.

- 1, 2 or 4 way Interleaving of VRAM serial outputs.

4.2 Internal VTG Register Set

4.2.1 Horizontal Limit

The Horizontal Limit register defines the horizontal period of the video display. The internal horizontal counter is clocked by VClk. This counter starts at 1 , counts to the value set in the Horizontal Count limit register and resets to 1 again.

VTGHLimit

Region: 0   Offset: 0000.3000h

Read/Write   Reset Value: 001h

31	24	16	8	0
			Horizontal Limit	
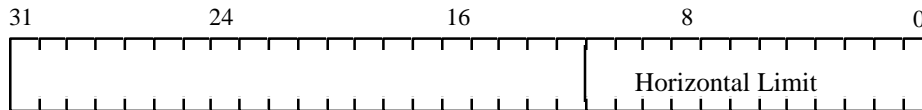
Bits 11-0   Horizontal Limit

4.2.2 Horizontal Sync Start Register

The Horizontal Sync starts when the internal Horizontal Counter reaches the value stored in the Horizontal Sync Start register.

VTGHSyncStart

Region: 0   Offset: 0000.3008h

Read/Write   Reset Value: XXXh

31	24	16	8	0
			Horizontal Sync Start	
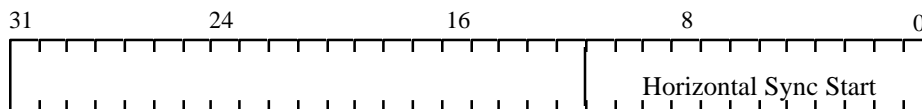
Bits 11-0   Horizontal Sync Start

4.2.3 Horizontal Sync End

The Horizontal Sync ends when the internal Horizontal Counter reaches the value stored in the Horizontal Sync End register.

VTGHSyncEnd

Region: 0   Offset: 0000.3010h

Read/Write   Reset Value: XXXh

31	24	16	8	0
			Horizontal Sync End	

Bits 11-0   Horizontal Sync End

4.2.4   Horizontal Blank End

The Horizontal Blank starts when the internal Counter is reset to 1. The Horizontal Blank ends when the internal Horizontal Counter reaches the value stored in the Horizontal Blank End register.

VTGHBlankEnd

Region: 0   Offset: 0000.3018h

Read/Write   Reset Value: XXXh

31	24	16	8	0
			Horizontal Blank End	
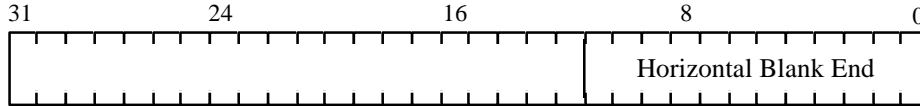
Bits 11-0   Horizontal Blank End

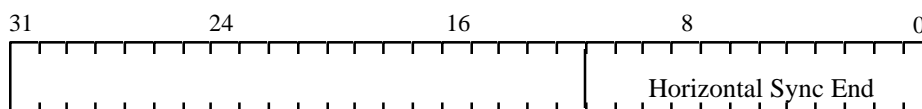4.2.5   Vertical Limit

The Vertical Limit register defines the vertical period of the video display. The internal vertical counter is clocked by VClk at the start of every Horizontal line. This counter starts at 1 , counts to the value set in the Vertical Count limit register and resets to 1 again.

VTGVLimit

Region: 0   Offset: 0000.3020h

Read/Write   Reset Value: 001h

31	24	16	8	0
			Vertical Limit	

Bits 11-0   Vertical Count

4.2.6   Vertical Sync Start

The Vertical Sync starts when the internal Vertical Counter reaches the value stored in the Vertical Sync Start register.

VTGVSyncStart

Region: 0   Offset: 0000.3028h

Read/Write   Reset Value: XXXh

31	24	16	8	0
			Vertical Sync Start	

Bits 11-0   Vertical Sync Start

4.2.7   Vertical Sync End

The Vertical Sync ends when the internal Vertical Counter reaches the value stored in the Vertical Sync End register.

VTGVSyncEnd

Region: 0   Offset: 0000.3030h

Read/Write   Reset Value: XXXh
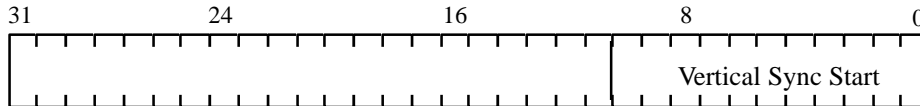
31		24		16		8		0
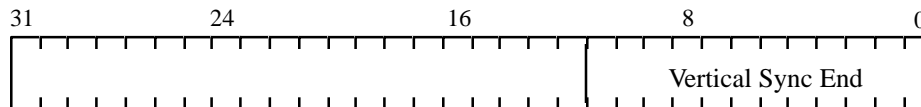
Vertical Sync End

Bits 11-0   Vertical Sync End

4.2.8   Vertical Blank End

The Vertical Blank ends when the internal Vertical Counter reaches the value stored in the Vertical Blank End register.

VTGVBlankEnd

Region: 0   Offset: 0000.3038h

Read/Write   Reset Value: XXXh

31		24		16		8		0
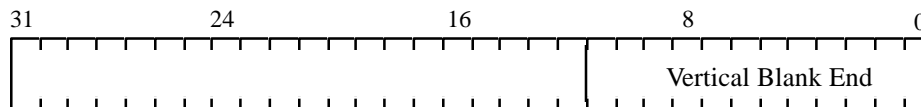
Vertical Blank End

Bits 11-0   Vertical Blank End

4.2.9   Horizontal Gate Start

The Horizontal Gate is an internal signal used to gate the VRAM serial clocks SClk0 and SClk1. Between HGate Start and HGate End, the serial clocks are enabled. The Horizontal Gate is typically set to the inverse of Horizontal Blank with a possible shift to allow for external delays in the Blank and serial clock/data paths. The internal Horizontal Gate signal starts when the internal Horizontal Counter matches Horizontal Gate Start register.

VTGHGateStart

Region: 0   Offset: 0000.3040h

Read/Write   Reset Value: XXXh

31		24		16		8		0

Horizontal Gate Start
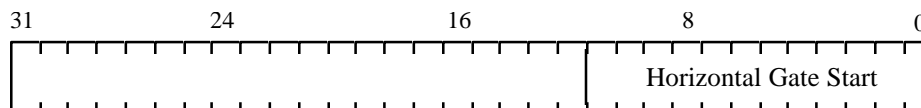
Bits 11-0   Horizontal Gate Start

4.2.10   Horizontal Gate End

The internal Horizontal Gate signal ends when the internal Horizontal Counter matches the Horizontal Gate End register.

VTGHGateEnd

Region: 0   Offset: 0000.3048h

Read/Write   Reset Value: XXXh

31	24	16	8	0

Horizontal Gate End
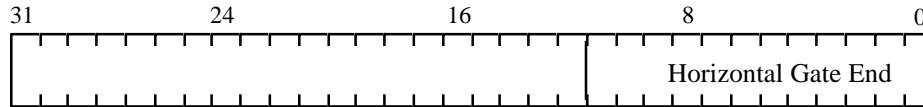
Bits 11-0   Horizontal Gate End

4.2.11   Vertical Gate Start

The internal Vertical Gate signal is used to reset the VRAM transfer cycle controller to perform a full transfer at the start of a frame. It is typically active for the Horizontal line before the end of vertical blank. The internal Vertical Gate signal starts when the internal Vertical Counter matches Vertical Gate Start register.

VTGVGateStart

Region: 0   Offset: 0000.3050h

Read/Write   Reset Value: XXXh

31	24	16	8	0

Vertical Gate Start
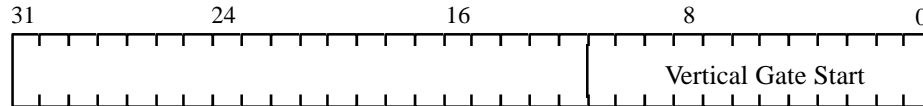
Bits 11-0   Vertical Gate Start

4.2.12   Vertical Gate End

The internal Vertical Gate signal ends when the internal Vertical Counter matches the Vertical Gate End register.

VTGVGateEnd

Region: 0   Offset: 0000.3058h

Read/Write   Reset Value: XXXh

31	24	16	8	0
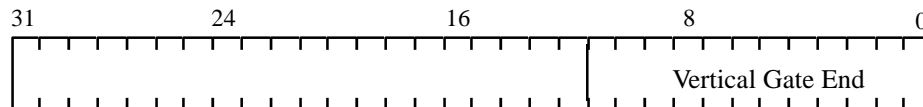
Vertical Gate End

Bits 11-0   Vertical Gate End

4.2.13   Polarity Control

The Polarity Control Register determines the polarities of the output signals HSync, VSync, CBlank and CompSync.

VTGPolarity

Region: 0   Offset: 0000.3060h

Read/Write   Reset Value: D5h
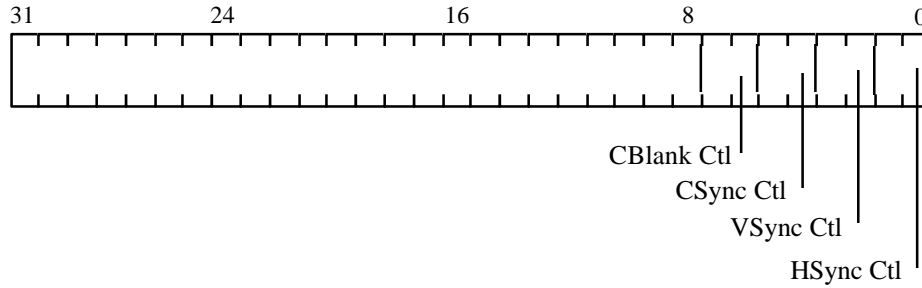
Bits 1-0   HSync Ctl

        0 = Active High
        1 = Forced High
        2 = Active Low
        3 = Forced Low

Bits 3-2   VSync Ctl

        0 = Active High
        1 = Forced High
        2 = Active Low
        3 = Forced Low

Bits 5-4   CSync Ctl

        0 = Active High
        1 = Forced High
        2 = Active Low
        3 = Forced Low

Bits 7-6   CBlank Ctl

        0 = Active High
        1 = Forced High
        2 = Active Low
        3 = Forced Low

4.2.14   Frame Row Address register

The contents of the Frame Row Address register determines the VRAM row loaded into the VRAM shift register at the start of frame. While the frame is active, VRAM split transfers are generated to reload the VRAM shift register. The transfer addresses required are automatically generated internally, starting from this value. At the start of the next frame, a full transfer reloads the shift register with the row specified by this register again. The full transfer split register start address is always zero.

This register can be programmed for double-buffering, if the framebuffer is large enough, by starting the buffers on two different rows and altering the value to swap buffers.

To avoid any possible display artifact, this register should not be changed at the time the VRAM full transfer cycle is occurring at the start of frame. It is recommended that the register is updated during the active vertical period.

VTGFrameRowAddr

Region: 0   Offset: 0000.3068h

Read/Write   Reset Value: 00h

Bits 8-0   Frame Row Address

4.2.15   Vertical Line Number

This read only register returns the value of the internal Vertical counter. It can be used to determine when the display is in the vertical blanking interval.

The display is in vertical blanking if the Vertical Line Number is between 1 and the value in the Vertical Blank End register. The display is active if the Vertical Line number is greater than the Vertical Blank End value.

VTGVLineNumber

Region: 0   Offset: 0000.3070h

Read   Reset Value: 001h

Bits 11-0   Vertical Line Number

4.2.16   Serial Clock Control

VTGSerialClk

Region: 0   Offset: 0000.3078h

Read/Write   Reset Value: XXh

31   24   16   8   0

SOE Ctl

SClk Ctl

Split Size
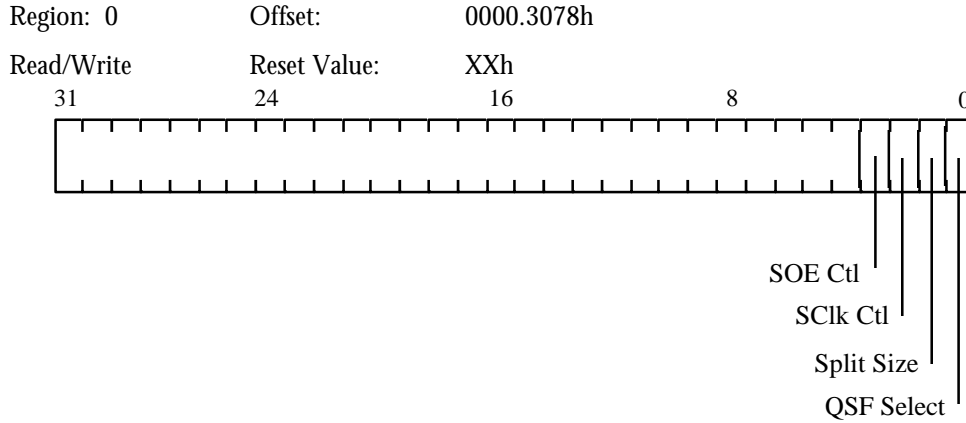
QSF Select

Bit 0   QSF Select

> 0 = External QSF
> 1 = Internal QSF

When this bit is asserted, the transfer address generator counts VRAM serial clocks and generates an internal QSF signal to initiate VRAM transfer cycles. When this bit is negated, the QSF pin is used to initiate transfer cycles. (IBM 4M VRAM do not generate QSF, so an internal QSF must be generated).

Bit 1   Split Size

> 0 = 128 word split transfer register
> 1 = 256 word split transfer register

This bit is set to reflect the size of the VRAM transfer register in split transfer mode. 0 = 128 , 1 = 256. Most 256Kx4 and 256K x 8 VRAMs have a split register of 256. IBM 4M VRAMs have a split register size of 128. This field is used in the generation of the internal QSF.

Bit 2   SClk Ctl

This field is used to control the generation of SCLK0 and SCLK1 as described in section 4.4 below

Bit 3   SOE Ctl

This field is used to control the generation of SOE0 , SOE1, SOE2 and SOE3 as described in section 4.4 below.

4.2.17   Mode Control

VTGModeCtl

Region: 0   Offset: 0000.3080h

Read/Write   Reset Value: 0000h

```
  31           24            16             8             0
 ┌─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┬─┐
 │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │
 └─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┴─┘
```
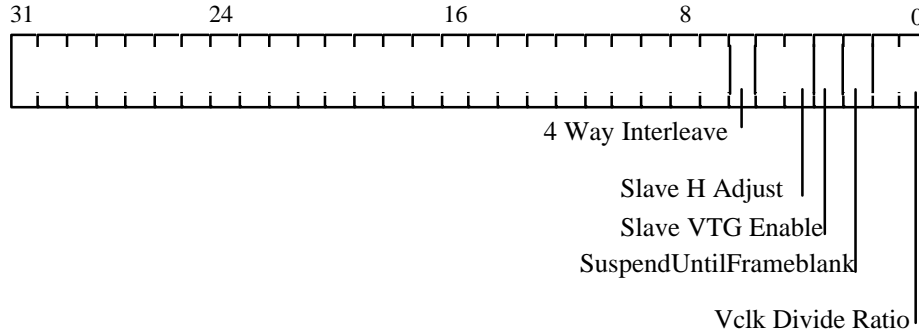
4 Way Interleave

Slave H Adjust

Slave VTG Enable

SuspendUntilFrameblank

Vclk Divide Ratio

Bits 1-0   VCLK Divide Ratio

          0 = Use VCLK undivided

          1 = Use VClk/2

          2 = Use VClk/4

          3 = Use VClk/8

GLINT 500TX can generate a LDClk which is divided down from the incoming VCLK. The VClk Divide ratio is used to select the division .The SClk and SOE signals are derived from the LDClk. Normal usage has this field at 0.

Bit 2   SuspendUntilFrameBlank Enable

          0 = Complete immediately

          1 = wait for VBLANK

The GLINT 500TX has a mechanism in the Graphics Core to flush outstanding writes to the framebuffer and then suspend any succeeding reads or writes until the next vertical blank period. This field is used to enable this feature in the timing generator. If the field is not set then no suspension occurs. This is the reset condition. The field should not be set until the timing generator is running to avoid the possibility of suspending the Graphics Core when no VBLANK will occur.

Bit 3   Slave VTG Enable

          0 = Disable

          1 = Enable

This field enables the syncing of the timing generator to an external VSYNC. The master VSYNC is input to the GLINT 500TX on the QSF pin. The polarity of the VSYNC is taken to be the polarity of the internal VSYNC defined in the VTGPolarity register.

Bits 5-4   Slave Hadjust

                    0 = adjust by 0 VClks

                    1 = adjust by 1 VClks

                    2 = adjust by 2 VClks

                    3 = adjust by 3 VClks

This field allows the internal timing generator to be adjusted by a number of VClks relative to the incoming master VSYNC.

Bit 6   4-way Interleave Enable

                    0 = Disable

                    1 = Enable

When this bit is set, and the TXEnhanced pin is pulled high, then two additional Serial O/p enables are generated allowing 4 banks of memory to be interleaved into the RAMDAC.

4.3   VTG Configuration

4.3.1   Horizontal Timing Specifications.

A Horizontal counter (VTGHCount) runs off VClk. The counter starts at 1 and counts to the value in VTGHLimit and then reloads. This defines the Horizontal period. i.e. VTGHLimit x VClkPeriod. The horizontal blank and sync timing is derived from this counter and the values stored in the parameter registers.

At reset VTGHLimit is reset with '1'. This effectively freezes the counter until the VTGHLimit register is loaded.

Horizontal blank starts at VTGHCount = 1.

Horizontal blank ends at VTGHCount = VTGHBlankEnd.

Horizontal blank width = VTGHBlankEnd x VClkPeriod.

Horizontal sync. starts at VTGHcount = VTGHSyncStart and ends at VTGHSyncEnd.

Horizontal sync. width = (VTGHsyncEnd - VTGHSyncStart) x VClkperiod.
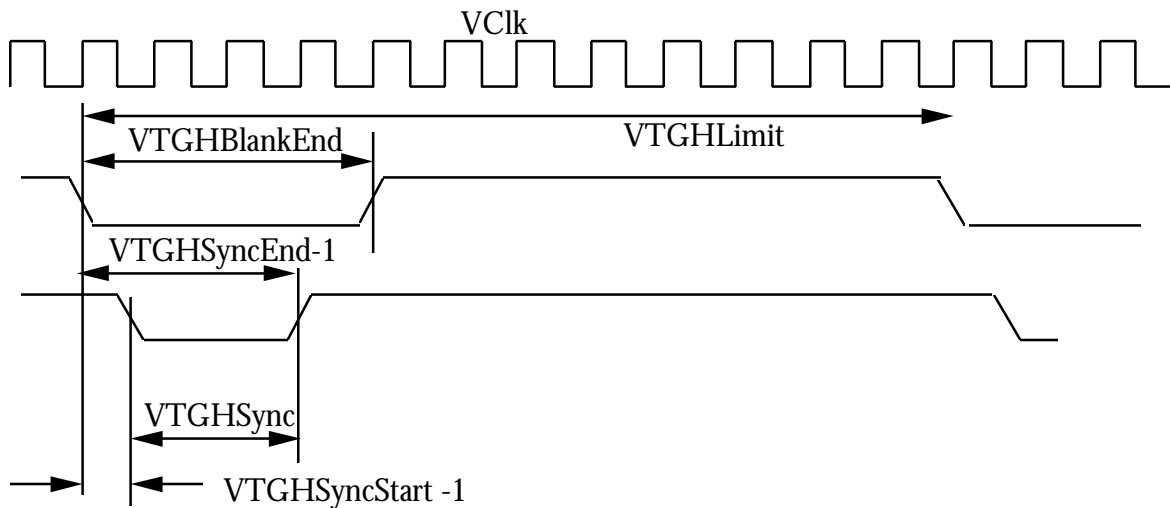
Figure 4-2. Horizontal Timing

4.3.2   Vertical Timing Specifications.

The vertical signals are specified in terms of numbers of lines. A vertical counter (VTGVCount) counts lines starting at 1 and counts to the value in VTGVLimit and then reloads. The vertical period or frame rate is defined as VTGVLimit x Horizontal period. This is VTGVLimit x VTGHLimit x VClkPeriod. The vertical blank and sync timing is derived from this counter and the values stored in the parameter registers.

At reset VTGVLimit is reset with '1'. This effectively freezes the counter until the VTGVLimit register is loaded.

Vertical Blank is asserted on the active edge of Horizontal blank

Vertical blank starts at VTGVCount = 1 and

Vertical blank ends at VTGVCount = VTGVBlankEnd.

Vertical blank width = VTGVBlankEnd x HorizontalPeriod.

The Vertical sync is asserted on the active edge of Horizontal sync.

Vertical sync starts at (VTGVCount = VTGVSyncStart -1)

Vertical sync ends at VTGVSyncEnd - 1

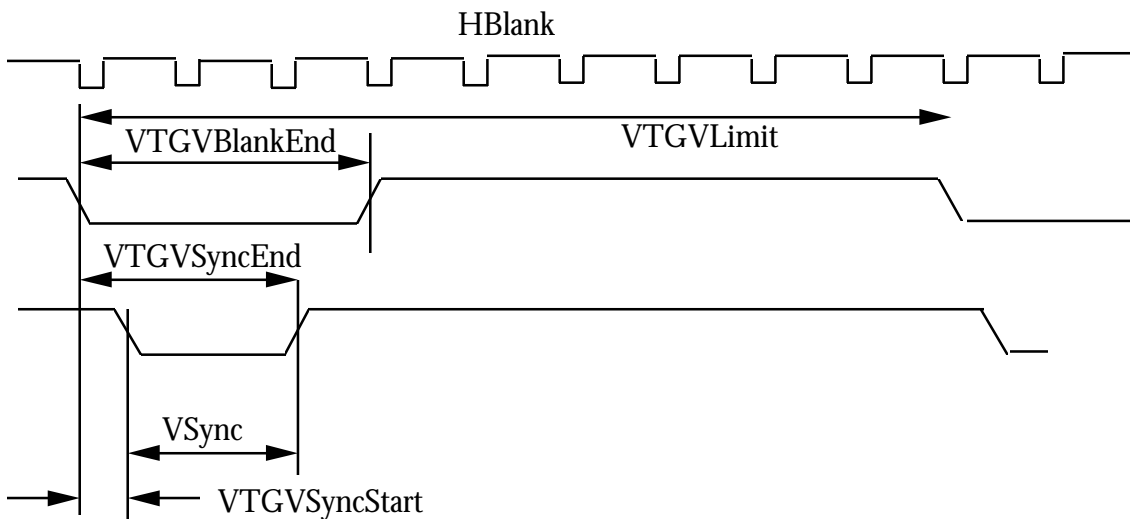Vertical sync. width = (VTGVsyncEnd - VTGVSync start) x HorizontalPeriod

Figure 4-3. Vertical Timing

4.3.3   Sync and Blank Generation

Composite Sync (CompSync.) is the logical OR of HSync and VSync.

Composite Blank (CBlank) is the logical OR of HBlank and VBlank.

VSync, HSync, CompSync and CBlank are all outputs from GLINT 500TX. The polarity of these signals is controlled by the Polarity Control Register.

4.3.4   Vertical and Horizontal Gate Specification

Hgate is generated from VTGHGateStart and VTGHGateEnd in the same way as Hsync. i.e.

Hgate = (VTGHGateEnd - VTGHGateStart) x VClkPeriod

Similarly VGate is generated from VTGVGateStart and VTGVGateEnd

VGate = (VTGVGateEnd - VTGVGateStart) x HorizontalPeriod.

VGate and HGate are used to control the VRAM transfer requester and to gate the VRAM serial clock. HGate is typically set to be the inverse of HBlank with a shift of a number of clocks to allow the VRAM serial data to reach the RAMDAC synchronized correctly to the blanking signal. VGate is typically set during the line before the end of Vertical Blank.

4.3.5   VRAM Transfer Control

The video display from GLINT 500TX is generated by connecting the framebuffer VRAM serial ports to the RAMDAC. The VRAM serial shift registers must be kept loaded with the correct data to generate the display. The framebuffer must be linearly mapped to use the internal timing generator/transfer address controller.

At the end of the vertical blanking, a VRAM full transfer cycle is performed using the address loaded in the Frame Row Address register. This defines the VRAM RAS address start point.

The VRAM serial clock (SClk) is gated with HGate and VGate to only clock during the active part of active lines. If an external QSF signal is available which indicates when the VRAM shift register is half empty, split transfer cycles are performed which reload the empty half of the shift register. This continues until the end of the frame.

If no external QSF signal is available then the Internal QSF bit of the Serial Clock Control register must be set. An internal QSF is generated by effectively counting SClks until the size of the VRAM split register is reached and QSF is toggled. Split register sizes of both 256 bits and 128 bits are supported by setting the Split RegisterSize bit of the Serial Clock Control register appropriately.

For a split register size of 256, the row address and column address bit 8 is incremented every time QSF toggles. For a split register size of 128, the row address and column address bits 8 and 7 are incremented every time QSF toggles.

4.4 VRAM Serial Port Control

There are numerous ways of controlling the framebuffer serial port to generate the display. The serial port interleave may be one, two or four way depending on the number of banks of memory and the RAMDAC port width. The register settings for these different interleaves is listed in Table 4.1 below.

Table 4.1. Options For Serial Port Control

4way	TX Enhanced	SOE Ctl	SClk Ctl	Display source	SClk freq.	serial port interleave
X	0	0	0	SOE0	LDCLK	1-way bank0
X	0	1	0	SOE1	LDCLK	1-way bank1
X	0	X	1	SOE0,1	LDCLK/2	2-way bank0,1
0	1	0	1	SOE0,1	LDCLK/2	2-way bank0,1
0	1	1	1	SOE2,3	LDCLK/2	2-way bank2,3
1	1	X	X	SOE0,1,2,3	LDCLK/4	4way

The first 3 modes are compatible with GLINT 300SX. The latter 3 modes are new to GLINT 500TX.

4.4.1   One-Way Interleaved

Serial data is clocked out of either Bank 0 or Bank 1. This is controlled using the SOE Ctl field of the Serial Clock Control register. There is no dynamic switching from bank 0 to bank 1.

SClk0 and SClk1 are identical in this case and are gated versions of the RAMDAC LDClk.
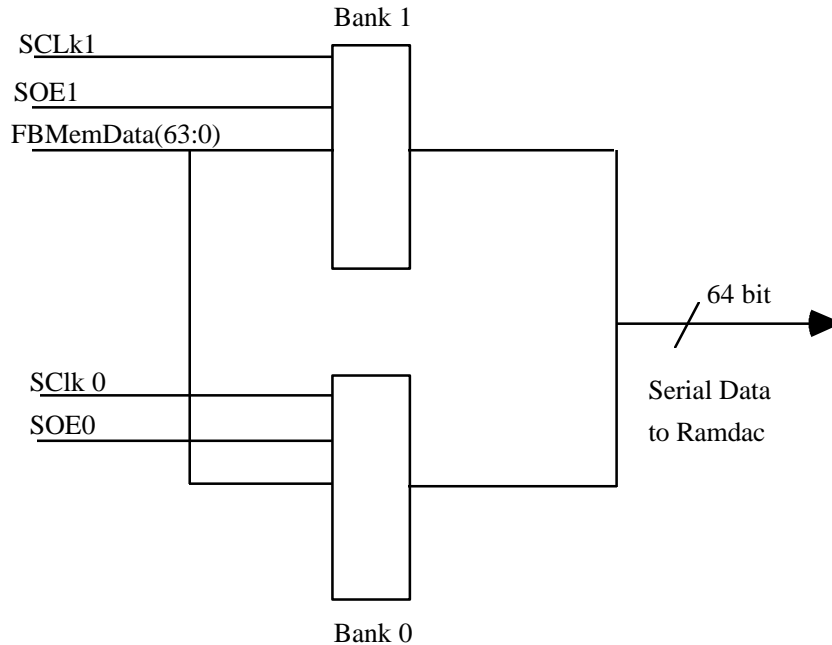
Figure 4.4 Serial Control of 1-Way interleaved Display.

4.4.2   Two-Way Interleaved

In this mode, Bank 0 and Bank 1 are interleaved, and the display is taken alternately from each using SOE0 and SOE1. SCLK0 and SCLK1 are again gated on during the active scan line and run at RAMDAC LDClk/2. This is compatible with GLINT 300SX.

If the GLINT 500TX has the TXEnhanced pin pulled high, then the SOE2 and SOE3 pins are activated. These can be used to allow display from an additional 2 banks of memory. In two-way interleaved mode the SOE Ctl field of the Serial Clock Control register is used to select whether the Bank 0 and Bank 1 are outputting data onto the Serial data bus, or whether Bank 2 and Bank 3 are used.
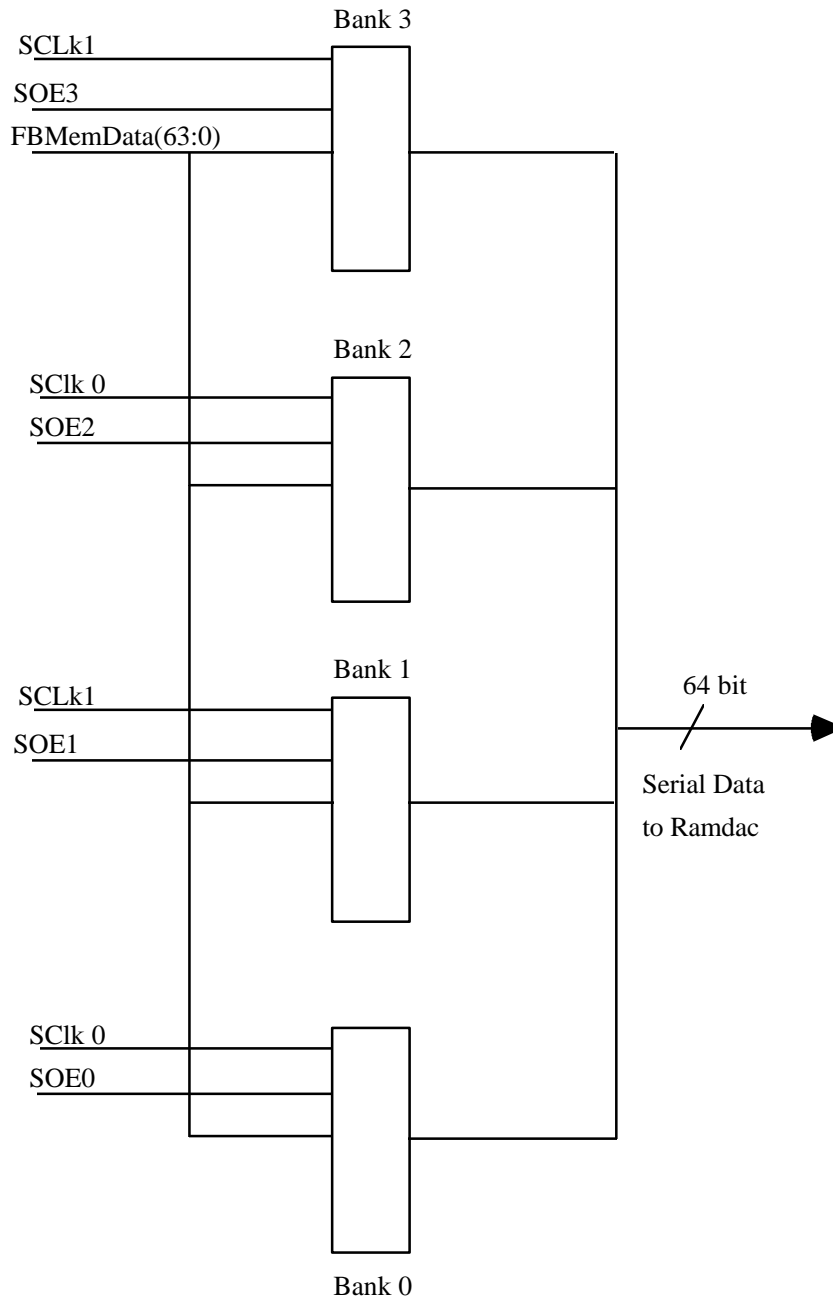
Figure 4.5 2-Way Or 4-Way interleaved Serial Port With 64bit RAMDAC.
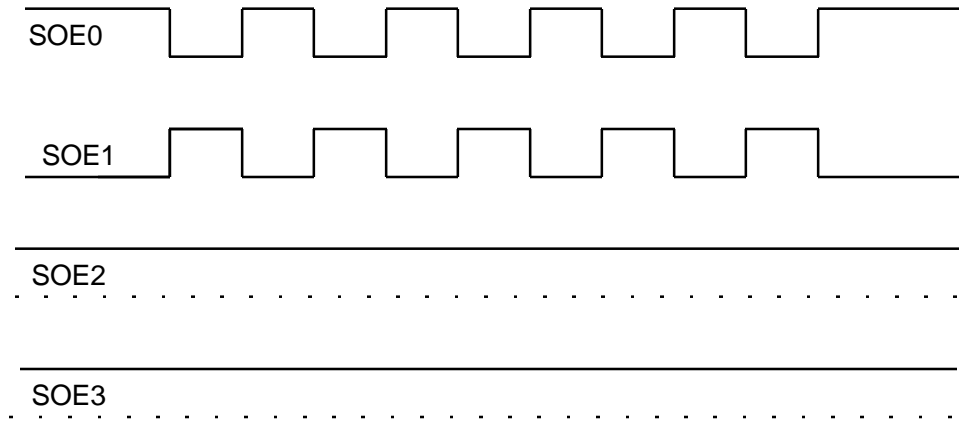
Figure 4.6 2-Way Interleaved With TX Enhanced = 1 , SOE Ctl = 0.
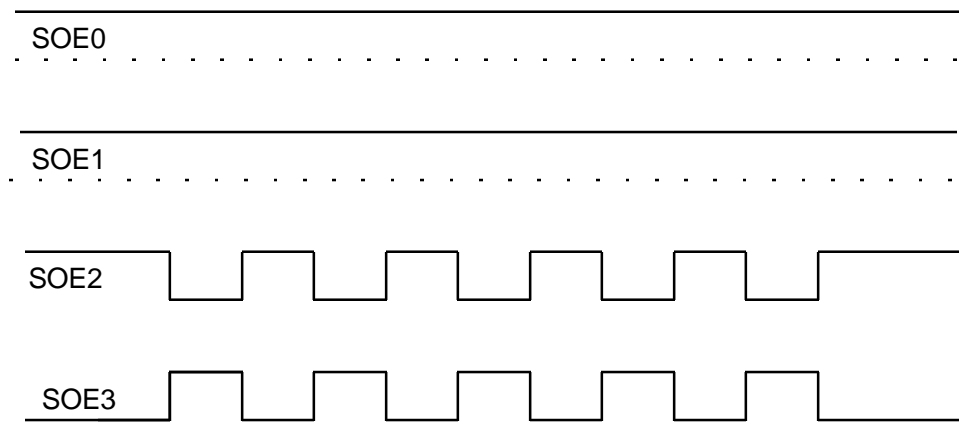
Figure 4.7 2-Way Interleaved With TX Enhanced = 1 , SOE Ctl = 1.

4.4.3   Four-Way Interleaved

This mode is connected to the VRAM serial port exactly the same way as the two-way interleaved mode. The GLINT 500TX drives the SOE of each of the 4 banks low in turn. Note that banks 0 and 2 are connected to SCLK0 and banks 1 and 3 to SCLK1.
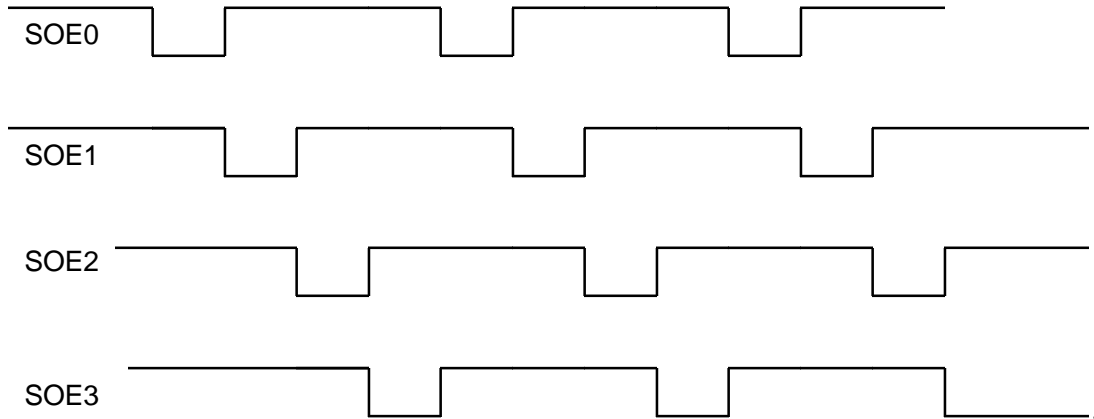
Figure 4.8 4-Way interleaved Serial Port.

If a 64-bit RAMDAC is used, then the interleave of the VRAM serial port must match the interleave of the VRAM random port as defined in the Interleave field of the FBModeSel register.

If a 128-bit RAMDAC is used, then the interleave of the VRAM serial port must be half the interleave of the VRAM random port.

In general, the higher the interleave value of the serial port, the faster the pixel rate that can be displayed and hence the higher the resolution . However, more banks of memory must be fitted.

4.5 VTG Example

The timing specification for the VESA 800 x 600 at 60 Hz mode 6Ah are as follows :-

	Horizontal Time	Characters	Vertical Time	Lines
Dot Clock	40 MHz			
Sync. Polarity	Positive		Positive	
Frequency	37.879 KHz		60.3165 Hz	
Period	26.4 uS	132	16.579 ms	628 lines
Blanking Time	6.4 uS	32	0.739 ms	28 lines
Sync Width	3.2 uS	16	0.106 ms	4 lines
Back Porch	2.2 uS	11	0.607 ms	23 lines
Active Time	20.0 uS	100	15.840 ms	600 lines
Front Porch	1.0 uS	5	0.026 ms	1 line

For a system with 32 bits per pixel and a 2 to 1 interleave on the serial data i.e. VLCK = Dot Clock /2 then the following register values can be used.

Register Name	Value	Explanation
VTGHLimit	528	132 x 8 pixel chars. 2 pixels per VCLK
VTGHSyncStart	20	Front porch *8 /2
VTGHSyncEnd	84	(FrontPorch + SyncWidth)*8/2
VTGHBlankEnd	128	(Blanking time) *8/2
VTGVLimit	628	Vertical Period
VTGVSyncStart	2	Front Porch +1
VTGVSyncEnd	6	Front Porch + SyncWidth +1
VTGVBlankEnd	28	Blanking Time
VTGHGateStart	HBlankEnd -2	Example value (system dependent)
VTGHGateEnd	HLimit -2	Example value (system dependent)
VTGVGateStart	VBlankEnd -1	
VTGVGateEnd	VBlankEnd	

5. External Video Control Registers

GLINT 500TX provides an 8 bit general purpose interface to allow external devices to be addressed from the PCI. This interface has a 16Kbyte address space and is specified as the external video control register region. It allows up to 2048 x 8bit registers to be accessed on 64 bit boundaries. On a typical system, this interface is used to address the LUT-DAC. On more advanced designs, when an external video timing generator or other controllable video circuitry is used, these can also be addressed through this register space. The interface consists of address, data and two control lines. The address and data lines share pins with the Localbuffer data pins.

31	24	16	8	0	OFFSET
			External Register 1		0000.4000h
					0000.4004h
			External Register 2		0000.4008h
			External Reg. 2048		0000.7FF8h
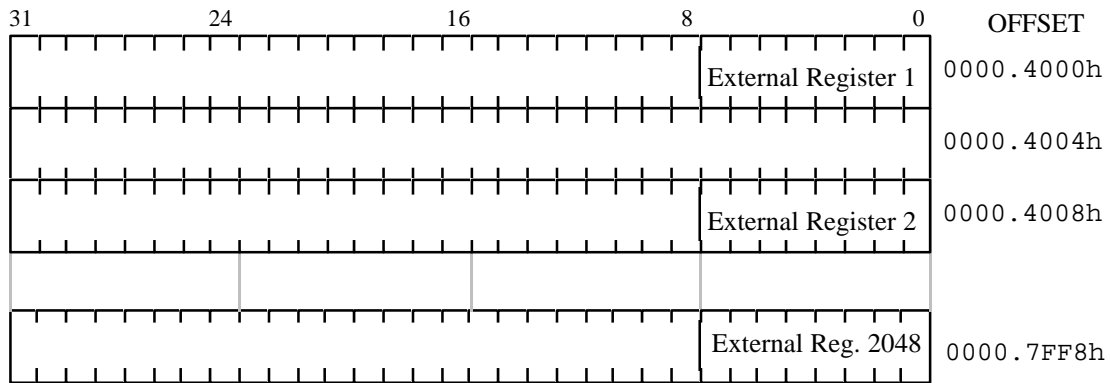
5.1 External Video Interface Signal Definitions

The following signals are defined for the External Video Interface:

Table 5-1. External Video Signals

Signal	Pins used	Description
Ext VidAddress(13-3)	LBMemData(37-27)	External Video register Address lines. Note that the registers are on 64 bit PCI boundaries.
ExtVidData(7-0)	LBMemData(47-40)	External Video Data bus.
DacRdN	DacRdN	External Video register read strobe (negative active)
DacWrN	DacWrN	External Video register write strobe (negative active)

See Chapter 9 for signal waveforms and timing.

5.2   LUT-DAC Interface.

A typical LUT-DAC would be connected to GLINT 500TX through the External Video Interface as shown in figure 5-1.
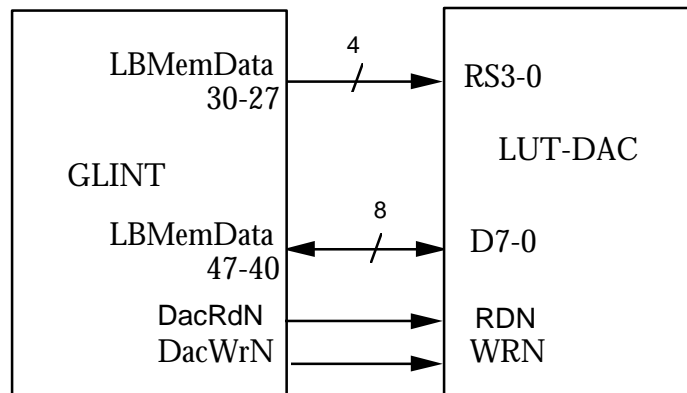
Figure 5-1 Typical LUT-DAC Interface.

When additional External Video circuitry is required, the DacRdN, DacWrN and ExtVidAddress must be externally decoded to generate any required select or control lines.

5.3   Resetting External Circuitry

External circuitry connected to GLINT may need a reset signal. This cannot be obtained directly from the PCI reset line as this can only have one load, the GLINT chip itself. GLINT uses two of its external circuitry control pins, RomEnN and DacWrN, when asserted together to indicate a reset. The pins are asserted when either the PCIRstN line to GLINT is asserted or when GLINT is reset by software.

Reset is indicated for the full length of a PCI reset and for 64 MClk cycles when a soft reset is initiated.

6.   Localbuffer

6.1   Configurations - DRAM Types.

The GLINT 500TX uses the Localbuffer to store depth, stencil, Fast Clear, Graphics ID and texture information. The Localbuffer may be up to 48 bits wide. The following tables indicate typical Localbuffer configurations.

Table 6-1. Localbuffer Sizes With 4Mbit Technology Memories

Memory Device Type	Localbuffer Width	No of Devices	Banks of Memory	Size in MBytes	External Buffering
256K x 16	32	4	2	2	No
	48	6	2	3	No
512K x 8	32	4	1	2	No
	40	5	1	2.5	No
	48	6	1	3	No
512K x 8	32	8	2	4	No
	40	10	2	5	No
	48	12	2	6	No
1M x 4	32	8	1	4	No
	40	10	1	5	No
	48	12	1	6	No
1M x 4	32	16	2	8	Yes
	40	20	2	10	Yes
	48	24	2	12	Yes

Table 6-2. Localbuffer Sizes With 16Mbit Technology Memories

Memory Device Type	Localbuffer Width	No of Devices	Banks of Memory	Size in MBytes	External Buffering
1M x 16	32	4	2	8	No
	48	6	2	12	No
2M x 8	32	4	1	8	No
	40	5	1	10	No
	48	6	1	12	No
2M x 8	32	8	2	16	No
	40	10	2	20	No
	48	12	2	24	No
4M x 4	32	8	1	16	No
	40	10	1	20	No
	48	12	1	24	No
4M x 4	32	16	2	32	Yes
	40	20	2	40	Yes
	48	24	2	48	Yes

Table 6-3. Localbuffer Field Sizes.

Depth, Stencil, Fast Clear and Graphics ID information for each pixel is packed and stored together. The following table shows the possible widths for each field.

Field	Possible Field Widths
Depth (Z)	16,24,32
Stencil	0,4,8
Fast Clear	0,4,8
Graphics ID	0,4

The widths of each field is dynamically programmable and so it can be different in different windows. The only limitation is that the sum of the field widths must be less than or equal to the physical number of Localbuffer bits provided by the hardware.

For more information on field use refer to the GLINT 500TX Programmers Reference Manual.

Textures are always stored in the bottom 32 bits of the each Localbuffer location. If the Localbuffer exceeds 32 bits in width , the bits above 32 are unused for texture storage.

6.2   PCI Region 1 and Region 3 Address Map.

The GLINT 500TX PCI regions 1 and 3 are two apertures into the bypass interface to the Localbuffer memory. The amount of memory visible from the host is configured at reset by the Localbuffer data pins. Also region 3 can be disabled at reset time. If region 3 is enabled the visible size is the same as for region 1.

Refer to Reset Control (Section 12) for more information on the operation at reset.

Table 6-4. Localbuffer Visible Bypass Memory.

Reset Code	Visible Memory	Address Range
0	1 MByte	0000.0000h - 000F.FFFFh
1	2 MBytes	0000.0000h - 001F.FFFFh
2	4 MBytes	0000.0000h - 003F.FFFFh
3	8 MBytes	0000.0000h - 007F.FFFFh
4	16 MBytes	0000.0000h - 00FF.FFFFh
5	32 MBytes	0000.0000h - 01FF.FFFFh
6	64 MBytes	0000.0000h - 03FF.FFFFh
7	Reserved	Bypass Disabled

6.3   Localbuffer Memory Types

The GLINT 500TX supports 1 or 2 banks of either fast page mode or EDO DRAM. The default memory controller setup is to assume fast page mode DRAM. The memory access timings can be adjusted by programming the LBMemoryCtl register. When two banks of

memory are fitted, the default configuration is to interleave the memories on a per location basis. Theses defaults are compatible with GLINT 300SX.

The GLINT 500TX allows the two banks of memory to be accessed separately , so that each can have an open page. This can give improved memory access performance if textures are stored in one bank of memory and Depth/Stencil/Fast Clear/Graphics ID information is stored in the other. This mode of operation is enabled through the Two Page enable field of the LBMemoryEDO register. The size of the first bank of memory must be known and the BankSize field must also be set to map the two banks of memory into a contiguous space.

The benefit of using EDO DRAM is that it allows page mode memory accesses to be performed in 1 clock cycle (as opposed to a minimum of 2 cycles for fast page mode devices). If EDO DRAM is fitted, the GLINT 500TX can be configured to perform single cycle EDO page mode accesses. This is enabled by setting the EDO Enable field of the LBMemoryEDO register. In this case the CAS-Low field of the LBMemoryCtl register is ignored and a single cycle CAS phase is performed during the memory access. If two banks of memory are fitted, the BankSize field must also be set. The banks are never interleaved if EDO accesses are enabled. There is no method to automatically configure the Localbuffer into EDO accesses, the LBMemoryEDO register must be configured through software.

FBMemCtrl register bit 22 is being used to indicate that EDO DRAM is fitted.

The method for turning on the Two Page detectors and EDO through software is :

1) Check for 1 or 2 banks of Local buffer - if 1 bank , leave Memsize field at value 0.

2) Probe the size of Localbuffer memory.

3) Set the Memsize field above to half way through the memory, e.g. a configuration with 8Mbytes of local buffer memory of width 32 bits (= 2 MPixels) should have the field set to 3.

4) Set the TwoPageEnable field.

5) Read FBMemCtrl register bit 22 (EDO DRAM field).

6) If set, then set the EDO mode field of the LBMemoryEDO register.

6.4   Localbuffer Example Configuration

Figure 6.1 is an example Localbuffer configuration. This is an 8 MByte buffer in two banks constructed of 1Mx16 memory devices . Note only 32 bits of Localbuffer width is provided. LBMemCasN(3:0) are used as byte enables. LBMemCasN(5:4) and LBMemData(48:32) are unused.

Figure 6-1 8MByte Localbuffer (32 bit wide)
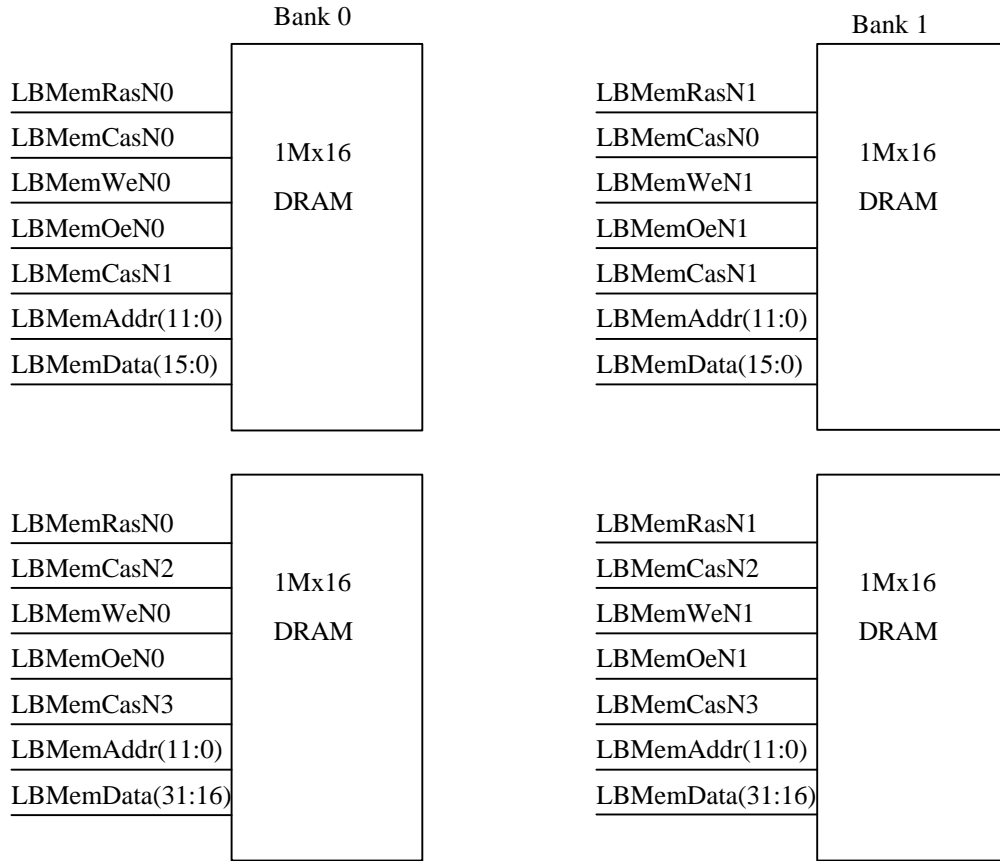
6.5   Shared Localbuffer

The Shared Framebuffer protocol on the GLINT 300SX has been extended on the GLINT 500TX to allow the Localbuffer to be shared with another device. When this is enabled , the GLINT 500TX either drives or tri-states all Localbuffer Address, Data and control lines depending on whether or not it is controlling the memory. See Section 7.3 for more information.

7.   Framebuffer

7.1   Configurations - VRAM Types and Features

Table 7-1. Framebuffer Configurations

Framebuffer Size (MBytes)	VRAM Data Bus Width	Data Width to LUT-DAC	Max supported Resolutions	Number of Random Port Banks	Serial Port Interleaved Banks	Timing Generator
2MByte	64	32/64	800x600x24 1024x768x16 1600x1200x8 800x600x16 DB 1024x768x8 DB	1	2/1	Internal
4MByte	64	64/128	1024x768x24 1600x1200x16 800x600x24 DB 1024x768x16 DB 1600x1200x8 DB 2048x2048x8	2	2/1	Internal
8MByte	64	64/128	1600x1200x24 1024x768x24 DB 1600x1200x16 DB 1600x1200x8 DB 2048x2048x8 DB 2048x2048x16	4	4/2	Internal / External
16MByte	64	128	1600x1200x24 DB 1600x1200x16 DB 1600x1200x8 DB 2048x2048x8 DB 2048x2048x16 DB	8	2x2	Internal / External

Notes:
1. For resolutions shown with 24 bit pixels, the pixels are on 32 bit boundaries.
2. DB indicates support for double buffering at this resolution.

The pixel ordering in the packed modes is shown below.

Table 7-2. Framebuffer Pixel Packing

Packing	Framebuffer Data Word			
	0 - 7	8 - 15	16 - 23	24 - 31
32 bit	Pixel 1			
16 bit	Pixel 1		Pixel 2	
8 bit	Pixel 1	Pixel 2	Pixel 3	Pixel 4

7.2   PCI Region 2 and Region 4 Address Map

The GLINT 500TX PCI regions 2 and 4 are the two apertures into the bypass interface to the Framebuffer memory. The amount of memory visible from the host is configured at reset by the Framebuffer data pins. Also region 4 can be disabled at reset time. If region 4 is enabled the visible size is the same as for region 2.

Refer to Reset Control (Section 12) for more information on the operation at reset.

A 32 bit Hardware Write Mask register is provided to condition all bypass write accesses to the Framebuffer. See Section 3.3.6 for more details.

Table 7-3. Framebuffer Visible Bypass Memory

Reset Code	Visible Memory	Address Range
0	1 MByte	0000.0000h - 000F.FFFFh
1	2 MBytes	0000.0000h - 001F.FFFFh
2	4 MBytes	0000.0000h - 003F.FFFFh
3	8 MBytes	0000.0000h - 007F.FFFFh
4	16 MBytes	0000.0000h - 00FF.FFFFh
5	32 MBytes	0000.0000h - 01FF.FFFFh
6	Reserved	
7	0 MBytes	Bypass Disabled

Some LUT-DACs have a display format whereby a 16 bit display is scanned out of either the low 16 bits of every 32 bit Framebuffer word , or the high 16 bits of every Framebuffer word. These are referred to as Buffer A and Buffer B respectively. The Graphics Core supports this type of unpacked Framebuffer. However 32 bit bypass accesses in this mode would normally access 1 pixel from each buffer. A 16 bit packed access mode has been provided which allows a 32 bit bypass access to access 2 consecutive pixels in either Buffer A of Buffer B . This mode is controlled by programming the Aperture Control registers. See sections 3.1.11 and 3.1.12.

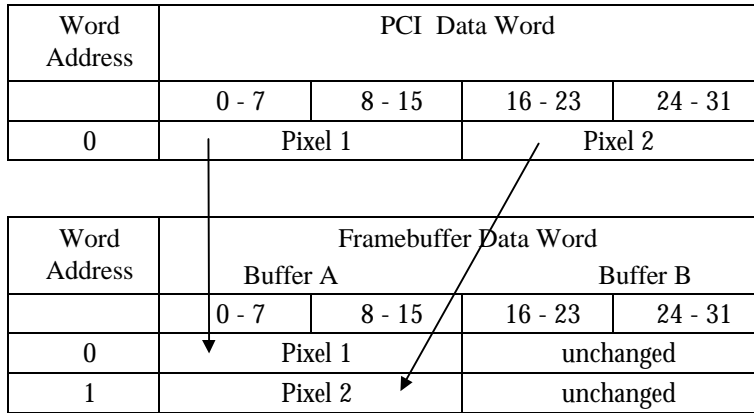Examples of different Packed write modes are given below:

Word Address	PCI Data Word			
	0 - 7	8 - 15	16 - 23	24 - 31
0	Pixel 1		Pixel 2	

Word Address	Framebuffer Data Word			
	Buffer A		Buffer B	
	0 - 7	8 - 15	16 - 23	24 - 31
0	Pixel 1		unchanged	
1	Pixel 2		unchanged	

Figure 7-1 Packed Write to Buffer A

Word Address	PCI Data Word			
	0 - 7	8 - 15	16 - 23	24 - 31
0	Pixel 1		Pixel 2	

Word Address	Framebuffer Data Word			
	Buffer A		Buffer B	
	0 - 7	8 - 15	16 - 23	24 - 31
0	unchanged		Pixel 1	
1	unchanged		Pixel 2	

Figure 7-2 Packed Write to Buffer B

Word Address	PCI Data Word			
	0 - 7	8 - 15	16 - 23	24 - 31
0	Pixel 1		Pixel 2	

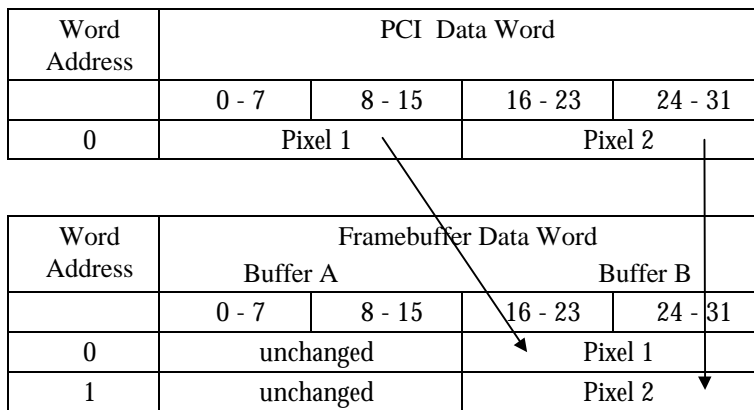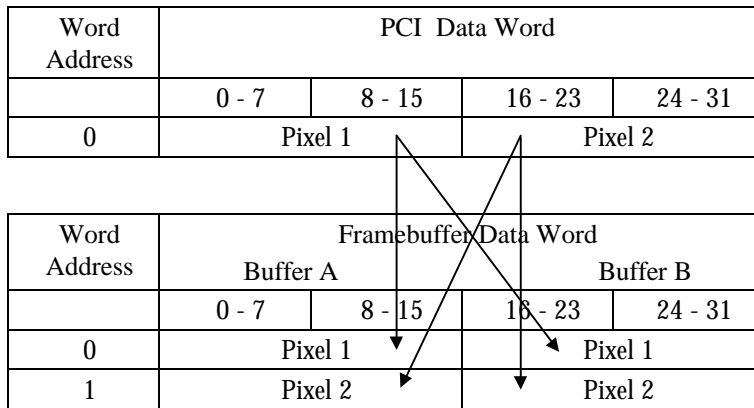| Word Address	Framebuffer Data Word			
	Buffer A		Buffer B	
	0 - 7	8 - 15	16 - 23	24 - 31
0	Pixel 1		Pixel 1	
1	Pixel 2		Pixel 2	

Figure 7-3 Packed Write to Buffer A and Buffer B

7.3   Shared Framebuffer/Shared Memory Interface.

The GLINT 500TX expands the functionality of the Shared Framebuffer interface on GLINT 300SX to allow either the Framebuffer or the Localbuffer or both buffers to be shared with another device. The selection of which buffer (if any) is shared is determined at reset time by configuration resistors on the FBMemData bus The GLINT 300SX uses the SFBMode field of the FBModeSel register to determine the configuration. The GLINT 500TX uses the SFBMode field and, in addition, the TX Enhanced Shared Memory field and the SFBModeSwap field of the FBTXMemCtl register to determine the configuration as specified in table   7-4.

The SFBModeSwap field and the TX Enhanced Shared Memory fields are only activated if the TXEnhanced pin is pulled high. This is to allow backwards compatibility with the GLINT 300SX.

The TX Enhanced Shared Memory field allows the localbuffer to be shared with another device or both Localbuffer and Framebuffer to be shared with another device.

If two GLINT 500TX devices are to be used in a shared Framebuffer configuration, both will load the configuration resistors FBReset 11 and 12 into the FBModesel register. The SFBModeSwap field is used to force one device to be Primary controller and the other to be secondary controller as follows:-

The SFBMode is set to 2 using the Configuration resistors.

The GLINT500TX to be primary controller has the TXEnhanced pin pulled high. This enables the SFBModeSwap field to be set through FBReset bit 21.

The device to be secondary controller has the TXEnhanced pin grounded. This device will not load the SFBModeSwap field.

Table 7-4. Shared Memory Configuration

SFBSwap	TXEnhanced Shared Memory	SFB Mode Bits	Framebuffer Configuration	Localbuffer Configuration
X	0	0	Not Shared	Not Shared
0	0	1	Primary Controller	Not Shared
0	0	2	Secondary Controller	Not Shared
X	0	3	Secondary Controller	Secondary Controller
X	1	0	Not Shared	Not Shared
0	1	1	Not Shared	Primary Controller
0	1	2	Not Shared	Secondary Controller
X	1	3	Primary Controller	Primary Controller
1	0	1	Secondary Controller	Not Shared
1	0	2	Primary Controller	Not Shared
1	1	1	Not Shared	Secondary Controller
1	1	2	Not Shared	Primary Controller

The SFB interface consists of three signals, FBReq, FBGnt, and FBSelOEN. FBReq and FBGnt are used to arbitrate for the memory bus. FBSelOEN is used by the SFB slave to

indicate when it is controlling the bus. This can be used to enable buffers on the memory control lines if they are used.

Note - When GLINT 500TX is in enhanced mode, the FBSelOEN pin is re-used to generate SOE2.

A primary controller is responsible for Memory refresh, VRAM transfer cycles(when it is the Framebuffer being shared) and arbitration of memory access requests from the secondary controller.

A secondary controller requests the memory bus whenever it requires a memory access. It will be granted the bus after an arbitrary amount of time. It keeps the bus until its grant is removed when it must vacate the bus within a defined period of time.

The shared Framebuffer control pins change function dependent on whether GLINT is a primary or secondary controller.

Table 7-5. Primary Controller Signals

Name	Width	Source	Description
FBReqN	1	I	Request from External secondary controller
FBGntN	1	O	Bus Grant to External secondary controller

Table 7-6. Secondary Controller Signals

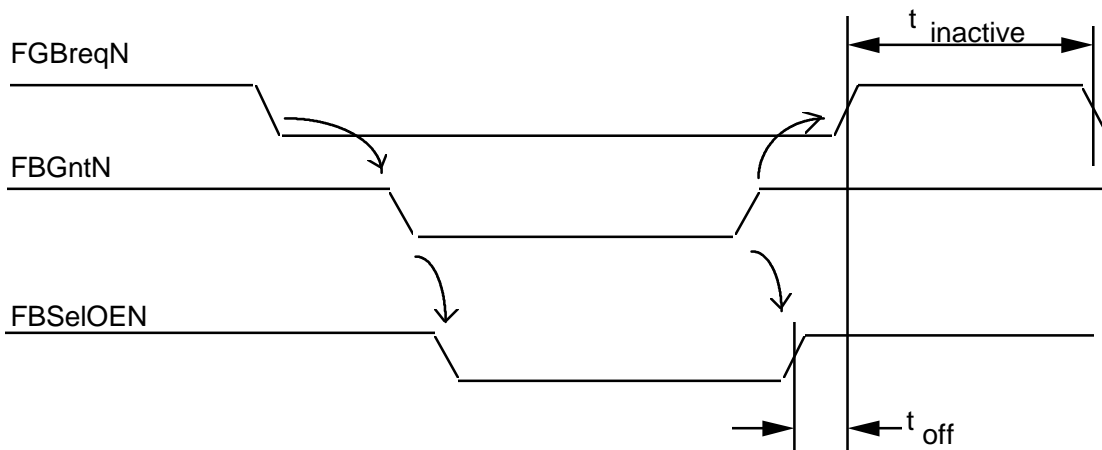| Name	Width	Source	Description
FBReq	1	O	Request to External Primary Controller
FBGnt	1	I	Bus Grant from External Primary Controller
FBSelOEN	1	O	Bus control output enable signal. (When TXEnhanced = 0)

Figure 7-4. Shared Framebuffer Control Signals

7.3.1   GLINT 500TX as Primary Controller

FBReqN is internally resynchronised to MClk.

FBGntN is asserted an unspecified amount of time after FBReqN is asserted. The Framebuffer Address, Data and Control lines are tri-stated by the GLINT 500TX. The

Control lines are held high by external pull-up resistors. The secondary controller is now free to drive the Framebuffer lines and access the memory.

FBGntN remains asserted until the GLINT 500TX requires a Framebuffer access, or a refresh or transfer cycle.

When FBGntN is removed, the secondary controller must relinquish the address, data and control bus in a graceful manner - i.e. RasN, CasN, WEN and OEN must all be driven high before being tri-stated. DSF must be driven low before tri-state.

The secondary controller must relinquish the bus and negate FBReqN within 500ns of FBGntN being negated.

Once FBReqN has been negated, it must remain inactive for at least 2 system clocks. i.e. 40ns at 50 MHz.

FBReqN can be negated while FBGntN is still asserted. In this case, FBReqN cannot be re-asserted until at least 2 MClks after FBGntN has been negated.

In order to allow some control of the arbitration between primary and secondary controller, two programmable timeout fields are provided. in the Framebuffer TX Shared Memory Control register. The Primary Timeout field determines the number of clocks the primary controller will keep the bus and ignore requests from the secondary controller.

The Secondary timeout controller determines the number of clocks the secondary controller will be granted to bus before it will be forced to back off. This timeout count is ignored if the Primary Controller needs to perform either a refresh cycle, VRAM Transfer Cycle or a Bypass memory access. In these cases, the Secondary Controller is degranted the bus immediately.

The optimal setting for the fields will be system performance dependent. Similar numbers for each field will give approx. equal access to the bus to both controller, with the Primary controller having slightly more bandwidth because of priority access for refresh and transfers.

7.3.2   GLINT 500TX as Secondary Controller

Framebuffer Refresh and VRAM transfer cycles by the GLINT 500TX are turned off when it is a secondary Framebuffer controller.

The GLINT 500TX asserts FBReqN whenever is requires a Framebuffer access.

FBGntN is internally resynchronised to MClk.

When FBGntN is asserted and the TXEnhanced pin is pulled low, the GLINT 500TX drives FBselOEN to enable any external buffers used to drive the control signals, and then drives the Framebuffer address, data and control lines to perform the memory access.

When FBGntN is negated, The GLINT 500TX finishes any outstanding memory cycles, drives the control lines inactive, negates FBselOEN and then tri-states the Address, Data and Control lines, and then releases FBReqN. FBReqN is guaranteed to be released within 500ns of FBGntN being negated.

The GLINT 500TX will not reassert FBReqN within 4 system clock cycles. i.e. 80ns @ 50mhz.

GLINT 500TX will also tri-state the Address, Data and Control lines and remove FBReqN while FBGntN is still asserted if no memory accesses are required. In the Case, it waits for FBGntN to be removed before FBReqN is reasserted.

7.3.3 Shared Framebuffer Control at Reset

While the GLINT 500TX is in reset, both FBReqN and FBGntN are tri-stated.

7.3.4 Shared Framebuffer and VRAM DSF

The S3 shared Framebuffer interface protocol does not include the VRAM DSF signal. The GLINT 500TX has different performance to the GLINT 300SX in that DSF is a shared signal. The DSF lines are driven low and then tri-stated when control of the bus is relinquished by the GLINT 500TX as either a primary or a secondary controller.

7.4 Framebuffer Timing

There are 3 parameters which can be varied to affect the Framebuffer interface timings. These are the RAS-PRECHARGE, RAS-CAS-low and CAS-low fields of the Framebuffer memory control register.

RAS-PRECHARGE allows the RAS precharge time to be varied between 2 and 5 MClks.

RAS-CAS-low allows the time from RAS assertion to CAS assertion to be varied from 2 to 5 MClks.

CAS-low allows the CAS low time to be varied from 1 to 4 MClks.

Table 9-13 in the Electrical Data section shows how the memory timings are affected by varying these parameters.

7.5 VRAM Requirements

The GLINT 500TX requires VRAM that support CAS-before-RAS refresh. It can make use of VRAM block fill modes. Both 4 column and 8 column block fill devices are supported.

If the internal timing generator is being used to generate the display, the VRAM must support both full read transfers and split read transfers. The shift register size can be either 256 or 512 elements long - so a split transfer loads either 128 or 256 elements respectively. Split transfers with a stop address are not supported, but devices that support this feature can be used.

7.6 External Timing Generator

If an external timing generator is used with the GLINT 500TX, then the control of the VRAM must be shared between the GLINT 500TX and the timing generator. In general, the GLINT 500TX controls the VRAM random port and the Timing Generator controls the VRAM serial port. However, the VRAM serial shift register must be loaded using the VRAM random port. Co-ordination between the timing generator and the GLINT 500TX

is used to achieve this operation. The timing generator requests a VRAM transfer cycle from GLINT and provides the transfer address with the GLINT 500TX performing the actual VRAM access. An example circuit is shown below.
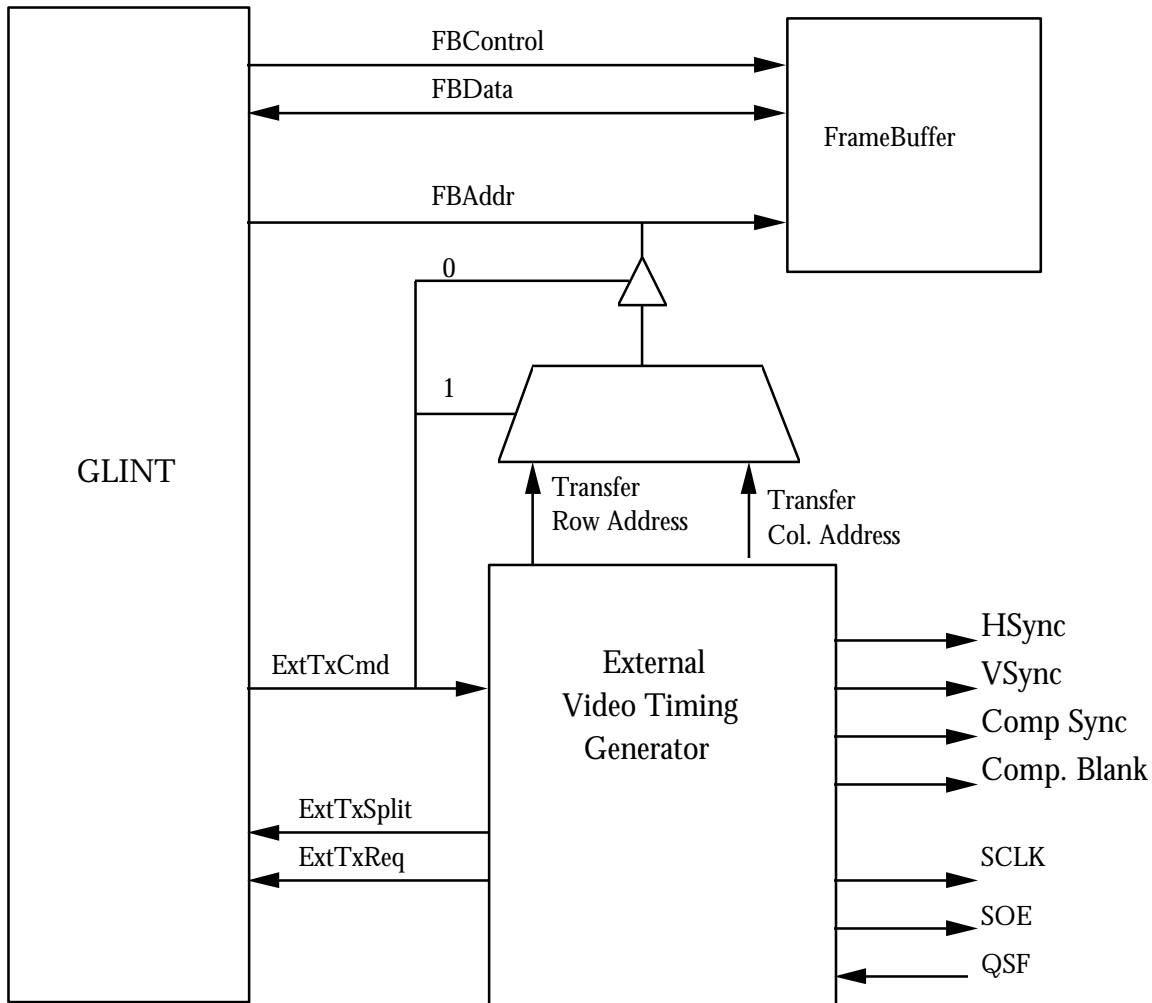

Figure 7-5 External Timing Generator Interface

An external controller requests a VRAM transfer cycle by asserting ExtTxReq and setting ExtTxSplit to indicate whether a split transfer or full transfer is required. This is internally resynchronised to MClk. When any outstanding memory access is complete GLINT tri-states the FBAddr bus. ExtTXCmd is set to 1 and the external controller should drive the transfer row address onto the bus. When ExtTxCmd is set to 3 , the external controller should drive the transfer column address onto the bus. ExTxReq must be asserted until ExtTxCmd is set to 2 indicating the transfer is complete. When ExTxReq is negated by the external controller then ExTxCmd returns to 0. It is intended that ExtTXCmd bit 0 is a direct output enable control onto FBAddr bus with ExtTXCmd bit 1 as a row/column select line.

The row address should be asserted within 20ns of ExTxCmd = 1.

The column address should be asserted within 20ns of ExTxCmd = 3.

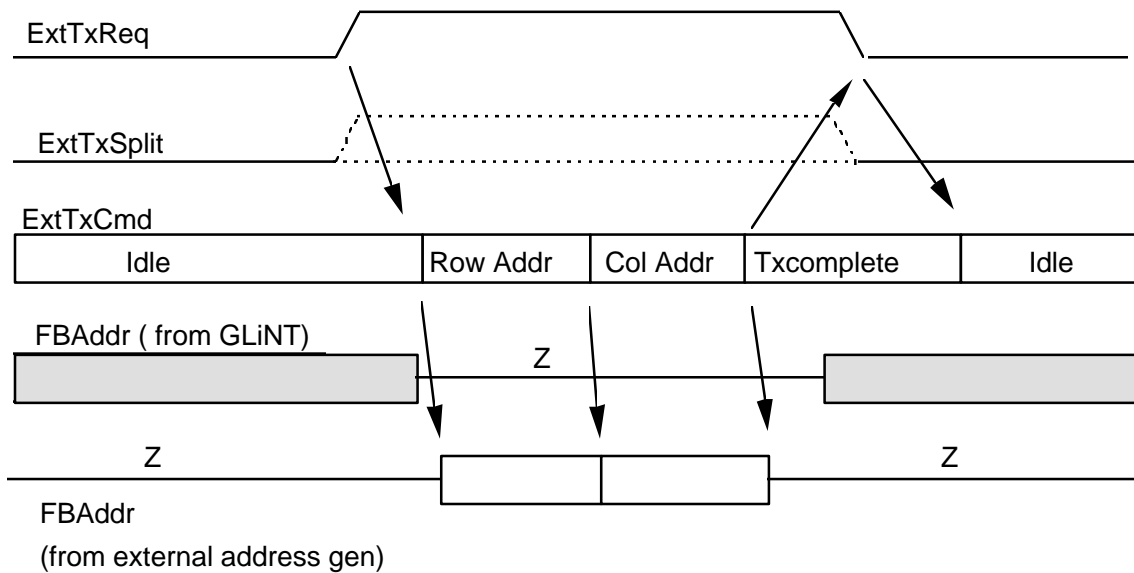The external controller should tri-state the FBAddr bus within 20ns of ExTxCmd = 2 and when ExtTxCmd = 0.

Figure 7-6 Transfer Request Protocol

The Ext. Timing field of the FB_MODE_SELECT register determines whether the internal or an external timing generator is used.

Ext. Timing

0 = Internal Timing Generator
1 = External Timing Generator

The following GLINT 500TX pins have dual function depending on whether an internal or external timing generator is used.

Table 7-7. Timing Generator Pins

Pin Name	Internal VTG function	Direction	External VTG function	Direction
QSF/TXReq	QSF	I	ExtTxReq	I
CBlank/Split	CompBlank	O	ExtTxSplit	I
HSync/Cmd1	HSync	O	ExtTxCmd1	O
VSync/Cmd0	VSync	O	ExtTxCmd0	O

7.7 Framebuffer Configurations

The Framebuffer consists of a number of 64 bit banks of memory. These can be configured in a number of ways. In particular they may be one, two or four way interleaved. The interleave chosen depends on the total amount of memory to be fitted, the pixel port width of the LUT-DAC used and the maximum resolution that needs to be supported. Table 7-7 below shows how the Framebuffer control lines are decoded with different interleaving schemes in Dual-Cas mode.

The Cas lines are used as byte enables for memory accesses.

The Write Enable and Output Enable control lines FBMemWeN(3:0) and FBMemOeN(3:0) are decoded from the address bits marked E1 and E0 below. These signals perform the bank interleaving.

The FBMemRasN(3:0) lines are decoded from the address bits marked R1 and R0 below.

One Way interleave mode only uses FBMemWeN(0) and FBMemOEn(0). Address bit 21 (marked RX below) decodes either FBMemRasN(0) or FBMemRasN(2) .

In addition to the three standard interleaves, two 'S3 Compatible' modes are provided. These are set up by setting the S3 Compatible field of the Framebuffer TX shared memory control register (together with the appropriate Framebuffer Interleave).

One way interleaved S3 compatible mode uses Address bit 21 to select between WE/OE 1 and WE/OE 0. Address bits 23 and 22 are decoded to select between FBMemRasN(3), (2), (1) and (0).

Two way interleaved S3 Compatible mode uses Address bits 23 and 3 to decode WE/OE 3 ,2,1 and 0 . Address bits 24 and 22 are used to decode FBMemRasN(3), (2), (1) and (0).

Note that although the maximum address range for the Framebuffer is 32 Mbytes, the Graphics core can only generate pixel addresses up to 16 Mpixels. In 32bpp and 16 bpp modes this is sufficient to address the whole Framebuffer range. In 8bpp mode, only the lower 16Mbytes of Framebuffer can be addressed from the graphics core.

Table 7-8. Framebuffer Addressing in Dual-CAS Mode.

	Address Bits																					
	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1 way interleaved	X	X	X	R X	\multicolumn{9}{c	}{Row Address}	\multicolumn{8}{c	}{Column Address}	\multicolumn{3}{c	}{Cas 7:0}
2 way interleaved	R1	R0	E1	\multicolumn{9}{c	}{Row Address}	\multicolumn{7}{c	}{Column Address}	E0	\multicolumn{3}{c	}{Cas 7:0}
4 way interleaved	R1	R0	\multicolumn{10}{c	}{Row Address}	\multicolumn{7}{c	}{Column Address}	E1	E0	\multicolumn{3}{c	}{Cas 7:0}
1way interleaved S3	X	R1	R0	E0	\multicolumn{8}{c	}{Row Address}	\multicolumn{8}{c	}{Column Address}	\multicolumn{3}{c	}{Cas 7:0}
2 way interleaved S3	R1	E1	R0	\multicolumn{9}{c	}{Row Address}	\multicolumn{8}{c	}{Column Address}	E0	\multicolumn{3}{c	}{Cas 7:0}

8. GLINT 500TX Register Set

Table 8-1. GLINT 500TX Configuration Region Registers

Register	Type	Offset	Section	Description
Register	Type	Offset	Section	Description

Device Identification

Register	Type	Offset	Section	Description
CFGVendorId	R	00h	2.1.1	Vendor identification number
CFGDeviceID	R	02h	2.1.2	Device identification number
CFGRevisionID	R	08h	2.1.3	Revision identification number
CFGClassCode	R	09h	2.1.4	Class code register
CFGHeaderType	R	0Eh	2.1.5	Header type

Device Control/Status

Register	Type	Offset	Section	Description
CFGCommand	R/W	04h	2.2.1	PCI command register
CFGStatus		06h	2.3.1	PCI status register

Miscellaneous Functions

Register	Type	Offset	Section	Description
CFGBist	R	0Fh	2.4.1	BIST
CFGLatTimer	R/W	0Dh	2.4.2	Latency timer value
CFGCacheLine	R	0Ch	2.4.3	Cache line size
CFGMaxLat	R	3Fh	2.4.4	Maximum latency period
CFGMinGrant	R	3Eh	2.4.5	Minimum grant period
CFGIntPin	R	3Dh	2.4.6	Interrupt pin being used
CFGIntLine	R/W	3Ch	2.4.7	Interrupt line routing information

Base Addresses

Register	Type	Offset	Section	Description
CFGBaseAddr0	R/W	10h	2.5.1	Control space offset
CFGBaseAddr1	R/W	14h	2.5.2	Aperture 0 Localbuffer offset
CFGBaseAddr2	R/W	18h	2.5.3	Aperture 0 Framebuffer offset
CFGBaseAddr3	R/W	1Ch	2.5.4	Aperture 1 Localbuffer offset
CFGBaseAddr4	R/W	20h	2.5.5	Aperture 1 Framebuffer offset
CFGRomAddr	R/W	30h	2.5.6	Expansion ROM offset

Table 8-2. GLINT 500TX Region 0 Registers

Register	Type	Offset	Section	Description

Control Status Registers

Register	Type	Offset	Section	Description
ResetStatus	R/W	0000h	3.1.1	Reset status and software reset
IntEnable	R/W	0008h	3.1.2	Interrupt enable
IntFlags	R/W	0010h	3.1.3	Interrupt flags
InFIFOSpace	R	0018h	3.1.4	Input FIFO space
OutFIFOWords	R	0020h	3.1.5	Number of words in the output FIFO
DMAAddress	R/W	0028h	3.1.6	DMA start address
DMACount	R/W	0030h	3.1.7	DMA word count
ErrorFlags	R/W	0038h	3.1.8	Error flags
VClkCtl	R/W	0040h	3.1.9	Video clock control
TestRegister	R/W	0048h	3.1.10	Test register (Diagnostic)
Aperture0	R/W	0050h	3.1.11	Aperture 0 control
Aperture1	R/W	0058h	3.1.12	Aperture 1 control
DMAControl	R/W	0060h	3.1.13	DMA control
FIFODis	R/W	0068h	3.1.14	FIFO Disconnect

Localbuffer Registers

Register	Type	Offset	Section	Description
LBMemoryCtl	R/W	1000h	3.2.1	Localbuffer memory control register
LBMemoryEDO	R/W	1008h	3.2.2	Localbuffer EDO memory control

Framebuffer Registers

Register	Type	Offset	Section	Description
FBMemoryCtl	R/W	1800h	3.3.1	Framebuffer memory control register
FBModeSel	R/W	1808h	3.3.2	Framebuffer mode select
FBGCWrMask	R	1810h	3.3.3	Framebuffer GC write mask (Diagnostic)
FBGCColorLower	R	1818h	3.3.4	Framebuffer GC color lower (Diagnostic)
FBTXMemCtl	R/W	1820h	3.3.5	Framebuffer TX Shared Memory Control
FBWrMask	R/W	1830h	3.3.6	Framebuffer Bypass Write mask
FBGCColorUpper	R/W	1838h	3.3.7	Framebuffer GC color upper (Diagnostic)

Register	Type	Offset	Section	Description

Internal Video Registers

Register	Type	Offset	Section	Description
VTGHLimit	R/W	3000h	4.2.1	Horizontal VClk count limit
VTGHSyncStart	R/W	3008h	4.2.2	Horizontal sync pulse start
VTGHSyncEnd	R/W	3010h	4.2.3	Horizontal sync pulse end
VTGHBlankEnd	R/W	3018h	4.2.4	Horizontal blanking period end
VTGVLimit	R/W	3020h	4.2.5	Vertical line count limit
VTGVSyncStart	R/W	3028h	4.2.6	Vertical sync pulse start
VTGVSyncEnd	R/W	3030h	4.2.7	Vertical sync pulse end
VTGVBlankEnd	R/W	3038h	4.2.8	Vertical blanking period end
VTGHGateStart	R/W	3040h	4.2.9	Horizontal gate pulse start
VTGHGateEnd	R/W	3048h	4.2.10	Horizontal gate pulse end
VTGVGateStart	R/W	3050h	4.2.11	Vertical gate pulse start
VTGVGateEnd	R/W	3058h	4.2.12	Vertical gate pulse end
VTGPolarity	R/W	3060h	4.2.13	Output signal polarity control
VTGFrameRowAddr	R/W	3068h	4.2.14	Frame row address
VTGVLineNumber	R	3070h	4.2.15	Vertical line number
VTGSerialClk	R/W	3078h	4.2.16	Serial clock control
VTGModeCtl	R/W	3080h	4.2.17	Mode Control

9. Electrical Data

9.1 Absolute Minimum/Maximum Ratings

Table 9-1 Absolute Minimum/Maximum Ratings

Junction Temperature	100°C
Storage Temperature	-65°C to 150°C
Minimum Operating Temperature	0°C
DC Supply Voltage	3.8V
I/O Pin Voltage with respect to GND	-0.5V to 5.5V

9.2 DC Specifications

Table 9-2 DC Specifications

Symbol	Parameter	Min	Max	Unit
V_{DD}	Supply Voltage	3.0	3.6	V
L_{PIN}	Pin Inductance		18.4	nH
I_{CC}	Power Supply Current		740	mA

Table 9-3 PCI Signal DC Specifications

Symbol	Parameter	Min	Max	Unit
V_{PIL}	Input Low Voltage		0.8	V
V_{PIH}	Input High Voltage	2.0		V
V_{POL}	Output Low Voltage		0.5	V
V_{POH}	Output High Voltage	2.4		V
I_{PIL}	Input Low Current		-25	uA
I_{PIH}	Input High Current		25	uA
C_{PIN}	Input Capacitance		10	pF
C_{CLK}	PCI Clock Input Capacitance		10	pF
C_{IDSEL}	PCI Idsel Input Capacitance		10	pF

Table 9-4 Non PCI Signal DC Specifications

Symbol	Parameter	Min	Max	Unit
V_{IL}	Input Low Voltage		0.8	V
V_{IH}	Input High Voltage	2.0		V
V_{OL}	Output Low Voltage		0.5	V
V_{OH}	Output High Voltage	2.4		V
I_{OL12}	Output Low Current	12		mA
I_{OH12}	Output High Current	-8		mA
I_{OL8}	Output Low Current	8		mA
I_{OH8}	Output High Current	-6		mA
I_{IL}	Input Low Current		1	uA
I_{IH}	Input High Current		1	uA
I_{IHPD}	Pulldown Input High Current		250	uA
I_{ILPU}	Pullup Input Low Current		250	uA
C_{IN}	Input Capacitance		10	pF

9.3 AC Specifications

Table 9-5 Test Loads For AC Timing

Pin Name	Capacitive Load
PCIAD[31:0], PCICBEN[3:0], PCIPar, PCIFrameN, PCIIRdyN, PCITRdyN, PCIStopN, PCIIdsel, PCIDevselN, PCIReqN, PCIGntN, PCIIntAN, LBMemAddr[11:0], LBRasN[1:0], LBCasN[5:0], LBMemOeN[1:0], LBMemWeN, LBMemData[47:0], FBMemAddr[8:0], FBMemRas[3:0], FBMemCas[7:0], FBMemOeN[3:0], FBMemWeN[3:0], FBMemDSF[1:0], FBMemData[63:0], LDClk, SClk[1:0], SOE[3:0].	50pF
CompSync, DacWrN, DacRdN, HSync/ExtTxCmd[0], VSync/ExtTxCmd[1], CBlank/ExtTxSplit, FBGnt, FBReq, FBSelOE, VClkCtl[1:0], RomEnN.	20pF

9.3.1 Clock Timing
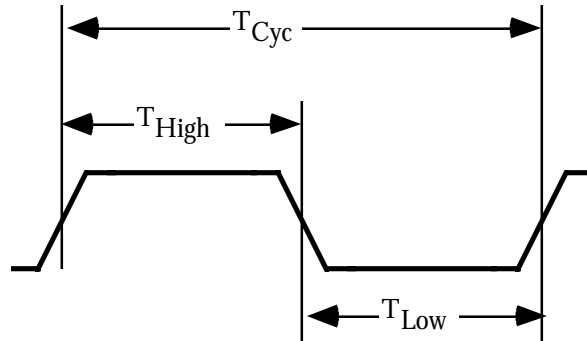
Figure 9-1 Clock Waveform Timing

Table 9-6 Clock Waveform Timing

Symbol	Parameter	Min	Max	Units	Notes
T_{PCyc}	PCIClk Cycle Time	30		nS	
T_{PHigh}	PCIClk High Time	8		nS	
T_{VLow}	PCIClk Low Time	8		nS	
T_{MCyc}	MClk Cycle Time	25	40	nS	
T_{MHigh}	MClk High Time	8		nS	
T_{MLow}	MClk Low Time	8		nS	
T_{VCyc}	VClk Cycle Time	20		nS	
T_{VHigh}	VClk High Time	6		nS	
T_{VLow}	VClk Low Time	6		nS	

9.3.1 Input / Output Timing
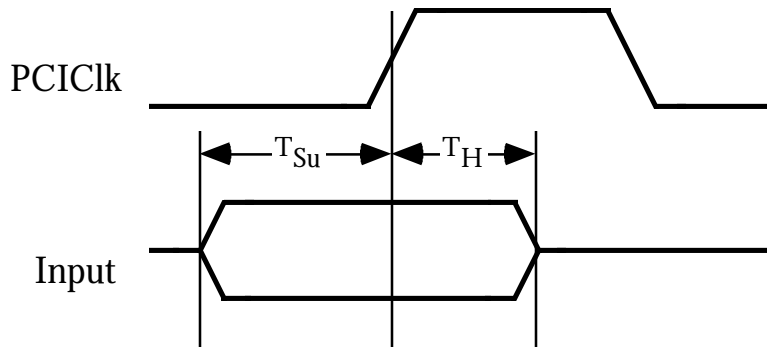
Figure 9-2 PCIClk Referenced Input Timing

Table 9-7 PCIClk Referenced Input Timing

Parameter	T_{Su} Min	T_H Min	Units	Notes
PCIAD(31:0), PCICBEN(3:0), PCIPar, PCIFrameN, PCIIRdyN, PCITRdyN, PCIStopN, PCIIdsel, PCIDevselN	7	0	nS	
PCIGntN	10	0	nS	
PCIRstN	7	0	nS	1

Notes:

> 1   PCIRstN is resynchronised internally. The timings given, when met, ensure that the reset is detected in the current cycle.

Figure 9-3 PCIClk Referenced Output Timing

Table 9-8 PCIClk Referenced Output Timing

	T_{Val}		T_{On}		T_{Off}			
Parameter	Min	Max	Min	Max	Min	Max	Units	Notes
PCIAD(31:0), PCICBEN(3:0), PCIPar, PCIFrameN, PCIIRdyN, PCITRdyN, PCIStopN, PCIIdsel, PCIDevselN	2	11	2	11	2	11	nS	
PCIReqN	2	12					nS	
PCIIntAN	2	11					nS	1

Notes:

1. Timings given are for falling edges of the open drain signal. Rise times are dependent on the external pull-up resistor.
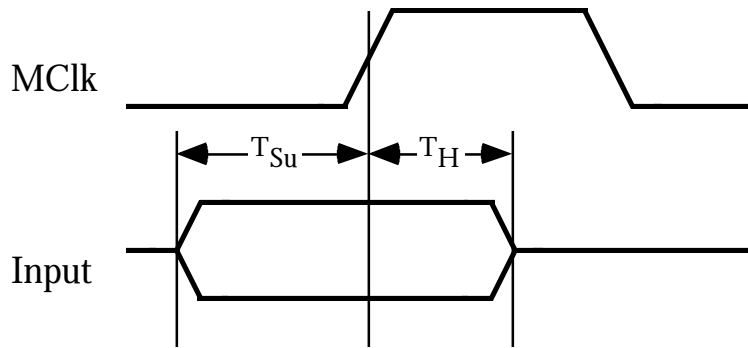
Figure 9-4 MClk Referenced Input Timing

Table 9-9 MClk Referenced Input Timing

Parameter	T_{Su} Min	T_H Min	Units	Notes
FBReqN	-	-	nS	1
FBGntN	-	-	nS	2
QSF/ExtTxReq	-	-	nS	3
CBlank/ExtTxSplit	-	-	nS	3
ExtIntN	5	2	nS	4

Notes:

1. This signal is an input when GLINT 500TX is a Shared Framebuffer Primary Controller. It is resynchronised internally.
2. This signal is an input when GLINT 500TX is a Shared Framebuffer Secondary Controller. It is resynchronised internally.
3. These signals are inputs when GLINT 500TX has an external video timing controller. These are resynchronised internally.
4. ExtIntN is resynchronised internally. The timings given ensure that the interrupt is detected in the current cycle.
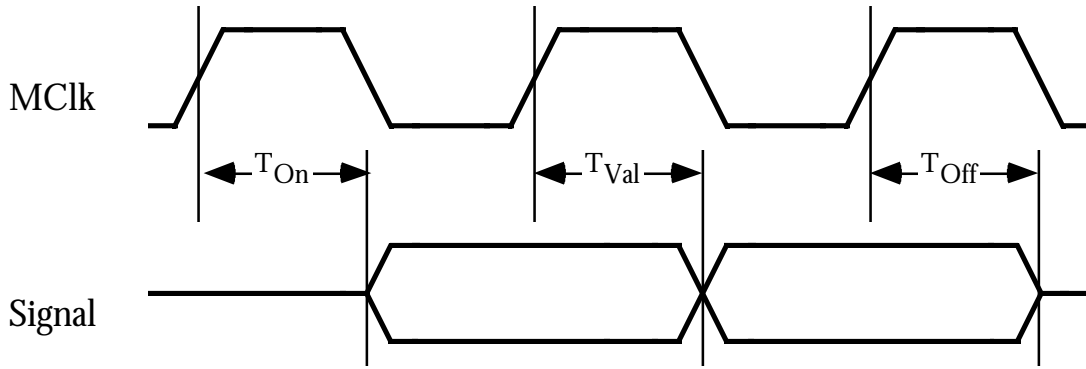
Figure 9-5 MClk Referenced Output Timing

Table 9-10 MClk Referenced Output Timing

	TVal		TOn		TOff			
Parameter	Min	Max	Min	Max	Min	Max	Units	Notes
LBMemAddr(11:0)	7	23	-	-	-	-	nS	
LBMemRasN(1:0)	5	17					nS	
LBMemCasN(5:0)	5	17					nS	
LBMemOeN(1:0)	5	17					nS	
LBMemWeN(1:0)	5	17					nS	
LBMemData(63:0)	5	20	7	20	7	20	nS	
FBMemAddr(8:0)	7	25	5	25	5	15	nS	
FBMemRasN(3:0)	5	16	5	17	5	17	nS	
FBMemCasN(7:0)	5	17	5	17	5	17	nS	
FBMemOeN(3:0)	5	17	5	17	5	17	nS	
FBMemWeN(3:0)	5	17	5	17	5	17	nS	
FBMemDSF(1:0)	5	17	5	17	5	17	nS	
FBMemData(63:0)	6	24	7	27	7	27	nS	
FBReq	7	25					nS	
FBGnt	7	25					nS	
FBSelOEN	6	20					nS	
HSync/ExtTxCmd1	7	24					nS	
VSync/ExtTxCmd0	7	24					nS	
DacWrN	5	20					nS	
DacRdN	5	20					nS	
RomEnN	5	20					nS	
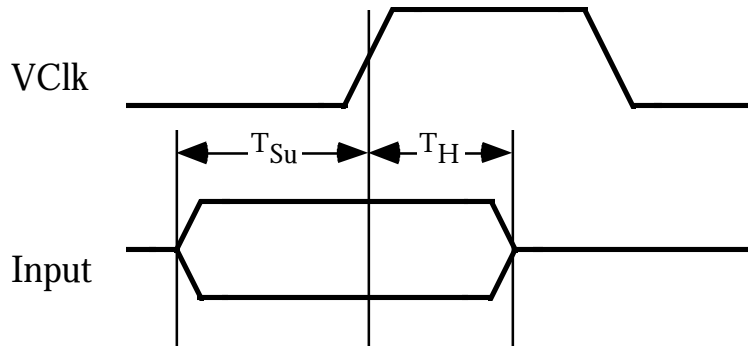
Figure 9-6 VClk Referenced Input Timing

Table 9-11 VClk Referenced Input Timing

Parameter	T_{Su} Min	T_H Min	Units	Notes
QSF/ExtTxReq	3	3	nS	1

Notes:

1. QSF/ExtTxReq is only timed against VClk when the GLINT 500TX is set to use the internal timing generator.
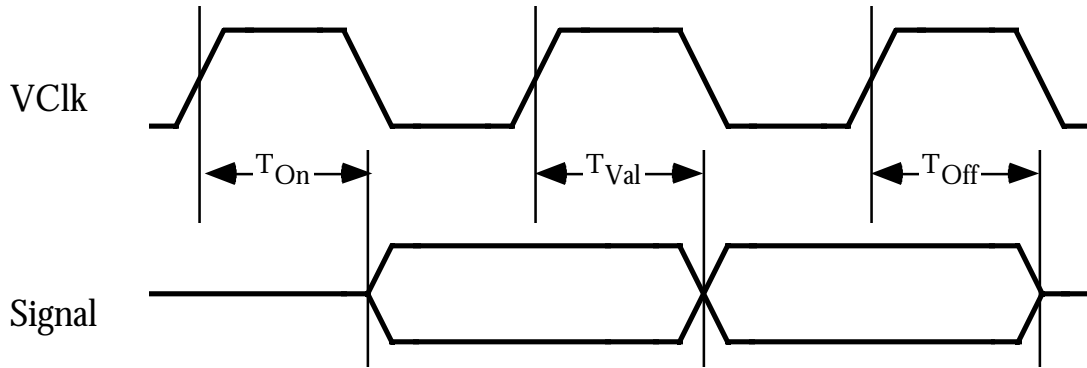
Figure 9-7 VClk Referenced Output Timing

Table 9-12 VClk Referenced Output Timing

Parameter	T_{Val}		T_{On}		T_{Off}		Units	Notes
	Min	Max	Min	Max	Min	Max		
SClk(1:0)	4.5	15					nS	
SOE(3:0)	4.5	19					nS	
LDClk	4	15					nS	
CBlank/ExtTxSplit	7	21					nS	1
HSync/ExtTxCmd1	7	21					nS	1
VSync/ExtTxCmd0	7	21					nS	1
CompSync	7	21					nS	

Notes:

1. These signals are only timed against VClk when the GLINT 500TX is set to use the internal timing generator.

File Name : glintfbrd.ps
Creator : timing v1.2 (simon.moore@3dlabs.com)
Pages : 1

Figure 9-8 Framebuffer Read Timings

File Name : glintfbwr.ps
Creator : timing v1.2 (simon.moore@3dlabs.com)
Pages : 1

Figure 9-9 Framebuffer Write Timing

File Name : glintfbtr.ps
Creator : timing v1.2 (simon.moore@3dlabs.com)
Pages : 1

Figure 9-10 Framebuffer Transfer Cycle Timing

File Name : glintfbcbr.ps
Creator : timing v1.2 (simon.moore@3dlabs.com)
Pages : 1

Figure 9-11 Framebuffer CAS-Before-RAS Refresh Timings

Table 9-13 Framebuffer Timing

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{cas}	CAS Pulse Width	CL	20*CL
t_{crp}	CAS to RAS Precharge	CL	20*CL
t_{csh}	CAS hold time	RL+CL	20*(RL+CL)
t_{pc}	Page-mode cycle time	CL + 1	20*(CL+1)
t_{cp}	CAS Precharge time	1	20
t_{rp}	RAS Precharge time	RP	20*RP
t_{rc}	Random read /write Cycle time	RL + RP+CL	20*(RL+RP+CL)
t_{ras}	RAS pulse Width	RL+CL	20*(RL+CL)
t_{rcd}	RAS to CAS delay time	RL+CL	20*(RL+CL)
t_{rah}	Row Address hold time	1	20
t_{ar}	Column address Hold time (referenced to RAS)	RL+CL	20*(RL+CL)
t_{asc}	Column Address setup time	1	20
t_{cah}	Column Address Hold time	CL	20*CL
t_{wch}	Write Command hold time	1	20
t_{wcr}	Write Command hold time (referenced to RAS)	RL+CL	20*(RL+CL)
t_{wp}	Write Command pulse width	CL	20*CL
t_{ds}	Data setup time	1	20
t_{dh}	Data hold time	CL	20*CL
t_{dhr}	Data hold time (to RAS)	RL+CL	20*(RL+CL)
t_{rpc}	RAS precharge to CAS active	1	20
t_{csr}	CAS setup time for CAS-before-RAS refresh	1	20
t_{chr}	CAS hold time for CAS-before-RAS refresh	RL+CL	20*(RL+CL)
t_{asr}	Row Address setup time	1	20
t_{tls}	DT/OE setup time to RAS	1	20
t_{tlh}	DT/OE hold time to RAS	1	20
t_{fsc}	DSF setup time referenced to CAS	1	20
t_{cfh}	DSF hold time (to CAS)	CL	20*CL
t_{fsr}	DSF setup time referenced to RAS	1	20
t_{rfh}	DSF hold time referenced to RAS	1	20

t_{tp}	DT/OE Precharge time	1	20
t_{trp}	DT/OE to RAS Precharge time	RP + 2	20*(RP+2)

The following table gives the access times required to read from VRAM into the GLINT 500TX.

A CAS access time of 15ns or better is required for a system clock of 50MHz with the CAS-low parameter set to 1 clock.

Table 9-14. VRAM Access Time Requirements.

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{cpa}	Access time from CAS Precharge	CL + 1	20*(CL+1) -5
t_{rac}	Access time from RAS	RL+CL	20*(RL+CL) -5
t_{cac}	Access time from CAS	CL	20*CL -5
t_{oea}	Access time from OE	CL	20*CL -5
t_{caa}	Access time from Column Address	CL + 1	20*(CL+1) -5

File Name : glintlbrd.ps

Creator : timing v1.2 (simon.moore@3dlabs.com)

Pages : 1

Figure 9-12 Localbuffer Read Timings - Fast-Page Mode

File Name : glintlbwr.ps
Creator : timing v1.2 (simon.moore@3dlabs.com)
Pages : 1

Figure 9-13 Localbuffer Write Timings - Fast-Page Mode

File Name : glintlbcbr.ps
Creator : timing v1.2 (simon.moore@3dlabs.com)
Pages : 1

Figure 9-14 Localbuffer CAS-Before-RAS Refresh Timings

Table 9-15 Localbuffer Timing - Fast-page mode

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{cas}	CAS Pulse Width	CL	20*CL
t_{crp}	CAS to RAS Precharge	CL	20*CL
t_{csh}	CAS hold time	RL+CL	20*(RL+CL)
t_{pc}	Page-mode cycle time	CL + 1	20*(CL+1)
t_{cp}	CAS precharge time	1	20
t_{rp}	RAS precharge time	RP	20*RP
t_{rc}	Random read or write Cycle time	RL + RP+CL	20*(RL+RP+CL)
t_{ras}	RAS pulse Width	RL+CL	20*(RL+CL)
t_{rcd}	RAS to CAS delay time	RL+CL	20*(RL+CL)
t_{rah}	Row Address hold time	1	20
t_{ar}	Column address Hold time (referenced to RAS)	RL+CL	20*(RL+CL)
t_{asc}	Column Address setup time	1	20
t_{cah}	Column Address Hold time	CL	20*CL
t_{wch}	Write Command hold time	1	20
t_{wcr}	Write Command hold time (referenced to RAS)	RL+CL	20*(RL+CL)
t_{wp}	Write Command pulse width	CL	20*CL
t_{ds}	Data setup time	1	20
t_{dh}	Data hold time	CL	20*CL
t_{dhr}	Data hold time (referenced to RAS)	RL+CL	20*(RL+CL)
t_{rpc}	RAS precharge to CAS active	1	20
t_{csr}	CAS setup time for CAS-before-RAS refresh	1	20
t_{chr}	CAS hold time for CAS-before-RAS refresh	RL+CL	20*(RL+CL)
t_{asr}	Row Address setup time	1	20

The following table gives the access times required to read from DRAM into the GLINT 500TX.

A CAS access time of 15ns or better is required for a system clock of 50MHz with the CAS-low parameter set to 1 clock.

Table 9-16. Localbuffer Access Time Requirements - Fast Page Mode.

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{cpa}	Access time from CAS precharge	CL + 1	20*(CL+1) -5
t_{rac}	Access time from RAS	RL+CL	20*(RL+CL) -5
t_{cac}	Access time from CAS	CL	20*CL -5
t_{oea}	Access time from OE	CL	20*CL -5
t_{caa}	Access time from Column Address	CL + 1	20*(CL+1) -5

```
Title:
Creator:  timing v1.2 (simon.moore@3dlabs.com)
CreationDate:
```

Figure 9-15 Localbuffer Write Timings - EDO mode

```
Title:
Creator:  timing v1.2 (simon.moore@3dlabs.com)
CreationDate:
```

Figure 9-16 Localbuffer Read Timings - EDO mode

Table 9-17 Localbuffer Timing - EDO mode

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{cas}	CAS Pulse Width	0.5	10
t_{crp}	CAS to RAS Precharge	1.5	30
t_{csh}	CAS hold time	RL+1	20*(RL+1)
t_{pc}	Page-mode cycle time	1	20
t_{cp}	CAS precharge time	0.5	10
t_{rp}	RAS precharge time	RP	20*RP
t_{rc}	Random read or write Cycle time	RL + RP+1	20*(RL+RP+1)
t_{ras}	RAS pulse Width	RL+1	20*(RL+1)
t_{rcd}	RAS to CAS delay time	RL+0.5	20*(RL+0.5)
t_{rah}	Row Address hold time	1	20
t_{ar}	Column address Hold time (referenced to RAS)	RL+CL	20*(RL+CL)
t_{asc}	Column Address setup time	1	20
t_{cah}	Column Address Hold time	0.5	10
t_{wch}	Write Command hold time	0.5	10
t_{wcr}	Write Command hold time (referenced to RAS)	RL+CL	20*(RL+CL)
t_{ds}	Data setup time	0.5	10
t_{dh}	Data hold time	0.5	10
t_{dhr}	Data hold time (referenced to RAS)	RL+1	20*(RL+1)
t_{rpc}	RAS precharge to CAS active	1	20
t_{csr}	CAS setup time for CAS-before-RAS refresh	1	20
t_{chr}	CAS hold time for CAS-before-RAS refresh	RL+CL	20*(RL+CL)
t_{asr}	Row Address setup time	1	20

The following table gives the access times required to read from DRAM into the GLINT 500TX.

A HyperPage Mode cycle time of 20ns or better is required for a system clock of 50MHz.

Table 9-18. Localbuffer Access Time Requirements - EDO Mode.

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{cpa}	Access time from CAS precharge	1.5	30
t_{rac}	Access time from RAS	RL+1.5	20*(RL+ 1.5)
t_{cac}	Access time from CAS	1	20
t_{oea}	Access time from OE	1.5	30
t_{caa}	Access time from Column Address	1.5	30

File Name : glintrom.ps

Creator : timing v1.2 (simon.moore@3dlabs.com)

Pages : 1

Figure 9-17 ROM Read Timings

Table 9-19. ROM Read Timings.

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{rom}	ROMEN low time	8	160 ns
t_{as}	Address setup time	1	20 ns
t_{ah}	Address hold time	1	20 ns

Table 9-20. ROM Access Times.

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{aa}	Access time from ROMEN	-	150 ns min.
t_{oez}	Access time from Column Address	-	20 ns min.

File Name : glintdacrd.ps

Creator : timing v1.2 (simon.moore@3dlabs.com)

Pages : 1

Figure 9-18 LUT-DAC Read Timings

File Name : glintdacwr.ps

Creator : timing v1.2 (simon.moore@3dlabs.com)

Pages : 1

Figure 9-19 LUT-DAC Write Timings

Table 9-21. LUT-DAC Timings.

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{rd}	DACRDN low time	8	160 ns
t_{as}	Address setup time	1	20 ns
t_{ah}	Address hold time	1	20 ns
t_{ds}	Data setup time	1	20 ns
t_{dh}	Data hold time	1	20 ns

Table 9-22. LUT-DAC Access Times.

Symbol	Parameter	Nominal timing in system clocks	Nominal timing at 50MHz
t_{aa}	Access time from DACRDN	-	150 ns min.
t_{oez}	Access time from Column Address	-	20 ns min.

10. Pin Information.

10.1 Package Pinout

The GLINT 500TX comes in a 304 pin QFP package. The pin numbering is shown in figure 10-1.
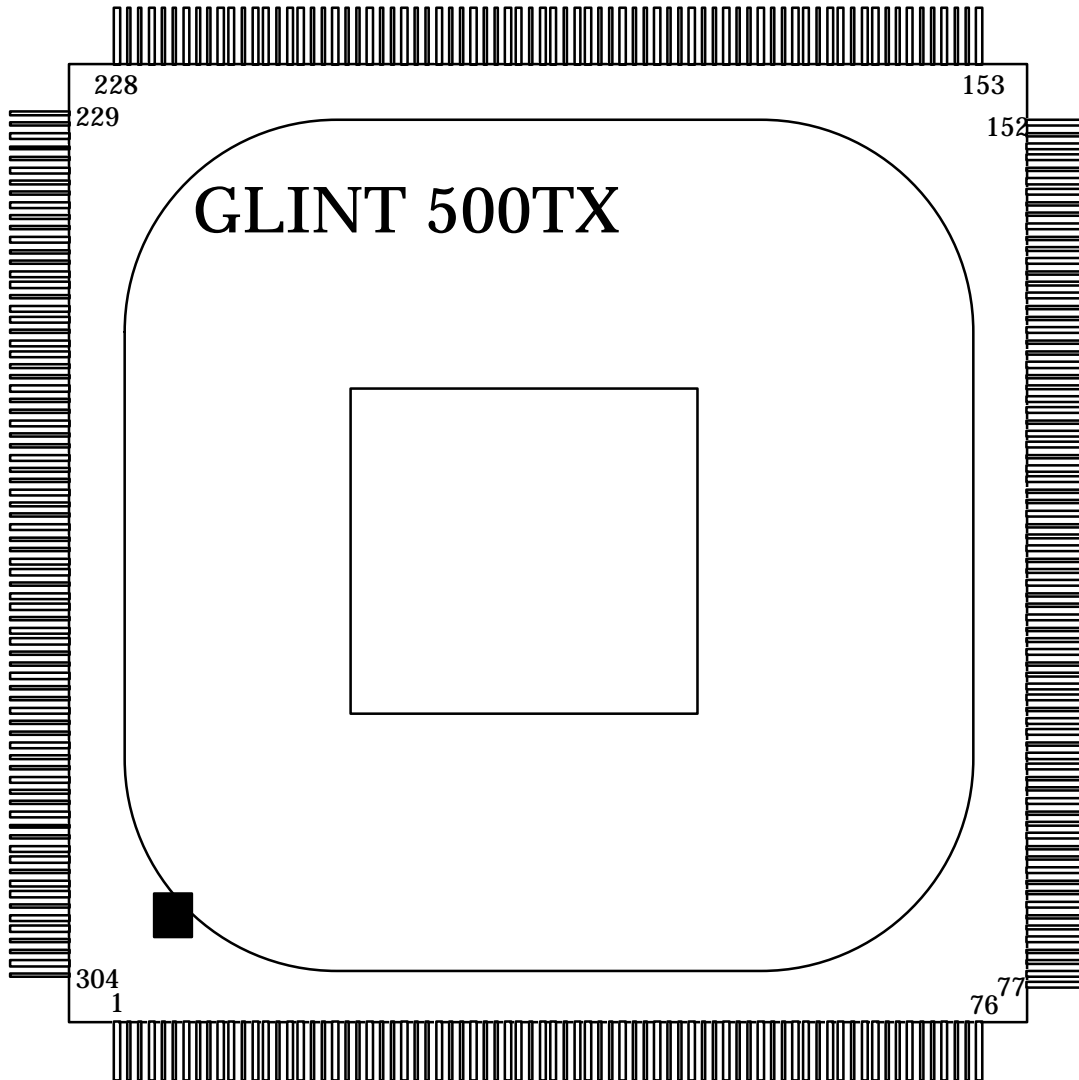
Figure 10-1 GLINT 500TX Pin Numbering

10.2   Pin Descriptions

Table 10-1 provides a brief description of each pin. The following pin type definitions are used.

I   Input signal
O   Output signal
I/O   Bi-directional signal

Output power ratings are marked as 4, 8, or 12 for the milliamp current rating or P indicating a PCI compatible output.

Table 10-1. Pin Descriptions

Symbol	Type	Power	Pin Number(s)	Description

Clocks

Symbol	Type	Power	Pin Number(s)	Description
PCIClk	I		11	PCI clock.
MClk	I		262	System clock. Used for all internally clocked functions on the chip and by the memory controllers.
VClk	I		296	Video clock. Used by internal video rate circuitry. Typically connected to a divided pixel clock.
LDClk	O	12	304	LUT-DAC Load clock.

PCI Interface

Symbol	Type	Power	Pin Number(s)	Description
PCIAD(31:0)	I/O	P	14-15, 17-22, 27-28, 30-32, 34-36, 51, 54-57, 59-61, 64-67, 73-76	PCI Address and Data bus.
PCICBEN(3:0)	I/O	P	23, 37, 50, 62	PCI command and bytes enables.
PCIPar	I/O	P	49	PCI parity bit.
PCIFrameN	I/O	P	40	PCI frame control line.
PCIIRdyN	I/O	P	41	PCI Initiator Ready.
PCITRdyN	I/O	P	42	PCI Target Ready.
PCIStopN	I/O	P	44	PCI Target Stop control.
PCIIdsel	I		26	PCI slot configuration select line.
PCIDevselN	I/O	P	43	PCI Target selected.
PCIReqN	O	P	13	PCI Master request line.
PCIGntN	I		12	PCI Master Grant line.
PCIFifoIndis	O	P	47	PCI Input Fifo Disconnect
PCIFifoOutDis	O	P	48	PCI OutputFifo Disconnect.
PCIIntAN	OD	P	5	PCI interrupt line.

Symbol	Type	Power	Pin Number(s)	Description
Localbuffer Interface				
LBMemAddr(11:0)	O	12	140-141, 144-145, 84-85, 88-93	Localbuffer Address bus.
LBMemRasN(1:0)	O	12	109, 113	Localbuffer DRAM RAS control lines.
LBMemCasN(5:0)	O	12	110-111, 112, 116-118	Localbuffer DRAM CAS control lines. These lines are used as byte enables for localbuffer accesses
LBMemOeN(1:0)	O	12	158-159	Localbuffer DRAM Output Enable Lines. These lines Select between 2 banks of memory for reads. For 1 bank only LBMemOEN(0) is used.
LBMemWeN(1:0)	O	12	162-163	Localbuffer DRAM Write Enable Lines. These lines are used to select between 2 banks of memory for writes. For 1 bank only LBMemWEN(0) is used.
LBMemData(47:0)	I/O	12	77-80, 82-83, 95-101, 104-108, 122-125, 128-133, 136-139, 146-157, 164-167	Localbuffer Data Bus. Also used at reset time to initialize internal registers. LBMemData(47:0) are also used as Data(7:0) for External Video/LUT-DAC and Expansion Rom. LBMemData(39:24) are also used as Address(15:0) for External Video and Expansion ROM.

Framebuffer Interface

Symbol	Type	Power	Pin Number(s)	Description
FBMemAddr(8:0)	O	12	217-219, 222, 224-228	Framebuffer Address Bus.
FBMemRasN(3:0)	O	12	264-265, 259-260	Framebuffer VRAM RAS control lines.
FBMemCasN(7:0)	O	12	186-189, 192-195	Framebuffer VRAM CAS control lines.
FBMemOeN(3:0)	O	12	253, 256-258	Framebuffer VRAM Output Enable lines.
FBMemWeN(3:0)	O	12	249-252	Framebuffer VRAM Write Enable lines.
FBMemDSF(1:0)	O	12	269, 271	Framebuffer VRAM DSF lines. These lines are electrically the same. Two DSF lines are provided for buffering purposes. NB. These DSF lines do NOT equate to the DSF0 and DSF1 lines of hyperpipelined VRAMs such as Toshiba TC528267

Symbol	Type	Power	Pin Number(s)	Description
FBMemData(63:0)	I/O	12	170-175, 178-182, 184-185, 196-203, 206-211, 213-216, 229-237, 240-245, 248, 272-277, 280-286, 288-291	Framebuffer Data Bus.
FBGnt	I/O	8	4	Shared Framebuffer grant. This line is an output when GLINT 300SX is a shared framebuffer primary controller. This line is an input when a secondary controller.
FBSelOE/SOE2	I/O	8	2	When TX Enhanced function pin is pulled high, this pin is VRAM serial output Enable 2 , otherwise it is the Shared Framebuffer output enable which can be used to control memory control signal buffers when a secondary shared framebuffer controller.

Video Control

Symbol	Type	Power	Pin Number(s)	Description
VClkCtl(1:0)	O	8	70-71	Pixel clock select lines. Can be used to control multi-rate Pixel clock generation chips.
HSync/ExtTxCmd1	O	8	292	Video Horizontal Sync line / Controls the external transfer address generator and acknowledges an ExtTxReq
VSync/ExtTxCmd0	O	8	293	Video Vertical Sync line / Controls the external transfer address generator and acknowledges an ExtTxReq
QSF/ExtTxReq	I		297	Input from VRAM QSF pin or External Timing generator to control VRAM transfer cycles
CBlank/ExtTxSplit	I/O	8	298	Video Composite Blank line / Qualifies ExtTxReq as a split transfer (instead of full transfer)
CompSync	O	8	1	Video Composite Sync line.
DacWrN	O	8	120	LUT-DAC / External VideoWrite line.
DacRdN	O	8	121	LUT-DAC / External VideoRead line.
SClk(1:0)	O	12	299, 301	Video serial clocks.
SOE(1:0)	O	12	302-303	Video serial output enable.
SOE3	O	12	46	When the TX Enhanced function pin is pulled high, this pin is VRAM serial output enable 3, otherwise the pin is tri-state.

Symbol	Type	Power	Pin Number(s)	Description
Misc.				
TXEnhanced	I		270	TX Enhanced Function pin. When this pin is pulled low, the GLINT 500TX pin functionality remains consistent with GLINT 300 SX. When this pin is pulled high, the SOE2 and SOE3 functionality is enabled. The new shared Localbuffer/Framebuffer functionality and S3 compatible framebuffer modes are enabled.
PCIRstN	I		10	Power On and Hardware reset.
ExtIntN	I		223	Ext Interrupt Internal Pullup
RomEnN	O	8	119	Expansion ROM enable
TestMode	I		263	Test mode control.
TestAClk	I		6	Test clock A. Internal Pulldown
TestBClk	I		7	Test clock B. Internal Pulldown
TestCClk	I		268	Test clock C. Internal Pulldown
DI1	I		58	Test Driver Inhibit. This pin must be pulled high in functional mode.
DI2	I		134	Test Driver Inhibit. This pin must be pulled high in functional mode.
VDD	I		8, 24, 38, 52, 68, 86, 102, 114, 126, 142, 160, 168, 176, 190, 204, 220, 238, 246, 254, 266, 278, 294	Vdd pins. All must be used
GND	I		9, 16, 25, 29, 33, 39, 45, 53, 63, 69, 72, 81, 87, 94, 103, 115, 127, 135, 143, 161, 169, 177, 183, 191, 205, 212, 221, 239, 247, 255, 261, 267, 279, 287, 295, 300	Ground pins. All must be used.

10.3   Pin Lists

Table 10-2. Alphabetical Pin Listing

Symbol	Pin Numbers
CBlank/ExtTxSplit	298
CompSync	1
DacRdN	121
DacWrN	120
DI1	58
DI2	134
ExtIntN	223
FBGntN	4
FBMemAddr(8:0)	217-219, 222, 224-228
FBMemCasN(7:0)	186-189, 192-195
FBMemData(63:0)	170-175, 178-182, 184-185, 196-203, 206-211, 213-216, 229-237, 240-245, 248, 272-277, 280-286, 288-291
FBMemDSF(1:0)	269, 271
FBMemOeN(3:0)	253, 256-258
FBMemRasN(3:0)	264-265, 259-260
FBMemWeN(3:0)	249-252
FBReqN	3
FBSelOEN/SOE2	2
GND	9, 16, 25, 29, 33, 39, 45, 53, 63, 69, 72, 81, 87, 94, 103, 115, 127, 135, 143, 161, 169, 177, 183, 191, 205, 212, 221, 239, 247, 255, 261, 267, 279, 287, 295, 300
HSync/ExtTxCmd1	292
LBMemAddr(11:0)	140-141, 144-145, 84-85, 88-93
LBMemCasN(5:0)	110-111, 112, 116-118
LBMemData(47:0)	77-80, 82-83, 95-101, 104-108, 122-125, 128-133, 136-139, 146-157, 164-167
LBMemOeN(1:0)	158-159
LBMemRasN(1:0)	109, 113
LBMemWeN	162-163
LDClk	304
MClk	262
PCIAD(31:0)	14-15, 17-22, 27-28, 30-32, 34-36, 51, 54-57, 59-61, 64-67, 73-76
PCICBEN(3:0)	23, 37, 50, 62
PCIClk	11
PCIDevselN	43
PCIFifoInDis	47
PCIFifoOutDis	48
PCIFrameN	40
PCIGntN	12
PCIIdsel	26
PCIIntAN	5
PCIIRdyN	41

Table 10-2. Alphabetical Pin Listing (Continued)

Symbol	Pin Numbers
PCIPar	49
PCIPerrN	47
PCIReqN	13
PCIRstN	10
PCISerrN	48
PCIStopN	44
PCITRdyN	42
VClkCtl(1:0)	70-71
QSF/ExtTxReq	297
RomEnN	119
SClk(1:0)	299, 301
SOE(1:0)	302-303
SOE3	46
TestAClk	6
TestBClk	7
TestCClk	268
TestMode	263
TXEnhanced	270
VClk	296
VDD	8, 24, 38, 52, 68, 86, 102, 114, 126, 142, 160, 168, 176, 190, 204, 220, 238, 246, 254, 266, 278, 294
VSync/ExtTxCmd0	293

Table 10-3. Numerical Pin Listing

Pin	Name	Pin	Name
1	CompSync	39	GND
2	FBSelOEN/SOE2	40	PCIFrameN
3	FBReqN	41	PCIIRdyN
4	FBGntN	42	PCITRdyN
5	PCIIntAN	43	PCIDevselN
6	TestAClk	44	PCIStopN
7	TestBClk	45	GND
8	VDD	46	SOE3
9	GND	47	PCIFifoInDis
10	PCIRstN	48	PCIFifoOutDis
11	PCIClk	49	PCIPar
12	PCIGntN	50	PCICBEN1
13	PCIReqN	51	PCIAD15
14	PCIAD31	52	VDD
15	PCIAD30	53	GND
16	GND	54	PCIAD14
17	PCIAD29	55	PCIAD13
18	PCIAD28	56	PCIAD12
19	PCIAD27	57	PCIAD11
20	PCIAD26	58	DI1
21	PCIAD25	59	PCIAD10
22	PCIAD24	60	PCIAD9
23	PCICBEN3	61	PCIAD8
24	VDD	62	PCICBEN0
25	GND	63	GND
26	PCIIdsel	64	PCIAD7
27	PCIAD23	65	PCIAD6
28	PCIAD22	66	PCIAD5
29	GND	67	PCIAD4
30	PCIAD21	68	VDD
31	PCIAD20	69	GND
32	PCIAD19	70	VClkCtl1
33	GND	71	VClkCtl0
34	PCIAD18	72	GND
35	PCIAD17	73	PCIAD3
36	PCIAD16	74	PCIAD2
37	PCICBEN2	75	PCIAD1
38	VDD	76	PCIAD0

Table 10-3. Numerical Pin Listing (Continued)

Pin	Name	Pin	Name
77	LBMemData47	115	GND
78	LBMemData46	116	LBMemCasN2
79	LBMemData45	117	LBMemCasN1
80	LBMemData44	118	LBMemCasN0
81	GND	119	RomEnN
82	LBMemData43	120	DacWrN
83	LBMemData42	121	DacRdN
84	LBMemAddr7	122	LBMemData29
85	LBMemAddr6	123	LBMemData28
86	VDD	124	LBMemData27
87	GND	125	LBMemData26
88	LBMemAddr5	126	VDD
89	LBMemAddr4	127	GND
90	LBMemAddr3	128	LBMemData25
91	LBMemAddr2	129	LBMemData24
92	LBMemAddr1	130	LBMemData23
93	LBMemAddr0	131	LBMemData22
94	GND	132	LBMemData21
95	LBMemData41	133	LBMemData20
96	LBMemData40	134	DI2
97	LBMemData39	135	GND
98	LBMemData38	136	LBMemData19
99	LBMemData37	137	LBMemData18
100	LBMemData36	138	LBMemData17
101	LBMemData35	139	LBMemData16
102	VDD	140	LBMemAddr11
103	GND	141	LBMemAddr10
104	LBMemData34	142	VDD
105	LBMemData33	143	GND
106	LBMemData32	144	LBMemAddr9
107	LBMemData31	145	LBMemAddr8
108	LBMemData30	146	LBMemData15
109	LBMemRasN1	147	LBMemData14
110	LBMemCasN5	148	LBMemData13
111	LBMemCasN4	149	LBMemData12
112	LBMemCasN3	150	LBMemData11
113	LBMemRasN0	151	LBMemData10
114	VDD	152	LBMemData9

Table 10-3 Numerical Pin Listing (Continued)

Pin	Name		Pin	Name
153	LBMemData8		191	GND
154	LBMemData7		192	FBMemCasN3
155	LBMemData6		193	FBMemCasN2
156	LBMemData5		194	FBMemCasN1
157	LBMemData4		195	FBMemCasN0
158	LBMemOeN1		196	FBMemData50
159	LBMemOeN0		197	FBMemData49
160	VDD		198	FBMemData48
161	GND		199	FBMemData47
162	LBMemWeN1		200	FBMemData46
163	LBMemWeN0		201	FBMemData45
164	LBMemData3		202	FBMemData44
165	LBMemData2		203	FBMemData43
166	LBMemData1		204	VDD
167	LBMemData0		205	GND
168	VDD		206	FBMemData42
169	GND		207	FBMemData41
170	FBMemData63		208	FBMemData40
171	FBMemData62		209	FBMemData39
172	FBMemData61		210	FBMemData38
173	FBMemData60		211	FBMemData37
174	FBMemData59		212	GND
175	FBMemData58		213	FBMemData36
176	VDD		214	FBMemData35
177	GND		215	FBMemData34
178	FBMemData57		216	FBMemData33
179	FBMemData56		217	FBMemAddr8
180	FBMemData55		218	FBMemAddr7
181	FBMemData54		219	FBMemAddr6
182	FBMemData53		220	VDD
183	GND		221	GND
184	FBMemData52		222	FBMemAddr5
185	FBMemData51		223	ExtIntN
186	FBMemCasN7		224	FBMemAddr4
187	FBMemCasN6		225	FBMemAddr3
188	FBMemCasN5		226	FBMemAddr2
189	FBMemCasN4		227	FBMemAddr1
190	VDD		228	FBMemAddr0

Table 10-3. Numerical Pin Listing (Continued)

Pin	Name	Pin	Name
229	FBMemData32	267	GND
230	FBMemData31	268	TestCClk
231	FBMemData30	269	FBMemDSF1
232	FBMemData29	270	TXEnhanced
233	FBMemData28	271	FBMemDSF0
234	FBMemData27	272	FBMemData16
235	FBMemData26	273	FBMemData15
236	FBMemData25	274	FBMemData14
237	FBMemData24	275	FBMemData13
238	VDD	276	FBMemData12
239	GND	277	FBMemData11
240	FBMemData23	278	VDD
241	FBMemData22	279	GND
242	FBMemData21	280	FBMemData10
243	FBMemData20	281	FBMemData9
244	FBMemData19	282	FBMemData8
245	FBMemData18	283	FBMemData7
246	VDD	284	FBMemData6
247	GND	285	FBMemData5
248	FBMemData17	286	FBMemData4
249	FBMemWeN3	287	GND
250	FBMemWeN2	288	FBMemData3
251	FBMemWeN1	289	FBMemData2
252	FBMemWeN0	290	FBMemData1
253	FBMemOeN3	291	FBMemData0
254	VDD	292	HSync/ExtTxCmd1
255	GND	293	VSync/ExtTxCmd0
256	FBMemOeN2	294	VDD
257	FBMemOeN1	295	GND
258	FBMemOeN0	296	VClk
259	FBMemRasN1	297	QSF/ExtTxReq
260	FBMemRasN0	298	CBlank/ExtTxSplit
261	GND	299	SClk1
262	MClk	300	GND
263	TestMode	301	SClk0
264	FBMemRasN3	302	SOE1
265	FBMemRasN2	303	SOE0
266	VDD	304	LDClk

11.   Thermal Management

The maximum junction temperature must be kept below $T_j(max)$ and this can only be guaranteed by proper analysis of the operating environment and the thermal path between the die and the air surrounding it.

11.1   Device Characteristics

These are fixed characteristics of the device and are independent of the operating environment or the characteristics of any heatsink:-

$T_j(max)$ =   100 °C.

$Pd(max)$ =   3.7 Watts @ Vdd(max), f_{MClk} = 50MHz.

θ_{jc} =   0 °C/Watt.

                              (there is no case to consider here, so this resistance is negligible)

11.2   Thermal Model

The formula used to calculate the junction temperature (T_j) is

$$T_j \ = \ T_a \ + \ Pd \times (\theta_{jc} + \theta_{cs} + \theta_{sa})$$

$$= \ T_a \ + \ Pd \times \theta_{ja}$$

Where:-

T_j	=	Junction temperature (°C)
T_a	=	Ambient temperature (°C)
Pd	=	Power dissipation (Watts)
θ_{jc}	=	Junction to Case thermal resistance (°C/Watt)
θ_{cs}	=	Case to Heatsink thermal resistance (°C/Watt)
θ_{sa}	=	Heatsink to Air thermal resistance (°C/Watt)
θ_{ja}	=	Total Junction to Air thermal resistance (°C/Watt)

The θ_{ja} form of the equation is more appropriate when there is no heatsink attached to the device (see below).

11.3   Operation Without Heatsink

> **Generally it is not recommended that this device is operated without a heatsink due to the high airflow rates which must be maintained to keep T_j below $T_j(max)$.**

The 304 CQFP package with the die exposed on the top surface and no attached heatsink has the following θ_{ja} characteristic as a function of airflow:-

Table 11-1. 304 pin CQFP Package Thermal Characteristics

Airflow (lfpm)		θ_{ja} (° C/W)
0	(Convection Cooling)	30
50	(0.25m/sec)	26
100	(0.5m/sec)	23
200	(1m/sec)	20
400	(2m/sec)	18

Example:-

Ta　　　　= 30 ° C

Airflow　= 400 lfpm

Tj　　　　= 30 + 3.7 x (18)

　　　　　= 96.6 ° C

11.4　　Operation With Heatsink

With a heatsink attached to the device the junction temperature will depend on θ_{cs} and θ_{sa}. θ_{cs} is the thermal resistance of the join between the heatsink and the exposed back surface of the die. θ_{sa} is the thermal resistance of the heatsink and will be a function of system airflow.

Example:-

Ta　　　= 40 ° C

θ_{cs}　　= 1.0 ° C/Watt　　(EG 7655 epoxy - see below)

θ_{sa}　　$\leq$　(100 - 40)/3.7 - 1.0

　　　　$\leq$　15.2 ° C/Watt.

In this example a heatsink must be chosen which has a thermal resistance figure of no greater than 15.2 ° C/Watt at an airflow matching the expected airflow in the system.

11.5   Heatsink Attachment

Two methods have been approved for the purpose of attaching a heatsink directly onto the exposed die surface and the Urethane conformal coating material covering the top of the CQFP package.

11.5.1   Preferred Attachment Method

Thermally conductive epoxy. Either Loctite Output 315 with Loctite 7387 or type EG 7655 from A.I. Technology Inc. The thickness of the epoxy layer should be between 0.05mm and 0.15mm with 100% coverage of the exposed die area, and a maximum voiding in the bond area of 3%. This epoxy should not be used outside the die area.

Typical achievable θ_{CS} using this method is 1.0 $°$ C/Watt.

11.5.2   Alternative Attachment Method

Chomerics Thermattach 405 thermally conductive tape when used with an additional adhesive, such as Loctite Output 315, for structural support outside the die area.

Typical achievable θ_{CS} using this method is 2.2 $°$ C/Watt.

12. Reset Control and Test Mode

12.1 Reset

A number of parameters for the GLINT 500TX are set at reset , such as Localbuffer and Framebuffer memory size and speed. The reset state is configured with resistors connected to the Localbuffer data pins. The state of the data pins is sampled on the rising edge of the reset line. Various parameters may be configured e.g.

- Framebuffer and Localbuffer sizes.
- Framebuffer and Localbuffer RAS and CAS timings
- Framebuffer and Localbuffer widths.

To set a bit to 1 the relevant data pin should be tied to V_{DD} (3.3V) with a 10K resistor.

To set a bit to 0 the relevant data pin should be tied to ground with a 4K7 resistor.

12.2 Clock Operation at Reset

The GLINT 500TX is a synchronous device. For correct reset operation the clocks must be running during the reset pulse. At power-up care must be taken to ensure that MClk and VClk are running before the system reset pulse completes.

12.3 Reset Localbuffer Configuration

This is determined as follows by the reset state of the Localbuffer data pins:

Bit 0   Number of Banks

0	1 Bank
1	2 Banks

Bits 2-1   Page Size

0	256 Pixels
1	512 Pixels
2	1024 Pixels
3	2048 Pixels

Bits 4-3   RAS-CAS low

0	2 Clocks
1	3 Clocks
2	4 Clocks
3	5 Clocks

Bits 6-5   RAS Precharge

0	2 Clocks
1	3 Clocks
2	4 Clocks
3	5 Clocks

Bits 8-7   CAS Low

          0   1 Clocks
          1   2 Clocks
          2   3 Clocks
          3   4 Clocks

Bit 9   Page Mode Disable

          0   Page mode Enabled
          1   Page mode Disabled

Bit 18 Dual Write Enables

          0   2 WE and 6 CAS pins
          1   6 WE and 2 CAS pins

Bits 21-20   PCI Maximum Latency

          Forms the top 2 bits of the configuration space Maximum Latency register

Bits 23-22   PCI Minimum Grant

          Forms the top 2 bits of the configuration space Minimum Grant register

Bits 26-24   Localbuffer Visible Region Size

          0   1 Mbyte
          1   2 Mbytes
          2   4 Mbytes
          3   8 Mbytes
          4   16 Mbytes
          5   32 Mbytes
          6   64 Mbytes
          7   0 Mbytes

Bits 29-27   Localbuffer width

          0   16 bits
          1   18 bits
          2   24 bits
          3   32 bits
          4   36 bits
          5   40 bits
          6   48 bits
          7   Other width

Bit 30 Localbuffer Bypass Packing

          0   64 bit Localbuffer bypass step
          1   32 bit Localbuffer bypass step

Bit 31 Aperture 1 Enable

          0   Aperture 1 disabled
          1   Aperture 1 enabled

12.4   Reset Framebuffer Configuration

This is determined as follows by the reset state of the Framebuffer data lines:

Bits 1-0   RAS-CAS low

> 0   2 Clocks
> 1   3 Clocks
> 2   4 Clocks
> 3   5 Clocks

Bits 3-2   RAS Precharge

> 0   2 Clocks
> 1   3 Clocks
> 2   4 Clocks
> 3   5 Clocks

Bits 5-4   CAS Low

> 0   1 Clocks
> 1   2 Clocks
> 2   3 Clocks
> 3   4 Clocks

Bit 6   Page Mode Disable

> 0   Page mode Enabled
> 1   Page mode Disabled

Bit 10 Fast Mode Disable

> 0   Enabled
> 1   Disabled

Bits 12-11   Shared Framebuffer Mode

> 0   Disabled
> 1   Arbiter
> 2   Requester
> 3   Reserved

Bit 13 Video Transfer Disable

> 0   Transfer Cycles Enabled
> 1   Transfer Cycles Disabled

Bit 14 External VTG Select

> 0   Internal VTG
> 1   External VTG

Bits 16-15   Framebuffer Interleave

> 0   1 way
> 1   2 way
> 2   4 way
> 3   Reserved

Bits18-17   Block Fill Size

> 0   Disabled
> 1   4 Pixels
> 2   8 Pixels
> 3   Reserved

Bit 19 Dual Write Enables

> 0   4 WE and 8 CAS pins
> 1   8 WE and 4 CAS pins

Bit 20 TX Enhanced Shared Memory

> 0   GLINT 300SX compatible Shared Framebuffer control
> 1   Enhanced Shared Memory Control

Bit 21 SFBModeSwap

> 0   SFBMode field has default action
> 1   invert action of SFBMode field

Bit 22 EDO DRAM Localbuffer

> 0   Fast Page Mode DRAM fitted for Local buffer
> 1   EDO Dram fitted for Local Buffer

 (This field has no direct effect on the hardware)

Bit 26 Base Class Zero

> 0 = GLINT 500TX returns a PCI Base class and sub-class of 03h 80h
> 1 = GLINT 500 TX returns a PCI Base Class and sub-Class of 00h 00h

Bit 27 Reserved

Bit 28 Aperture 1 Enable

> 0   Aperture 1 disabled
> 1   Aperture 1 enabled

Bits 31-29   Framebuffer Visible Region Size

0	1 Mbyte
1	2 Mbytes
2	4 Mbytes
3	8 Mbytes
4	16 Mbytes
5	32 Mbytes
6	Reserved
7	0 Mbytes

12.5   Production Test Mode

This section describes how to place the GLINT 500TX into a mode suitable for board production test. In Board ATE mode, all GLINT drivers are tristated. In order to do this, the DI1 and DI2 pins must be pulled low.

Table 12-1. GLINT 500TX Functional Mode

Pin	
DI2	high
DI1	high
TestAClk	low
TestBClk	low
TestCClk	low

Table 12-2. GLINT 500TX Board ATE Mode

Pin	
DI1	low
DI2	low
TestAClk	low
TestBClk	low
TestCClk	low

13.   Package Dimensions

Figure 13-1 Mechanical Diagrams

Table 13-1. 304 pin CQFP Package Dimensions

Dimension		mm
a	Lead Pitch	0.5
b	Lead Width	0.23 ± 0.05
c	Foot Length	0.5 ± 0.1
d	Height	3.1 max
E	Width (toe to toe)	42.6 ± 0.2
F	Body Width	40.0 ± 0.2

App. A   GLINT 300SX and 500TX Hardware Differences

The GLINT 500TX has been designed to be backwards compatible with GLINT 300SX. In general, a GLINT 500TX may be placed directly on a board designed for a GLINT 300SX without modification to the board. However there are some additional features in GLINT 500TX which, if used, may require a different board layout. These features are only enabled if a pin, which was assigned to GND on the GLINT 300SX, is pulled high. The additional features are described below.

A.1   Localbuffer

The GLINT 500TX supports the use of EDO DRAM for the localbuffer. No board design changes are necessary to use EDO DRAM in place of Fast Page mode DRAM. There is an internal register which is used to select between the different memory types.

The GLINT 500TX supports a Shared Localbuffer protocol similar to the Shared Framebuffer protocol. The Shared Localbuffer capability is enabled at reset using a configuration resistor on the framebuffer data bus. In order to avoid problems of backwards compatibility with the GLINT 300SX, this configuration resistor is ignored unless the TX Enhanced Function pin is pulled high (see pinout section).

When the TX Enhanced Function pin is pulled high, then the reset state of bits 21 and 20 of the framebuffer data bus is used in conjunction with the reset state of bit 12-11 of the framebuffer data bus to determine how the Shared Framebuffer and Localbuffer interfaces are configured. The options are as follows:-

Table A-1. Shared Framebuffer and Localbuffer Options

SFBSwap	TXEnhanced Shared Memory	SFB Mode Bits	Framebuffer Configuration	Localbuffer Configuration
X	0	0	Not Shared	Not Shared
0	0	1	Primary Controller	Not Shared
0	0	2	Secondary Controller	Not Shared
X	0	3	Secondary Controller	Secondary Controller
X	1	0	Not Shared	Not Shared
0	1	1	Not Shared	Primary Controller
0	1	2	Not Shared	Secondary Controller
X	1	3	Primary Controller	Primary Controller
1	0	1	Secondary Controller	Not Shared
1	0	2	Primary Controller	Not Shared
1	1	1	Not Shared	Secondary Controller
1	1	2	Not Shared	Primary Controller

Primary Controller and Secondary Controller refer to the function of the GLINT 500TX.

N.B. There is one request line and one grant line for both localbuffer and framebuffer. If both the Shared Framebuffer and Shared Localbuffer capabilities are enabled simultaneously, then control is passed together for both memory interfaces from primary to secondary controller.

A.2   Framebuffer

The GLINT 500TX only supports a 64 bit data bus width into the framebuffer. A 32 bit data bus into the framebuffer is not supported.

The GLINT 500TX provides two new framebuffer configurations in order to be compatible with S3 devices when the Shared Framebuffer interface is used. These new configurations remove the need to perform the GLINT 300SX workarounds described in Design Alerts 106.1.24.1 and 106.1.27.1. The new configurations are only available if the TX Enhanced Function pin is pulled high.

A.3   Internal Video Timing Generator

The GLINT 500TX provides two additional framebuffer Serial Output enable pins - SOE2 and SOE3. These extra pins enable the internal video timing generator to display 4 x 64 bit interleaved framebuffer banks with a 64 bit LUT-DAC. (The GLINT 300SX is only able to display 2 x 64 bit interleaved framebuffer banks with a 64 bit LUT-DAC or 4 x 64 bit interleaved framebuffer banks with a 128 bit LUT-DAC).

SOE2 is output on the FBSelOEN pin when the GLINT 500TX is not used as a Shared Framebuffer secondary controller. When the GLINT 500TX is a Shared Framebuffer secondary controller , it cannot be used to control the video display. Hence SOE2 is not required and FBSelOEN reverts to its original function.

SOE3 is output on the PCILockN pin when the TX Enhanced Function pin is pulled high. The GLINT 500TX does not use or drive the PCILockN signal and this pin does not need to be connected to the PCI bus. If the TX Enhanced Function pin is pulled low, then PCILockN is tri-stated and may be connected to the PCI bus.

A.4   Pinout

The following pins have extended functionality on the GLINT 500TX:

Table A-2. Extended Pin Functionality

Pin No.	Pin Name	GLINT 300SX Function	GLINT 500TX Function
2	FBSelOEN/SOE2	FBSelOEN	FBSelOEN when TX Enhanced Function is pulled low. SOE2 when TX Enhanced Function is pulled high.
46	PCILockN/SOE3	PCI Lock signal	Tri-state when TX Enhanced Function is pulled low. SOE3 when TX Enhanced Function is pulled high.
58	DI1	VDD	Test pin - Pulled high in functional mode
134	DI2	VDD	Test pin - Pulled high in functional mode
270	GND/TXEnhance	GND	TX Enhanced Function. If pulled high, then the GLINT 500TX enhanced functions are enabled.

N.B. A pin should be pulled high by connecting to +5V via a 10K resistor. A pin should be pulled low by connecting to ground via a 10K resistor.

Index